



LG

Life's Good

LCD TV **SERVICE MANUAL**

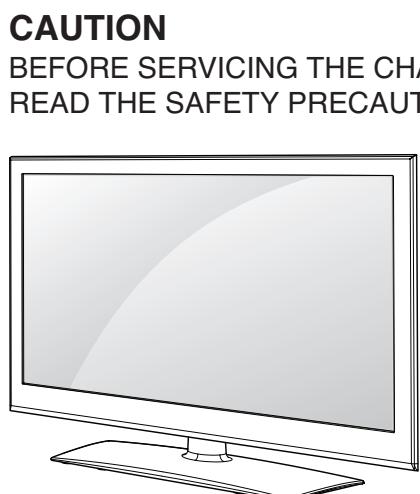
CHASSIS : LB0AZ

MODEL : 55LV355H 55LV355H-TA

Internal Use Only

North/Latin America
Europe/Africa
Asia/Oceania

<http://aic.lgservice.com>
<http://eic.lgservice.com>
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SAFETY PRECAUTIONS

IMPORTANT SAFETY NOTICE

Many electrical and mechanical parts in this chassis have special safety-related characteristics. These parts are identified by  in the Schematic Diagram and Exploded View.

It is essential that these special safety parts should be replaced with the same components as recommended in this manual to prevent Shock, Fire, or other Hazards.

Do not modify the original design without permission of manufacturer.

General Guidance

An **isolation Transformer** should always be used during the servicing of a receiver whose chassis is not isolated from the AC power line. Use a transformer of adequate power rating as this protects the technician from accidents resulting in personal injury from electrical shocks.

It will also protect the receiver and its components from being damaged by accidental shorts of the circuitry that may be inadvertently introduced during the service operation.

If any fuse (or Fusible Resistor) in this TV receiver is blown, replace it with the specified.

When replacing a high wattage resistor (Oxide Metal Film Resistor, over 1 W), keep the resistor 10 mm away from PCB.

Keep wires away from high voltage or high temperature parts.

Before returning the receiver to the customer,

always perform an **AC leakage current check** on the exposed metallic parts of the cabinet, such as antennas, terminals, etc., to be sure the set is safe to operate without damage or electrical shock.

Leakage Current Cold Check(Antenna Cold Check)

With the instrument AC plug removed from AC source, connect an electrical jumper across the two AC plug prongs. Place the AC switch in the on position, connect one lead of ohm-meter to the AC plug prongs tied together and touch other ohm-meter lead in turn to each exposed metallic parts such as antenna terminals, phone jacks, etc.

If the exposed metallic part has a return path to the chassis, the measured resistance should be between 1 M Ω and 5.2 M Ω .

When the exposed metal has no return path to the chassis the reading must be infinite.

An other abnormality exists that must be corrected before the receiver is returned to the customer.

Leakage Current Hot Check (See below Figure)

Plug the AC cord directly into the AC outlet.

Do not use a line Isolation Transformer during this check.

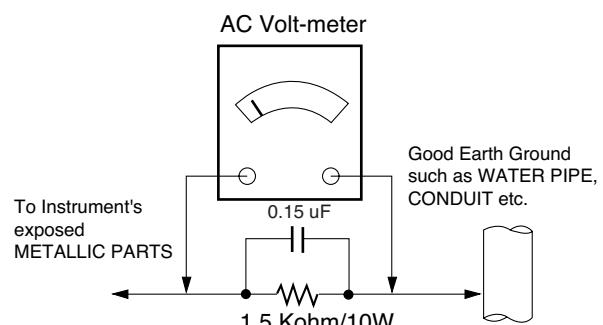
Connect 1.5 K / 10 watt resistor in parallel with a 0.15 uF capacitor between a known good earth ground (Water Pipe, Conduit, etc.) and the exposed metallic parts.

Measure the AC voltage across the resistor using AC voltmeter with 1000 ohms/volt or more sensitivity.

Reverse plug the AC cord into the AC outlet and repeat AC voltage measurements for each exposed metallic part. Any voltage measured must not exceed 0.75 volt RMS which corresponds to 0.5 mA.

In case any measurement is out of the limits specified, there is possibility of shock hazard and the set must be checked and repaired before it is returned to the customer.

Leakage Current Hot Check circuit



When 25A is impressed between Earth and 2nd Ground for 1 second, Resistance must be less than 0.1Ω

*Base on Adjustment standard

SERVICING PRECAUTIONS

CAUTION: Before servicing receivers covered by this service manual and its supplements and addenda, read and follow the SAFETY PRECAUTIONS on page 3 of this publication.

NOTE: If unforeseen circumstances create conflict between the following servicing precautions and any of the safety precautions on page 3 of this publication, always follow the safety precautions.

Remember: Safety First.

General Servicing Precautions

1. Always unplug the receiver AC power cord from the AC power source before;
 - a. Removing or reinstalling any component, circuit board module or any other receiver assembly.
 - b. Disconnecting or reconnecting any receiver electrical plug or other electrical connection.
 - c. Connecting a test substitute in parallel with an electrolytic capacitor in the receiver.
- CAUTION:** A wrong part substitution or incorrect polarity installation of electrolytic capacitors may result in an explosion hazard.
2. Test high voltage only by measuring it with an appropriate high voltage meter or other voltage measuring device (DVM, FETVOM, etc) equipped with a suitable high voltage probe.
Do not test high voltage by "drawing an arc".
3. Do not spray chemicals on or near this receiver or any of its assemblies.
4. Unless specified otherwise in this service manual, clean electrical contacts only by applying the following mixture to the contacts with a pipe cleaner, cotton-tipped stick or comparable non-abrasive applicator; 10 % (by volume) Acetone and 90 % (by volume) isopropyl alcohol (90 % - 99 % strength)
CAUTION: This is a flammable mixture.
Unless specified otherwise in this service manual, lubrication of contacts is not required.
5. Do not defeat any plug/socket B+ voltage interlocks with which receivers covered by this service manual might be equipped.
6. Do not apply AC power to this instrument and/or any of its electrical assemblies unless all solid-state device heat sinks are correctly installed.
7. Always connect the test receiver ground lead to the receiver chassis ground before connecting the test receiver positive lead.
Always remove the test receiver ground lead last.
8. Use with this receiver only the test fixtures specified in this service manual.
CAUTION: Do not connect the test fixture ground strap to any heat sink in this receiver.

Electrostatically Sensitive (ES) Devices

Some semiconductor (solid-state) devices can be damaged easily by static electricity. Such components commonly are called Electrostatically Sensitive (ES) Devices. Examples of typical ES devices are integrated circuits and some field-effect transistors and semiconductor "chip" components. The following techniques should be used to help reduce the incidence of component damage caused by static by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed to prevent potential shock reasons prior to applying power to the unit under test.

2. After removing an electrical assembly equipped with ES devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
3. Use only a grounded-tip soldering iron to solder or unsolder ES devices.
4. Use only an anti-static type solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ES devices.
5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ES devices.
6. Do not remove a replacement ES device from its protective package until immediately before you are ready to install it. (Most replacement ES devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive material).
7. Immediately before removing the protective material from the leads of a replacement ES device, touch the protective material to the chassis or circuit assembly into which the device will be installed.
CAUTION: Be sure no power is applied to the chassis or circuit, and observe all other safety precautions.
8. Minimize bodily motions when handling unpackaged replacement ES devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ES device.)

General Soldering Guidelines

1. Use a grounded-tip, low-wattage soldering iron and appropriate tip size and shape that will maintain tip temperature within the range of 500 °F to 600 °F.
2. Use an appropriate gauge of RMA resin-core solder composed of 60 parts tin/40 parts lead.
3. Keep the soldering iron tip clean and well tinned.
4. Thoroughly clean the surfaces to be soldered. Use a small wire-bristle (0.5 inch, or 1.25 cm) brush with a metal handle.
Do not use freon-propelled spray-on cleaners.
5. Use the following unsoldering technique
 - a. Allow the soldering iron tip to reach normal temperature. (500 °F to 600 °F)
 - b. Heat the component lead until the solder melts.
 - c. Quickly draw the melted solder with an anti-static, suction-type solder removal device or with solder braid.
CAUTION: Work quickly to avoid overheating the circuit board printed foil.
6. Use the following soldering technique.
 - a. Allow the soldering iron tip to reach a normal temperature (500 °F to 600 °F)
 - b. First, hold the soldering iron tip and solder the strand against the component lead until the solder melts.
 - c. Quickly move the soldering iron tip to the junction of the component lead and the printed circuit foil, and hold it there only until the solder flows onto and around both the component lead and the foil.
CAUTION: Work quickly to avoid overheating the circuit board printed foil.
 - d. Closely inspect the solder area and remove any excess or splashed solder with a small wire-bristle brush.

IC Remove/Replacement

Some chassis circuit boards have slotted holes (oblong) through which the IC leads are inserted and then bent flat against the circuit foil. When holes are the slotted type, the following technique should be used to remove and replace the IC. When working with boards using the familiar round hole, use the standard technique as outlined in paragraphs 5 and 6 above.

Removal

1. Desolder and straighten each IC lead in one operation by gently prying up on the lead with the soldering iron tip as the solder melts.
2. Draw away the melted solder with an anti-static suction-type solder removal device (or with solder braid) before removing the IC.

Replacement

1. Carefully insert the replacement IC in the circuit board.
2. Carefully bend each IC lead against the circuit foil pad and solder it.
3. Clean the soldered areas with a small wire-bristle brush.
(It is not necessary to reapply acrylic coating to the areas).

"Small-Signal" Discrete Transistor Removal/Replacement

1. Remove the defective transistor by clipping its leads as close as possible to the component body.
2. Bend into a "U" shape the end of each of three leads remaining on the circuit board.
3. Bend into a "U" shape the replacement transistor leads.
4. Connect the replacement transistor leads to the corresponding leads extending from the circuit board and crimp the "U" with long nose pliers to insure metal to metal contact then solder each connection.

Power Output, Transistor Device Removal/Replacement

1. Heat and remove all solder from around the transistor leads.
2. Remove the heat sink mounting screw (if so equipped).
3. Carefully remove the transistor from the heat sink of the circuit board.
4. Insert new transistor in the circuit board.
5. Solder each transistor lead, and clip off excess lead.
6. Replace heat sink.

Diode Removal/Replacement

1. Remove defective diode by clipping its leads as close as possible to diode body.
2. Bend the two remaining leads perpendicular y to the circuit board.
3. Observing diode polarity, wrap each lead of the new diode around the corresponding lead on the circuit board.
4. Securely crimp each connection and solder it.
5. Inspect (on the circuit board copper side) the solder joints of the two "original" leads. If they are not shiny, reheat them and if necessary, apply additional solder.

Fuse and Conventional Resistor

Removal/Replacement

1. Clip each fuse or resistor lead at top of the circuit board hollow stake.
2. Securely crimp the leads of replacement component around notch at stake top.
3. Solder the connections.

CAUTION: Maintain original spacing between the replaced component and adjacent components and the circuit board to prevent excessive component temperatures.

Circuit Board Foil Repair

Excessive heat applied to the copper foil of any printed circuit board will weaken the adhesive that bonds the foil to the circuit board causing the foil to separate from or "lift-off" the board. The following guidelines and procedures should be followed whenever this condition is encountered.

At IC Connections

To repair a defective copper pattern at IC connections use the following procedure to install a jumper wire on the copper pattern side of the circuit board. (Use this technique only on IC connections).

1. Carefully remove the damaged copper pattern with a sharp knife. (Remove only as much copper as absolutely necessary).
2. carefully scratch away the solder resist and acrylic coating (if used) from the end of the remaining copper pattern.
3. Bend a small "U" in one end of a small gauge jumper wire and carefully crimp it around the IC pin. Solder the IC connection.
4. Route the jumper wire along the path of the out-away copper pattern and let it overlap the previously scraped end of the good copper pattern. Solder the overlapped area and clip off any excess jumper wire.

At Other Connections

Use the following technique to repair the defective copper pattern at connections other than IC Pins. This technique involves the installation of a jumper wire on the component side of the circuit board.

1. Remove the defective copper pattern with a sharp knife. Remove at least 1/4 inch of copper, to ensure that a hazardous condition will not exist if the jumper wire opens.
2. Trace along the copper pattern from both sides of the pattern break and locate the nearest component that is directly connected to the affected copper pattern.
3. Connect insulated 20-gauge jumper wire from the lead of the nearest component on one side of the pattern break to the lead of the nearest component on the other side.
Carefully crimp and solder the connections.

CAUTION: Be sure the insulated jumper wire is dressed so the

it does not touch components or sharp edges.

SPECIFICATION

NOTE : Specifications and others are subject to change without notice for improvement.

1. Application range

This specification is applied to the LCD TV used LB0AZ chassis.

2. Requirement for Test

Each part is tested as below without special appointment.

- 1) Temperature: $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ ($77^{\circ}\text{F} \pm 9^{\circ}\text{F}$), CST: $40^{\circ}\text{C} \pm 5^{\circ}\text{C}$
- 2) Relative Humidity : $65\% \pm 10\%$
- 3) Power Voltage
 - : Standard input voltage (AC 100-240 V~, 50 / 60 Hz)
 - * Standard Voltage of each products is marked by models.
- 4) Specification and performance of each parts are followed each drawing and specification by part number in accordance with BOM.
- 5) The receiver must be operated for about 5 minutes prior to the adjustment.

3. Test method

- 1) Performance: LGE TV test method followed
- 2) Demanded other specification
 - Safety: CE, IEC specification
 - EMC:CE, IEC

4. Model General Specification

No.	Item	Specification	Remarks
1.	Market	Australilia, NewZealand, Singapore, Malaysia, Vietnam, Indonesia, South Africa, Israel, A-ASIA	only Analog for A-ASIA
2.	Broadcasting system	1) PAL/SECAM-B/G/D/K 2) PAL-I/II 3) NTSC-M 4) DVB-T	PAL for NZ/SG
3.	Receiving system	Analog : Upper Heterodyne Digital : COFDM(DVB-T)	► DVB-T - Guard Interval(Bitrate_Mbit/s) 1/4, 1/8, 1/16, 1/32 - Modulation : Code Rate QPSK : 1/2, 2/3, 3/4, 5/6, 7/8 16-QAM : 1/2, 2/3, 3/4, 5/6, 7/8 64-QAM : 1/2, 2/3, 3/4, 5/6, 7/8
4.	Video Input RCA	PAL, SECAM, NTSC	4 System : PAL, SECAM, NTSC, PAL60
5.	Component Input	Y/Cb/Cr, Y/Pb/Pr	
6.	RGB Input (1EA)	RGB-PC	Analog(D-SUB 15PIN)
7.	HDMI Input	HDMI1-DTV/DVI HDMI2-DTV/DVI HDMI3-DTV/DVI	PC - HD Model : HDMI version 1.3 - FHD Model : HDMI version 1.4 Support HDCP
8.	Audio Input	RGB/DVI Audio Component AV	
9.	SDPIF out	SPDIF out	
10.	USB	For My Media(Movie/Photo/Music List) or For SVC	

5. Component Video Input (Y, Pb, Pr)

No.	Specification				Remark
	Resolution	H-freq(kHz)	V-freq(Hz)		
1.	720x480	15.73	60.00	SDTV,DVD 480i	
2.	720x480	15.63	59.94	SDTV,DVD 480i	
3.	720x480	31.47	59.94	480p	
4.	720x480	31.50	60.00	480p	
5.	720x576	15.625	50.00	SDTV,DVD 625 Line	
6.	720x576	31.25	50.00	HDTV 576p	
7.	1280x720	45.00	50.00	HDTV 720p	
8.	1280x720	44.96	59.94	HDTV 720p	
9.	1280x720	45.00	60.00	HDTV 720p	
10.	1920x1080	31.25	50.00	HDTV 1080i	
11.	1920x1080	33.75	60.00	HDTV 1080i	
12.	1920x1080	33.72	59.94	HDTV 1080i	
13.	1920x1080	56.250	50	HDTV 1080p	
14.	1920x1080	67.5	60	HDTV 1080p	

6. RGB Input (PC)

No.	Specification				Proposed	Remark
	Resolution	H-freq(kHz)	V-freq(Hz)	Pixel Clock(MHz)		
1.	720*400	31.468	70.08	28.321		For only DOS mode
2.	640*480	31.469	59.94	25.17	VESA	Input 848*480 60 Hz, 852*480 60 Hz -> 640*480 60 Hz Display
3.	800*600	37.879	60.31	40.00	VESA	
4.	1024*768	48.363	60.00	65.00	VESA(XGA)	
5.	1280*768	47.78	59.87	79.5	WXGA	
6.	1360*768	47.72	59.8	84.75	WXGA	
7.	1280*1024	63.981	60.02	108.875	SXGA	FHD Model
8.	1920*1080	66.587	59.93	138.625	WUXGA	FHD model

7. HDMI Input

(1) DTV Mode

No.	Resolution	H-freq(kHz)	V-freq.(Hz)	Pixel clock(MHz)	Proposed	Remark
1.	720*480	31.469 /31.5	59.94 /60	27.00/27.03	SDTV 480P	
2.	720*576	31.25	50	54	SDTV 576P	
3.	1280*720	37.500	50	74.25	HDTV 720P	
4.	1280*720	44.96 /45	59.94 /60	74.17/74.25	HDTV 720P	
5.	1920*1080	33.72 /33.75	59.94 /60	74.17/74.25	HDTV 1080I	
6.	1920*1080	28.125	50.00	74.25	HDTV 1080I	
7.	1920*1080	26.97 /27	23.97 /24	74.17/74.25	HDTV 1080P	
8.	1920*1080	33.716 /33.75	29.976 /30.00	74.25	HDTV 1080P	
9.	1920*1080	56.250	50	148.5	HDTV 1080P	
10.	1920*1080	67.43 /67.5	59.94 /60	148.35/148.50	HDTV 1080P	

(2) PC Mode

No.	Resolution	H-freq(kHz)	V-freq.(Hz)	Pixel clock(MHz)	Proposed	Remark
1.	720*400	31.468	70.08	28.321		HDCP
2.	640*480	31.469	59.94	25.17	VESA	HDCP
3.	800*600	37.879	60.31	40.00	VESA	HDCP
4.	1024*768	48.363	60.00	65.00	VESA(XGA)	HDCP
5.	1360*768	47.72	59.8	84.75	WXGA	HDCP
6.	1280*1024	63.981	60.02	108.875	SXGA	HDCP/FHD model
7.	1920*1080	67.5	60.00	138.625	WUXGA	HDCP/FHD model

ADJUSTMENT INSTRUCTION

1. Application Range

This specification sheet is applied to all of the LCD TV with LB0AZ chassis.

2. Designation

- 1) The adjustment is according to the order which is designated and which must be followed, according to the plan which can be changed only on agreeing.
- 2) Power Adjustment: Free Voltage
- 3) Magnetic Field Condition: Nil.
- 4) Input signal Unit: Product Specification Standard
- 5) Reserve after operation: Above 5 Minutes (Heat Run)
 - Temperature : at 25 °C ± 5 °C
 - Relative humidity : 65 % ± 10 %
 - Input voltage : 220 V, 60 Hz
- 6) Adjustment equipments: Color Analyzer(CA-210 or CA-110), DDC Adjustment Jig equipment, Service remote control.
- 7) Push the "IN STOP" key - For memory initialization.

Case1 : Software version up

1. After downloading S/W by USB, TV set will reboot automatically.
2. Push "In-stop" key.
3. Push "Power on" key.
4. Function inspection
5. After function inspection, Push "In-stop" key.

Case2 : Function check at the assembly line

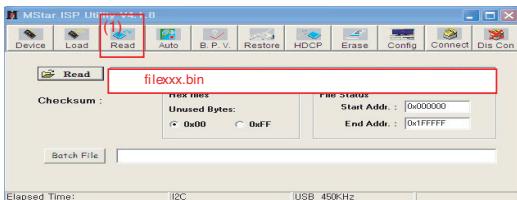
1. When TV set is entering on the assembly line, Push "In-stop" key at first.
2. Push "Power on" key for turning it on.
 - > If you push "Power on" key, TV set will recover channel information by itself.
3. After function inspection, Push "In-stop" key.

3. Main PCB check process

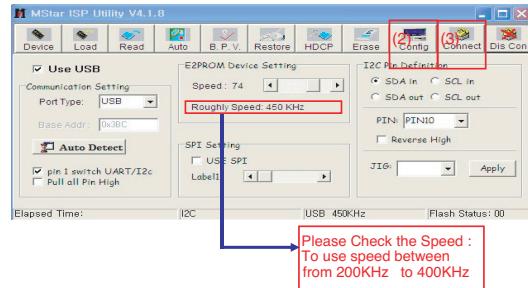
* APC - After Manual-Insert, executing APC

* Boot file Download

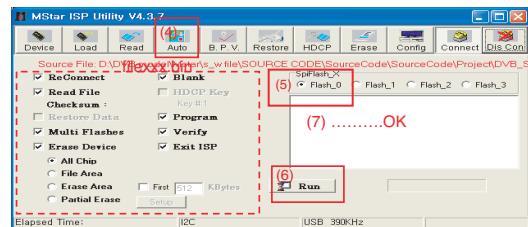
- 1) Execute ISP program "Mstar ISP Utility" and then click "Config" tab.



- 2) Set as below, and then click "Auto Detect" and check "OK" message.
If "Error" is displayed, Check connection between computer, jig, and set.
- 3) Click "Read" tab, and then load download file(XXXX.bin) by clicking "Read".
- 4) Click "Connect" tab. If "Can't" is displayed, check connection between computer, jig, and set.

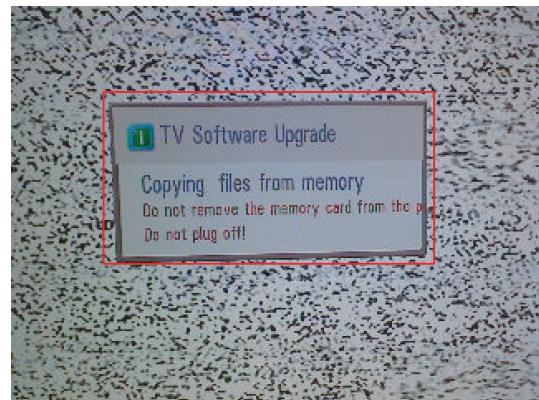


- 5) Click "Auto" tab and set as below.
- 6) Click "Run".
- 7) After downloading, check "OK" message.



* USB DOWNLOAD

- 1) Put the USB Stick to the USB socket.
- 2) Automatically detecting update file in USB Stick
 - If your downloaded program version in USB Stick is Low, it didn't work. But your downloaded version is High, USB data is automatically detecting.
- 3) Show the message "Copying files from memory".



4) Updating is starting.



5) Uploading completed, the TV will restart automatically.

- 6) If your TV is turned on, check your updated version and Tool option.(explain the Tool option, next stage)
 * If downloading version is more high than your TV have, TV can lost all channel data. In this case, you have to channel recover. if all channel data is cleared, you didn't have a DTV/ATV test on production line.

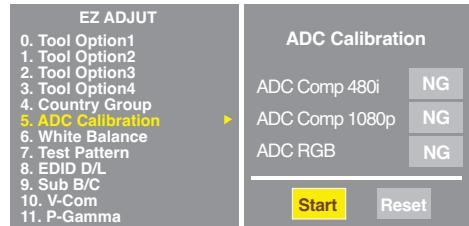
* After downloading, have to adjust Tool Option again.

- 1) Push "IN-START" key in service remote control.
- 2) Select "Tool Option 1" and Push "OK" key.
- 3) Punch in the number. (Each model has their number)

3.1. ADC Process

(1) ADC

- Enter Service Mode by pushing "ADJ" key.
- Enter Internal ADC mode by pushing "▶" key at "5. ADC Calibration".



<Caution> Using 'power on' key of the Adjustment remote control, power on TV.

* ADC Calibration Protocol (RS232)

No	Item	CMD1	CMD2	Data0	
Enter Adjust Mode	Adjust 'Mode In'	A	A	0 0	When transfer the 'Mode In', Carry the command.
ADC adjust	ADC Adjust	A	D	1 0	Automatically adjustment (The use of a internal pattern)

Adjust Sequence

- aa 00 00 [Enter Adjust Mode]
- xb 00 40 [Component1 Input (480i)]
- ad 00 10 [Adjust 480i Comp1]
- xb 00 60 [RGB Input (1024*768)]
- ad 00 10 [Adjust 1024*768 RGB]
- aa 00 90 End Adjust mode

* Required equipment : Adjustment remote control.

3.2. Function Check

* Check display and sound

- Check Input and Signal items. (cf. work instructions)
 - 1) TV
 - 2) AV (SCART1/SCART2/ CVBS)
 - 3) COMPONENT (480i)
 - 4) RGB (PC : 1024 x 768 @ 60hz)
 - 5) HDMI
 - 6) PC Audio In
- * Display and Sound check is executed by Remote control.

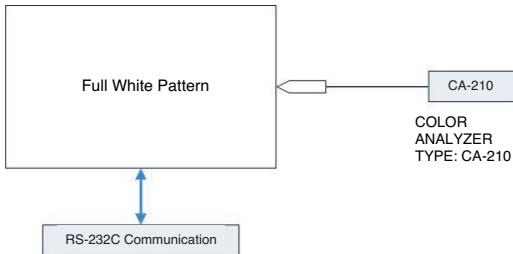
4. Total Assembly line process

4.1. Adjustment Preparation

- W/B Equipment condition
CA210
- : CCFL/EEFL -> CH9, Test signal: Inner pattern(80IRE)
LED -> CH14, Test signal: Inner pattern(80IRE)
- Above 5 minutes H/run in the inner pattern. ("Power on" key of adjustment remote control)

Cool	13,000	K	X=0.269(± 0.002) Y=0.273(± 0.002)	<Test Signal> Inner pattern (204gray,80IRE)
Medium	9,300	K	X=0.285(± 0.002) Y=0.293(± 0.002)	
Warm	6,500	K	X=0.313(± 0.002) Y=0.329(± 0.002)	

- Connecting picture of the measuring instrument
(On Automatic control)
Inside Pattern is used when W/B is controlled. Connect to auto controller or push Adjustment remote control POWER ON -> Enter the mode of White-Balance, the pattern will come out.



- Auto-control interface and directions
 - Adjust in the place where the influx of light like floodlight around is blocked. (illumination is less than 10 lux).
 - Adhere closely the Color Analyzer (CA210) to the module less than 10 cm distance, keep it with the surface of the Module and Color Analyzer's prove vertically.(80° ~ 100°)
 - Aging time
 - After aging start, keep the power on (no suspension of power supply) and heat-run over 5 minutes.
 - Using 'no signal' or 'full white pattern' or the others, check the back light on.

• Auto adjustment Map(RS-232C)

RS-232C COMMAND

[CMD ID DATA]

Wb 00 00	White Balance Start
Wb 00 ff	White Balance End

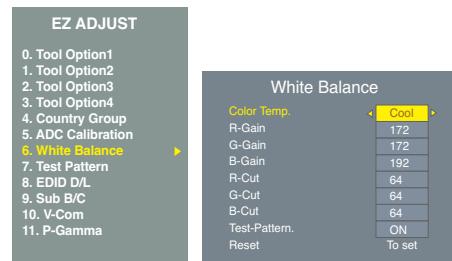
	RS-232C COMMAND			MIN	CENTER			MAX
	[CMD ID DATA]				(DEFAULT)			
	Cool	Mid	Warm		Cool	Mid	Warm	
R Gain	jg	Ja	jd	00	172	192	192	192
G Gain	jh	Jb	je	00	172	192	192	192
B Gain	ji	Jc	jf	00	192	192	172	192
R Cut					64	64	64	128
G Cut					64	64	64	128
B Cut					64	64	64	128

<Caution>

Color Temperature : COOL, Medium, Warm.
One of R Gain/G Gain/ B Gain should be kept on 0xC0, and adjust other two lower than C0.
(when R/G/B Gain are all C0, it is the FULL Dynamic Range of Module)

* Manual W/B process using adjusts Remote control.

- After enter Service Mode by pushing "ADJ" key.
- Enter White Balance by pushing "▶" key at "6. White Balance".



- After done all adjustments, Press "In-start" key and compare Tool option and Area option value with its BOM, if it is correctly same then unplug the AC cable. If it is not same, then correct it same with BOM and unplug AC cable. For correct it to the model's module from factory Jig model.
- Push the "IN STOP" key after completing the function inspection. And Mechanical Power Switch must be set "ON".

4.2. DDC EDID Write (RGB 128Byte)

- Connect D-sub Signal Cable to D-sub Jack.
- Write EDID Data to EEPROM(24C02) by using DDC2B protocol.
- Check whether written EDID data is correct or not.
- For Service main Assembly, EDID have to be downloaded to Insert Process in advance.

4.3. DDC EDID Write (HDMI 256Byte)

- Connect HDMI Signal Cable to HDMI Jack.
- Write EDID Data to EEPROM(24C02) by using DDC2B protocol.
- Check whether written EDID data is correct or not.
- For Service main Assembly, EDID have to be downloaded to Insert Process in advance.

4.4. EDID DATA

- All Data : HEXA Value

- Changeable Data :

*: Serial No : Controlled / Data:01

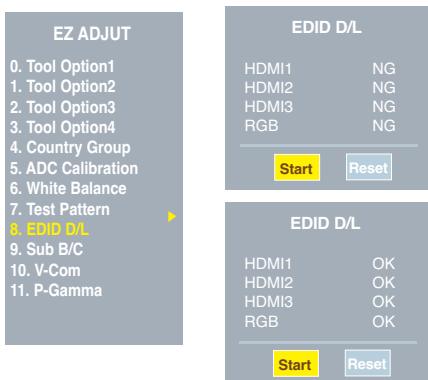
**: Month : Controlled / Data:00

***. Year : Controlled

****: Check sum

4.5. Auto Download

- 1) After enter Service Mode by pushing "ADJ" key.
- 2) Enter EDID D/L menu.
- 3) Enter "START" by pushing "OK" key.



<Caution> Never connect HDMI & D-sub cable when EDID downloaded.

* Edid data and Model option download (RS232)

NO	Item	CMD1	CMD2	Data0	
Enter download Mode	Download 'Mode In'	A	A	0 0	When transfer the 'Mode In', Carry the command.
EDID data and Model option download	Download	A	E	00 10	Automatically Download (The use of a internal pattern)

- Manual Download

* Caution

- 1) Use the proper signal cable for EDID Download.
 - Analog EDID : Pin3 exists
 - Digital EDID : Pin3 exists
- 2) Never connect HDMI & D-sub Cable at the same time.
- 3) Use the proper cables below for EDID Writing.
- 4) Download HDMI1, HDMI2, separately because HDMI1 is different from HDMI2.

For Analog EDID	For HDMI EDID	
D-sub to D-sub	DVI-D to HDMI or HDMI to HDMI	
Item	Condition	Data(Hex)
Manufacturer ID	GSM	1E6D
Version	Digital : 1	01
Revision	Digital : 3	03

1) FHD RGB EDID data

0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0	0	ff	ff	ff	ff	ff	0	1e	6d	a		b			
10	c	1	3	68	10	9	78	0a	ee	91	a3	54	4c	99	26
20	0f	50	54	a1	8	0	81	80	61	40	45	40	31	40	1
30	1	1	1	1	1	1	2	3a	80	18	71	38	2d	40	58
40	45	0	a0	5a	0	0	0	1e	1	1d	0	72	51	d0	1e
50	6e	28	55	0	a0	5a	0	0	0	1e	0	0	0	fd	0
60	3e	1e	53	10	0	0a	20	20	20	20	20	20	20	d	
70														0	e

2) FHD HDMI EDID data

0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0	0	ff	ff	ff	ff	ff	0	1e	6d	a		b			
10	c	1	3	80	10	9	78	0a	ee	91	a3	54	4c	99	26
20	0f	50	54	a1	8	0	71	4f	81	80	1	1	1	1	1
30	1	1	1	1	1	1	2	3a	80	18	71	38	2d	40	58
40	45	0	a0	5a	0	0	0	1e	1b	21	50	a0	51	0	1e
50	48	88	35	0	a0	5a	0	0	0	1c	0	0	0	fd	0
60	3e	1e	53	10	0	0a	20	20	20	20	20	20	20	d	
70														1	e
80	2	3	26	f1	4e	10	1f	84	13	5	14	3	2	12	20
90	22	15	1	26	15	7	50	9	57	7		f			
A0	f	e3	5	3	1	1	1d	80	18	71	1c	16	20	58	2c
B0	25	0	a0	5a	0	0	0	9e	1	1d	0	72	51	d0	1e
C0	6e	28	55	0	a0	5a	0	0	0	1e	2	3a	80	18	71
D0	2d	40	58	2c	45	0	a0	5a	0	0	0	1e	1	1d	0
E0	52	d0	1e	20	b8	28	55	40	a0	5a	0	0	0	1e	0
F0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	e

* Detail EDID Options are below

Product ID

Model Name	HEX	EDID Table	DDC Function
FHD Model	0001	01 00	Analog/Digital

Serial No: Controlled on production line.

Month, Year: Controlled on production line:

ex) Week : '01' -> '01'

Year : '2011' -> '15' fix

Model Name(Hex):

MODEL	MODEL NAME(HEX)
all	00 00 00 FC 00 4C 47 20 54 56 0A 20 20 20 20 20 20

Checksum: Changeable by total EDID data.

Vendor Specific(HDMI)

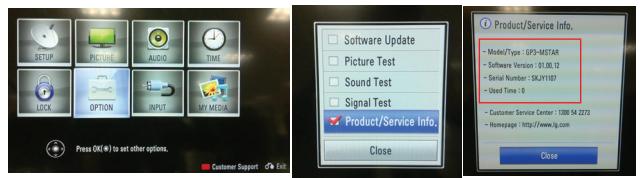
INPUT	MODEL NAME(HEX)
HDMI1	67030C001000B82D
HDMI2	67030C002000B82D
HDMI3	67030C003000B82D

5. Model name & Serial number D/L

- Press "Power on" key of service remote control.
(Baud rate : 115200 bps)
- Connect RS232 Signal Cable to RS-232 Jack.
- Write Serial number by use RS-232.
- Must check the serial number at the Product/Service info.(menu key -> red key -> select product/Service info.)



- Check the model name Instart menu. -> Factory name displayed. (ex 32LV2510-TB)
- Check the Product/Service info..(Menu key -> Red key -> Select product/Service info)



5.1. Signal TABLE

CMD	LENGTH	ADH	ADL	DATA_1	...	Data_n	CS	DELAY
-----	--------	-----	-----	--------	-----	--------	----	-------

CMD : A0h

LENGTH : 85~94h (1~16 bytes)

ADH : EEPROM Sub Address high (00~1F)

ADL : EEPROM Sub Address low (00~FF)

Data : Write data

CS : CMD + LENGTH + ADH + ADL + Data_1 +...+ Data_n

Delay : 20ms

5.2. Command Set

No.	Adjust mode	CMD(hex)	LENGTH(hex)	Description
1	EEPROM WRITE	A0h	84h+n	n-bytes Write (n = 1~16)

* Description

FOS Default write : <7mode data> write

Vtotal, V_Frequency, Sync_Polarity, Htotal, Hstart, Vstart, 0, Phase

Data write : Model Name and Serial Number write in EEPROM.,

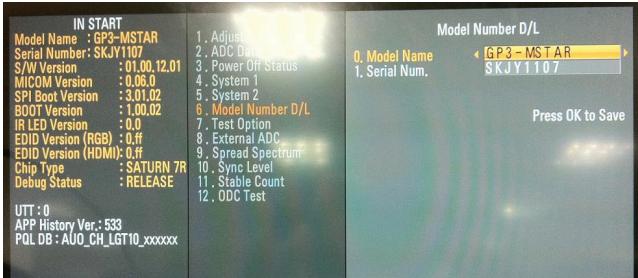
5.3. Method & notice

- Serial number D/L is using of scan equipment.
- Setting of scan equipment operated by Manufacturing Technology Group.
- Serial number D/L must be conformed when it is produced in production line, because serial number D/L is mandatory by D-book 4.0.

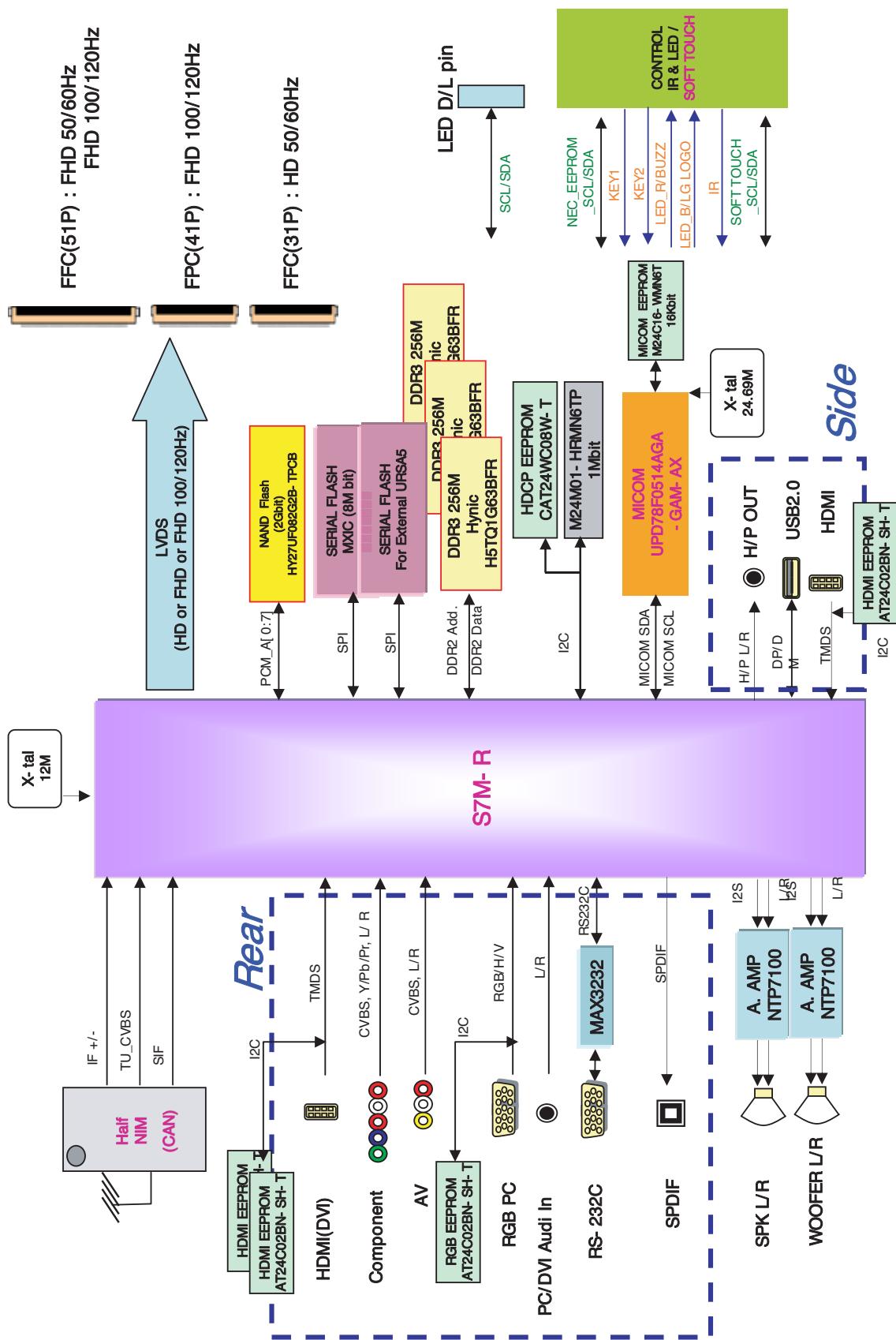
* Manual Download (Model Name and Serial Number)

If the TV set is downloaded by OTA or Service man, sometimes model name or serial number is initialized.(Not always)
There is impossible to download by bar code scan, so It need Manual download.

- Press the 'Instart' key of Adjustment remote control.
- Go to the menu '6.Model Number D/L' like below photo.
- Input the Factory model name(ex 32LV2510-TB) or Serial number like photo.



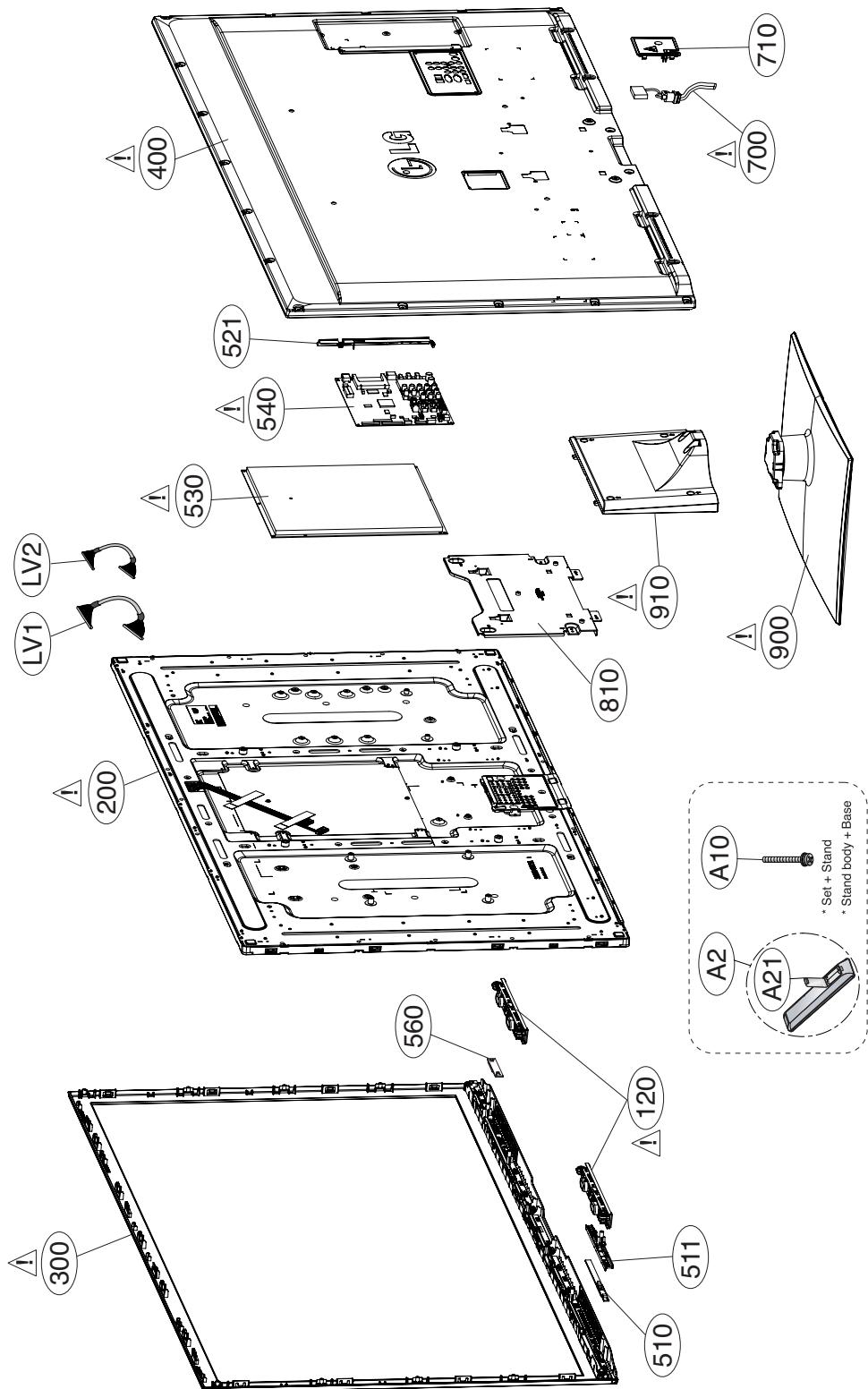
BLOCK DIAGRAM

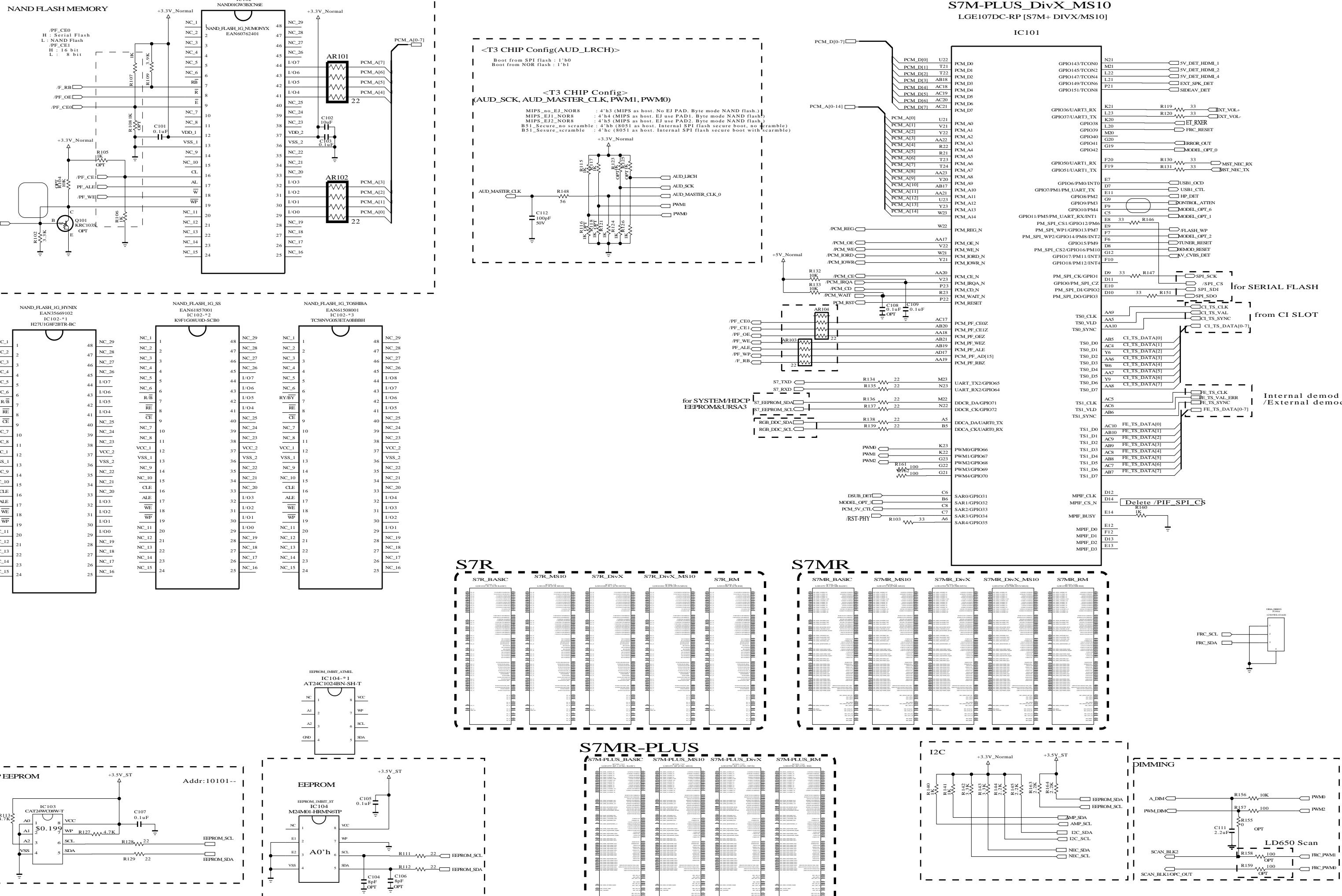


EXPLODED VIEW

IMPORTANT SAFETY NOTICE

Many electrical and mechanical parts in this chassis have special safety-related characteristics. These parts are identified by Δ in the Schematic Diagram and EXPLODED VIEW.
It is essential that these special safety parts should be replaced with the same components as recommended in this manual to prevent X-RADIATION, Shock, Fire, or other Hazards.
Do not modify the original design without permission of manufacturer.



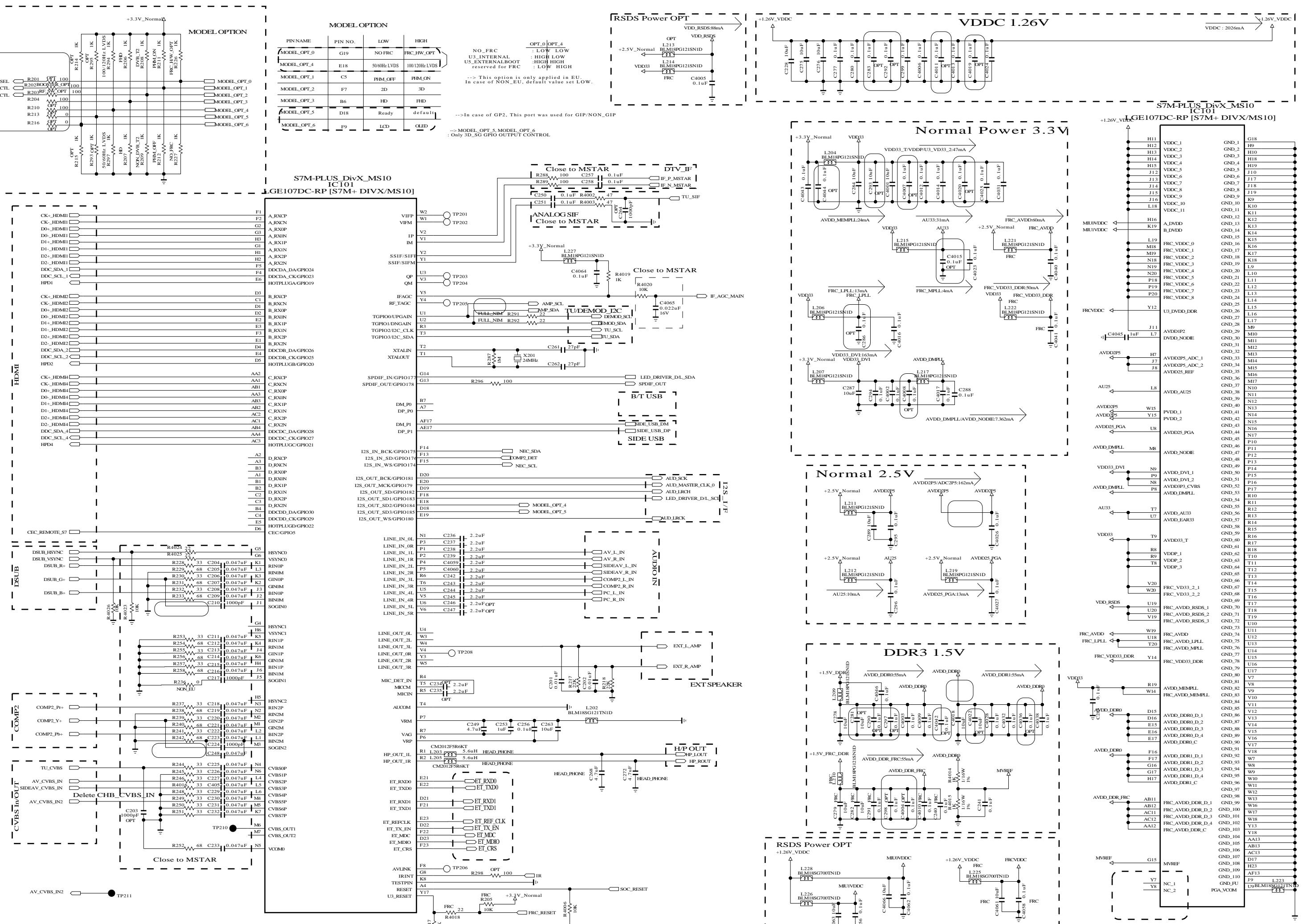


THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

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LG ELECTRONICS

MODEL	GP3_Saturn7M	DATE	Ver. 0.1
BLOCK	FLASH/EEPROM/GPIO	SHEET	1

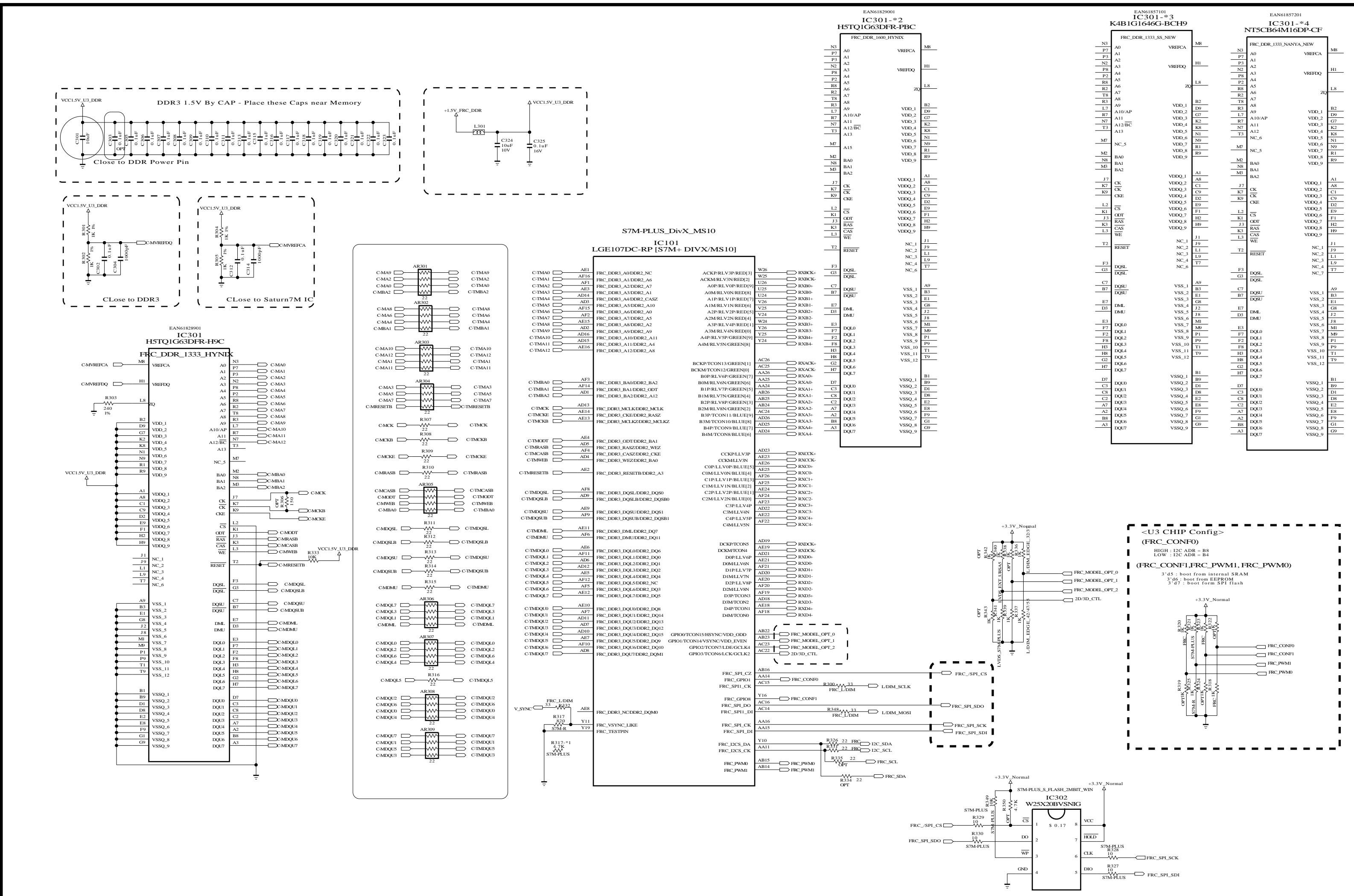


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LG Electronics

LG ELECTRONICS

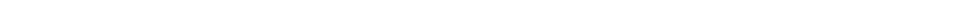
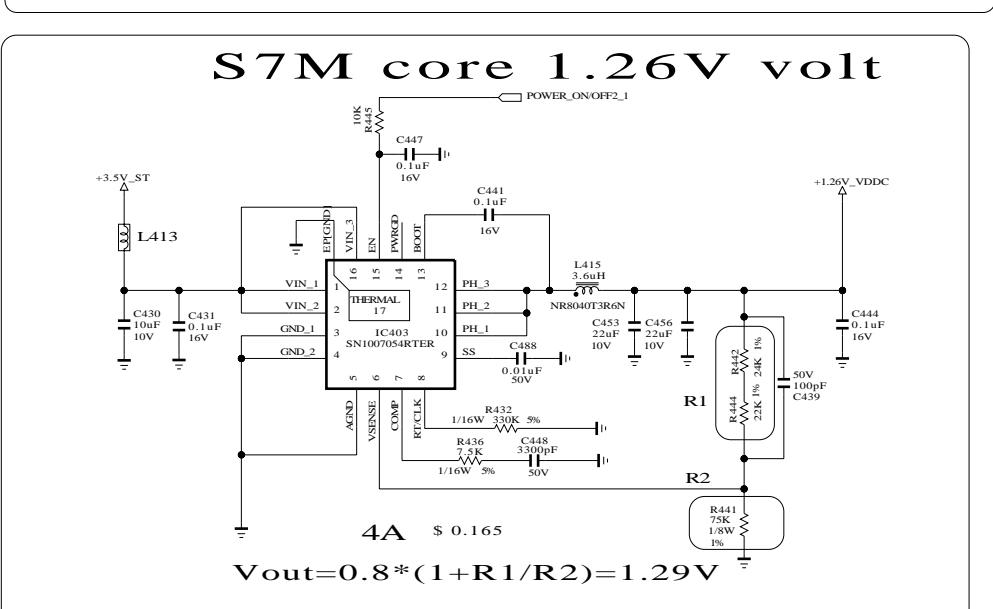
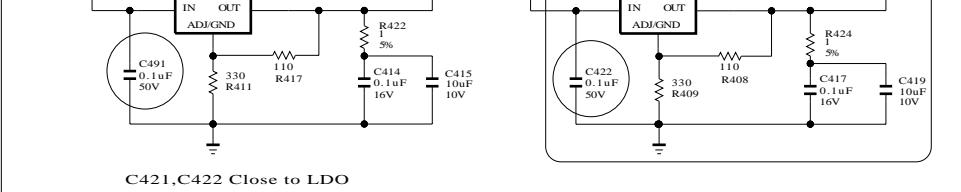
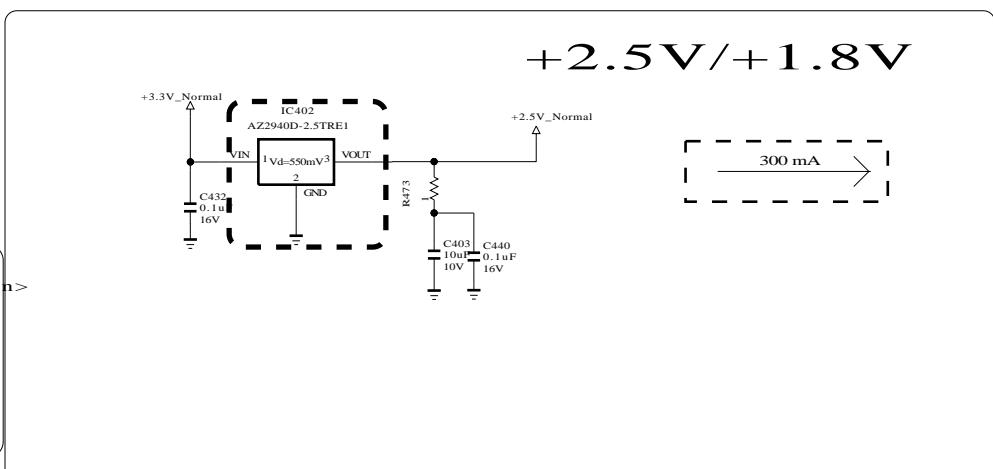
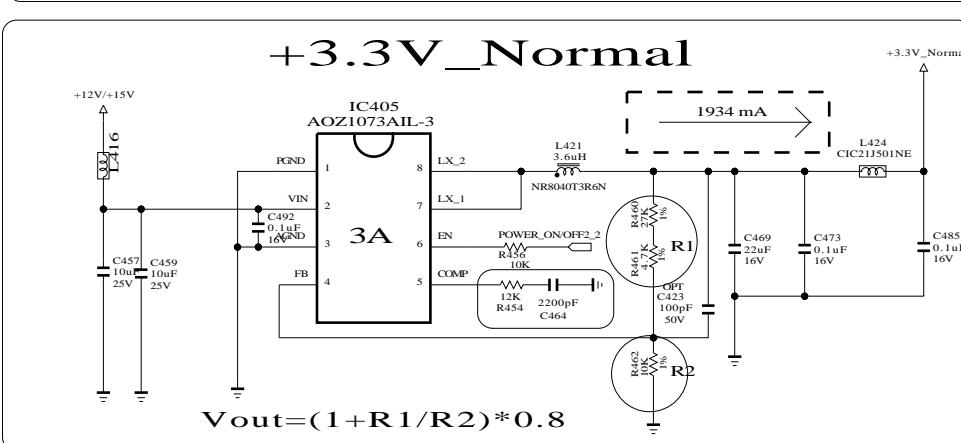
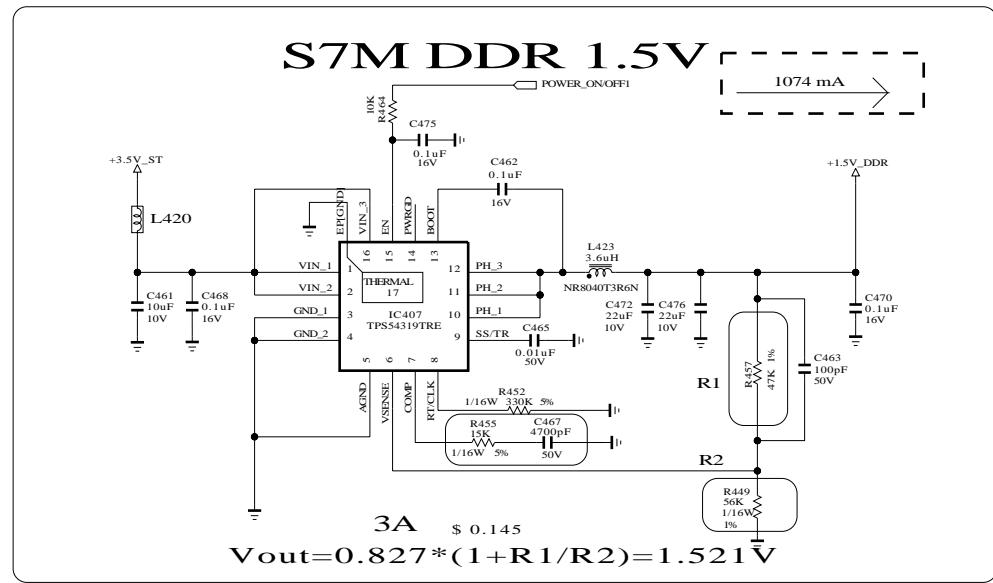
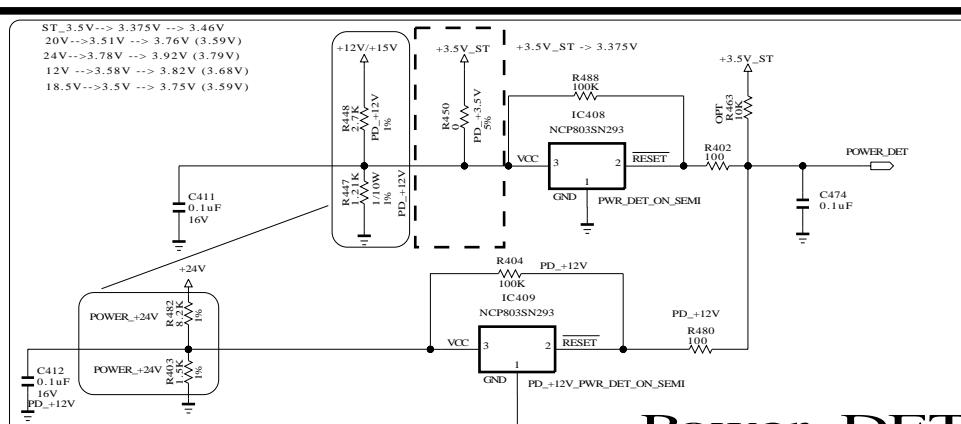
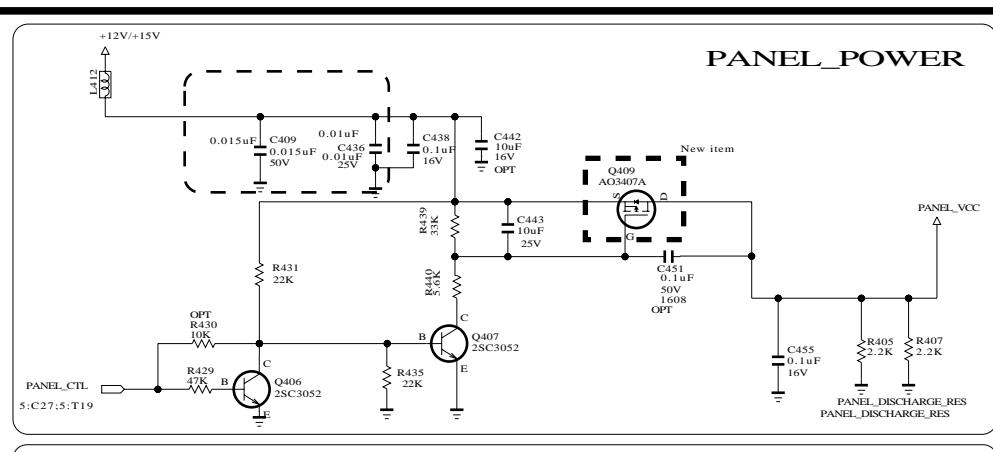
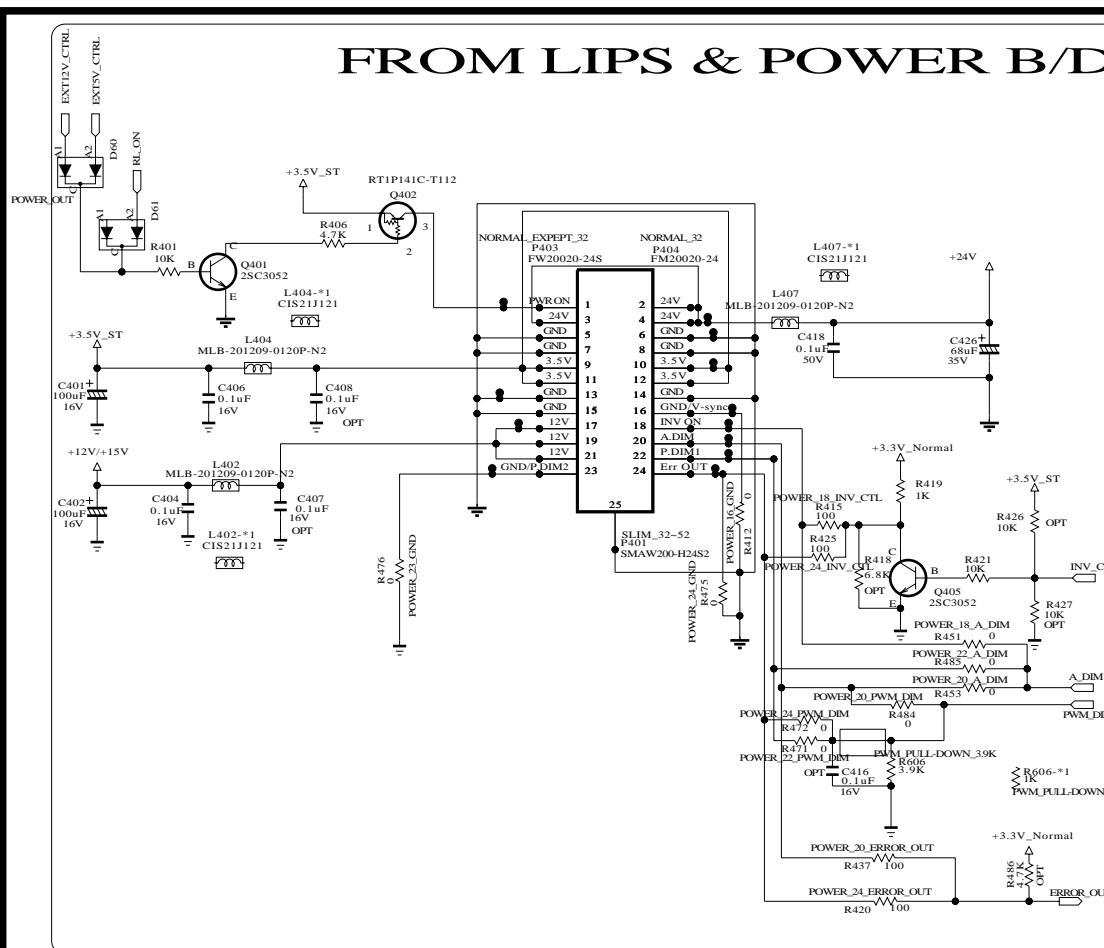
MODEL	GP2R	DATE	20101023
BLOCK	MAIN2, HW OPT	SHEET	2



THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

MODEL	GP2R	DATE
BLOCK	FRC_DDR	SHEET
		20101023
		3

FROM LIPS & POWER B/D



<MODULE PIN MAP>

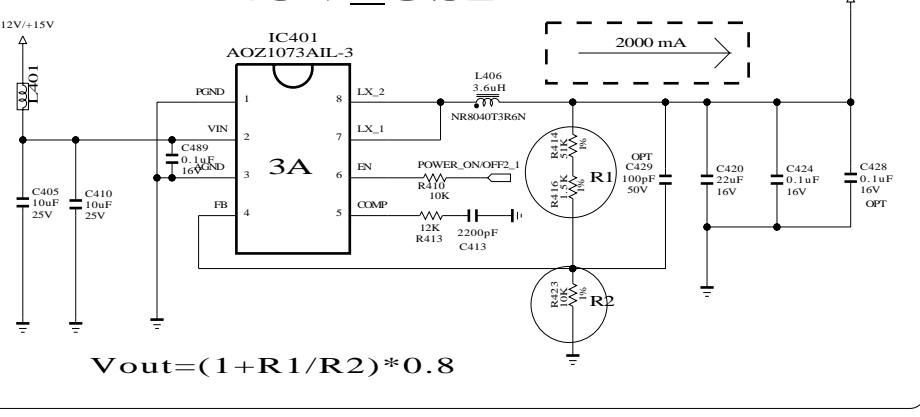
PIN No	LGD(PSU) or LIPS	CM010Lamp (PSU)	AUO 10'Lamp (PSU)	SHARP (PSU)	IPS @ (PSU)
16	GND	GND	GND	GND	GND
18	INV_ON	A-DIM	INV_ON	INV_ON	INV_ON
20	VBR-A	NC	Err_out	S2/60 ERROR 26/32HD:NC	Err_out
22	PWM_DIM	PWM_DIM	NC	60:NC	NC
24	Err_out	INV_ON	PWM_DIM	26/32/52:GND 60:PWM	PWM_DIM
23	GND	GND	GND	GND	GND

<LED MODULE PIN MAP -> latest update 20100618>

PIN No	LGD LPB / OS LPB	32LE5300-TA CM010LED (PSU)	AUO 10'LED (PSU)	32LE5300-TA LGD 10'LED (PSU)
16	NC	NC	NC	NC
18	INV_ON	INV_ON	INV_ON	INV_ON
20	NC	err_out --> NC	err_out --> NC	NC
22	PWM_DIM	NC	NC	PWM_DIM
24	err_out --> NC	PWM_DIM	PWM_DIM	err_out --> NC
23	NC	NC	NC	NC

LGD edge led error-out use or not? checking is necessary...

+5V_USB

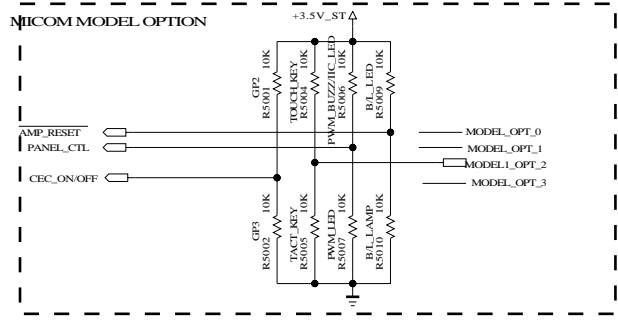


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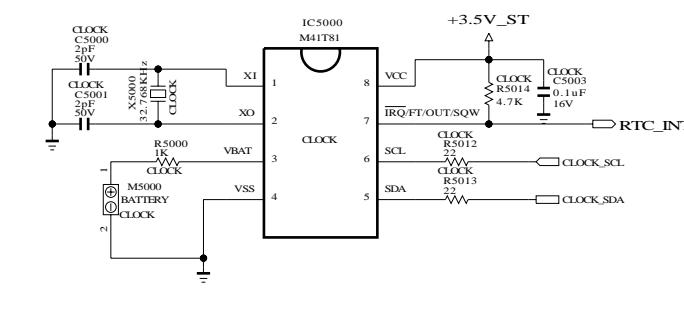
MODEL	GP2R	DATE	20101023
BLOCK	POWER_LARGE	SHEET	4



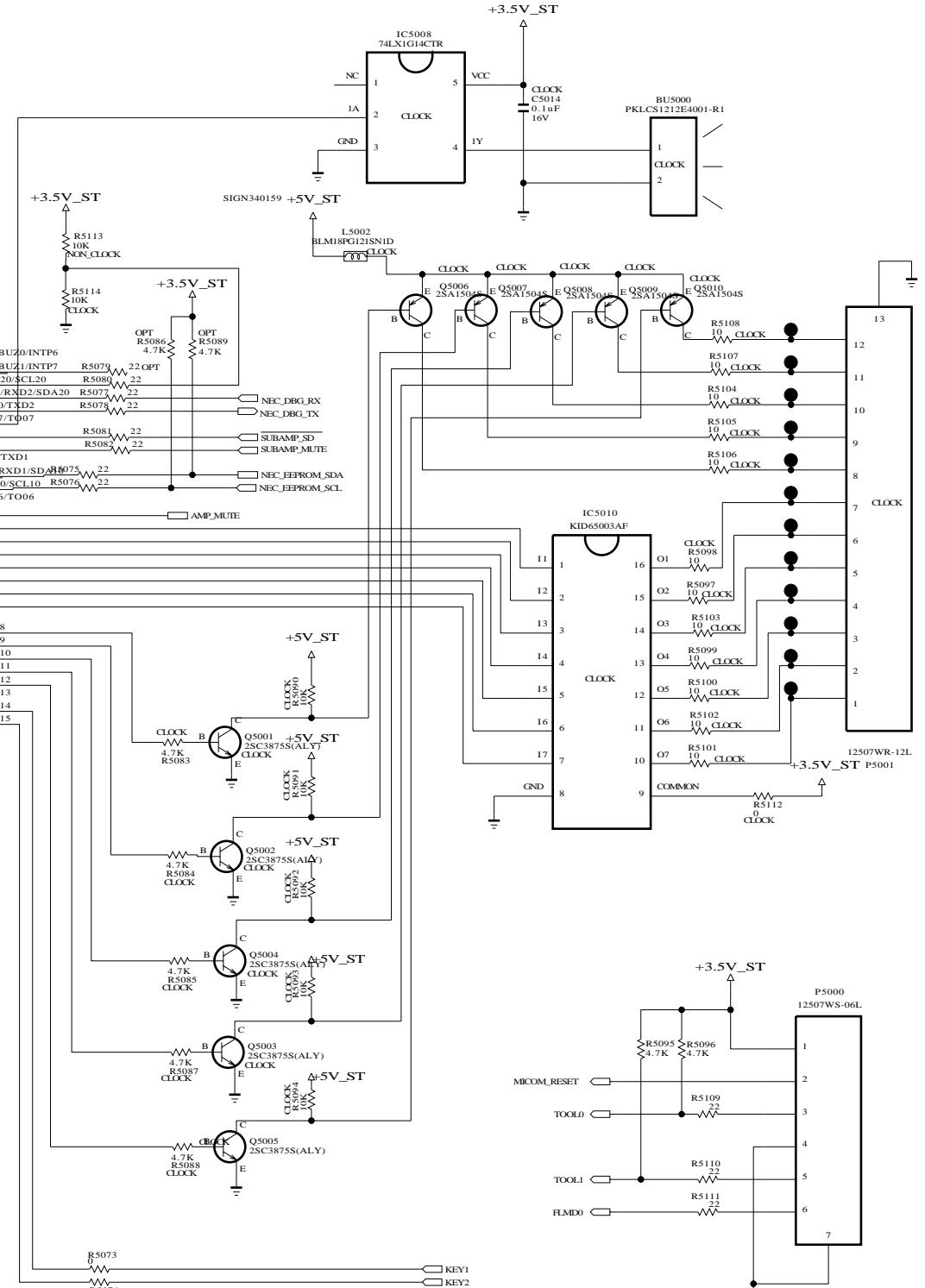
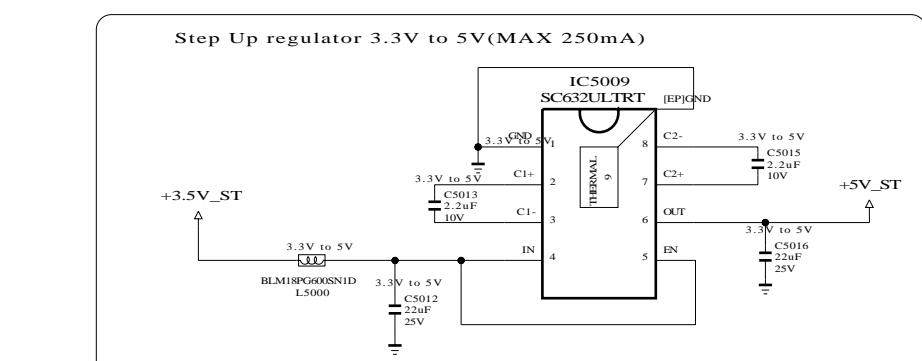
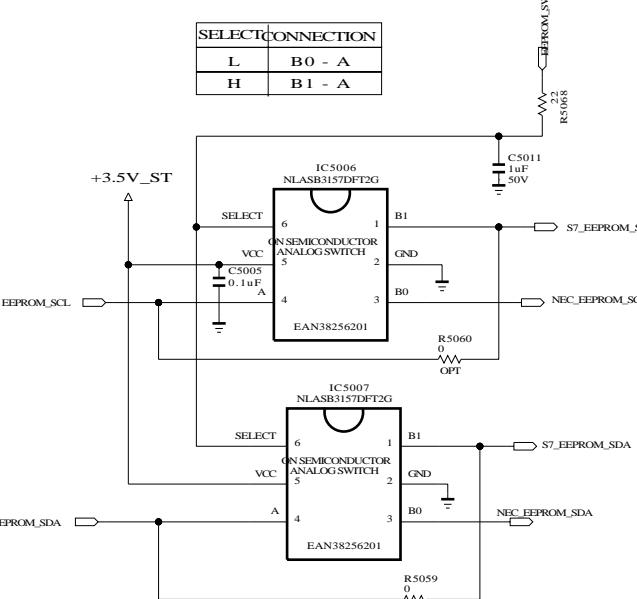
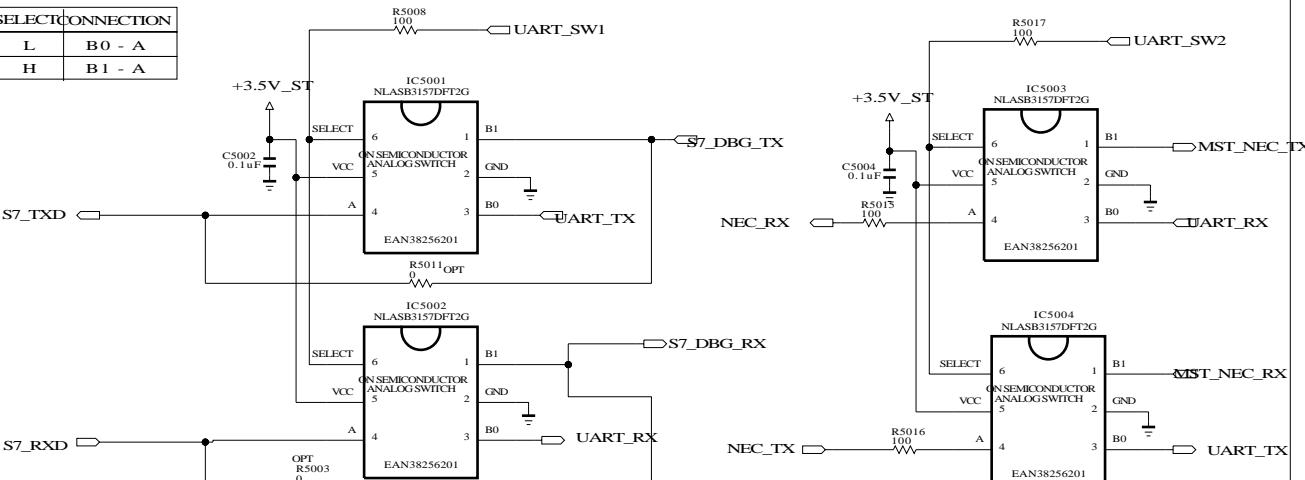
MODEL OPTION

PIN NAME	PIN NO.	HIGH	LOW
MODEL_OPT_0	8	B/L_LED	B/L_LAMP
MODEL_OPT_1	11	PWM_BUZZ/IIC_LED	PWM_LED
MODEL_OPT_2	30	TOUCH_KEY	TACT_KEY
MODEL_OPT_3	31	GP2	GP3
MODEL_OPT_0		MODEL_OPT_1	
LOW		LOW	
HIGH		HIGH	LOW
HIGH		HIGH	LOW
LOW		HIGH	LOW
HIGH		HIGH	LOW
HIGH		HIGH	HIGH
			TBD

REAL TIME CLOCK



UART SWITCH



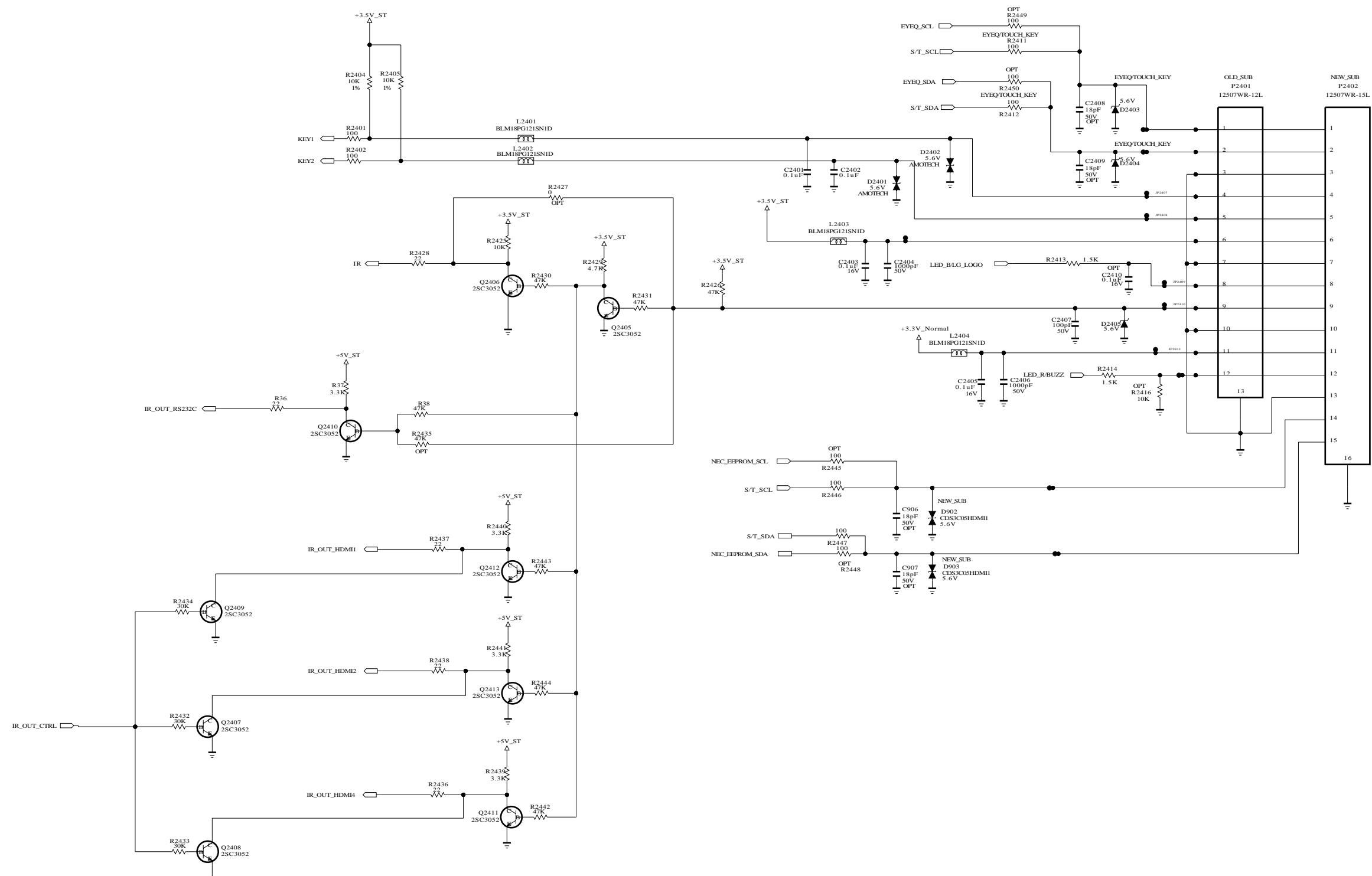
THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

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MODEL	GP2R	DATE
BLM18PG600SNID L5000	MICOM Rev.4	20101125
BLOCK	SHEET	5

CONTROL
IR & LED

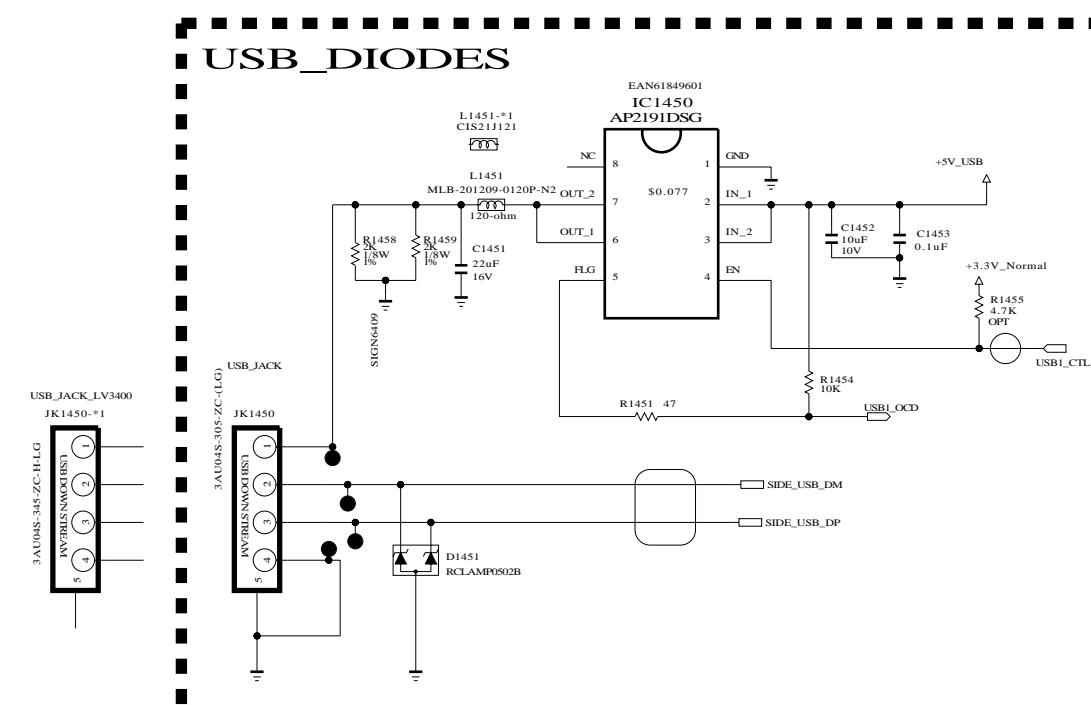


THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. IT IS ESSENTIAL THAT ONLY MANUFACTURED SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

SECRET
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LG ELECTRONICS

MODEL	GP2R	DATE	20101023
BLOCK	IR/CONTROL-L	SHEET	6 /

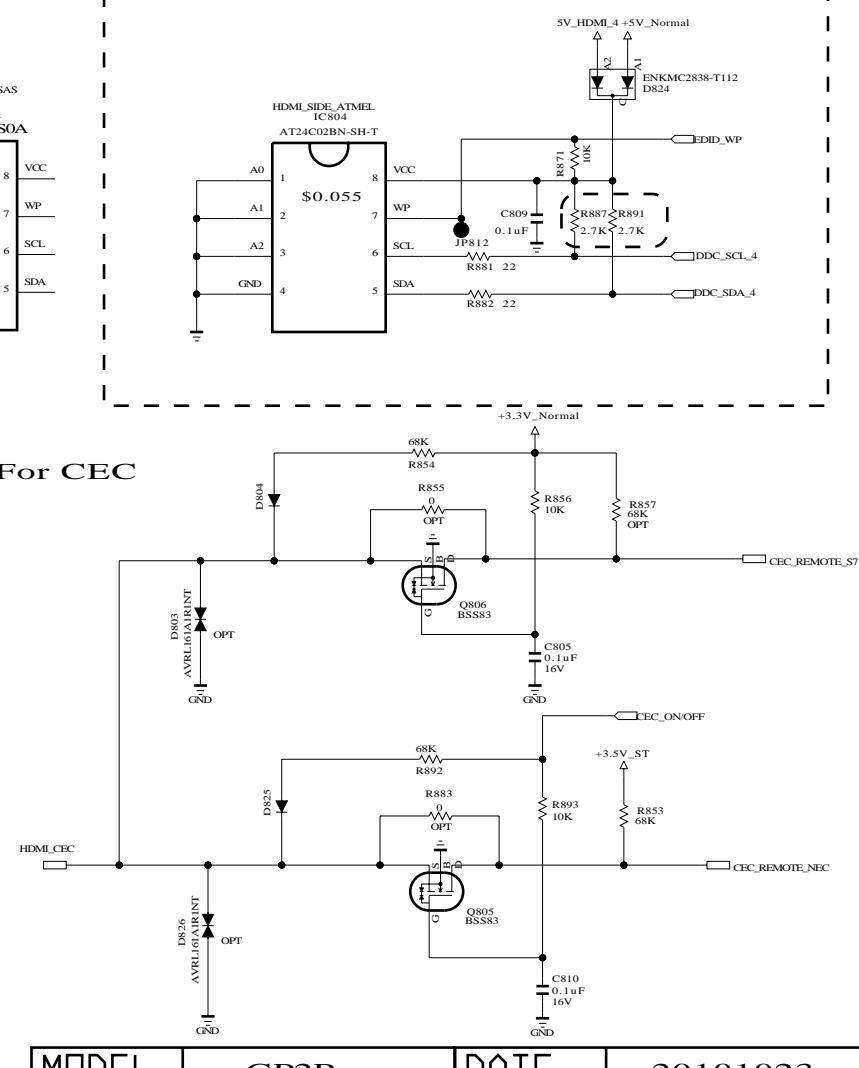
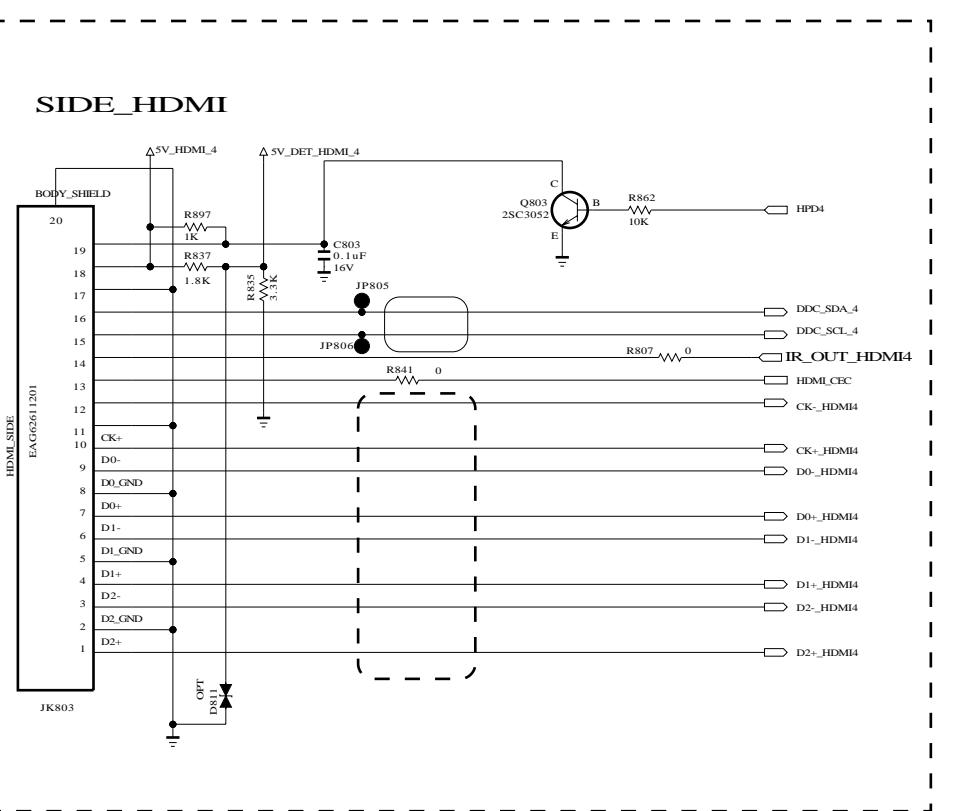
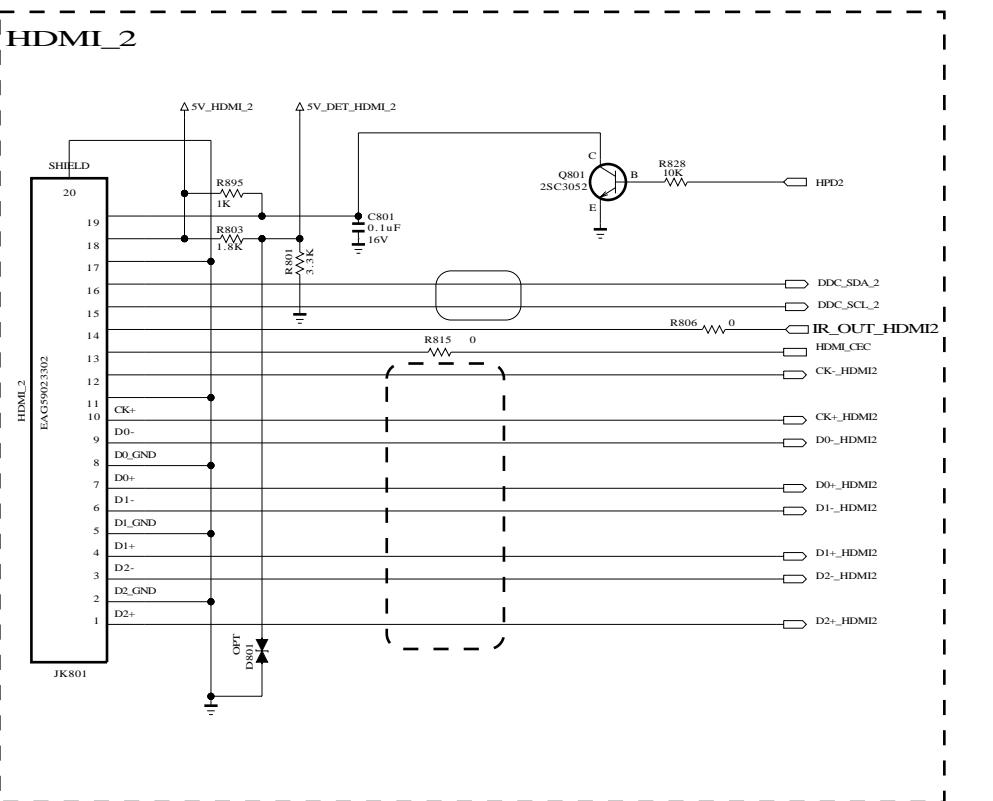
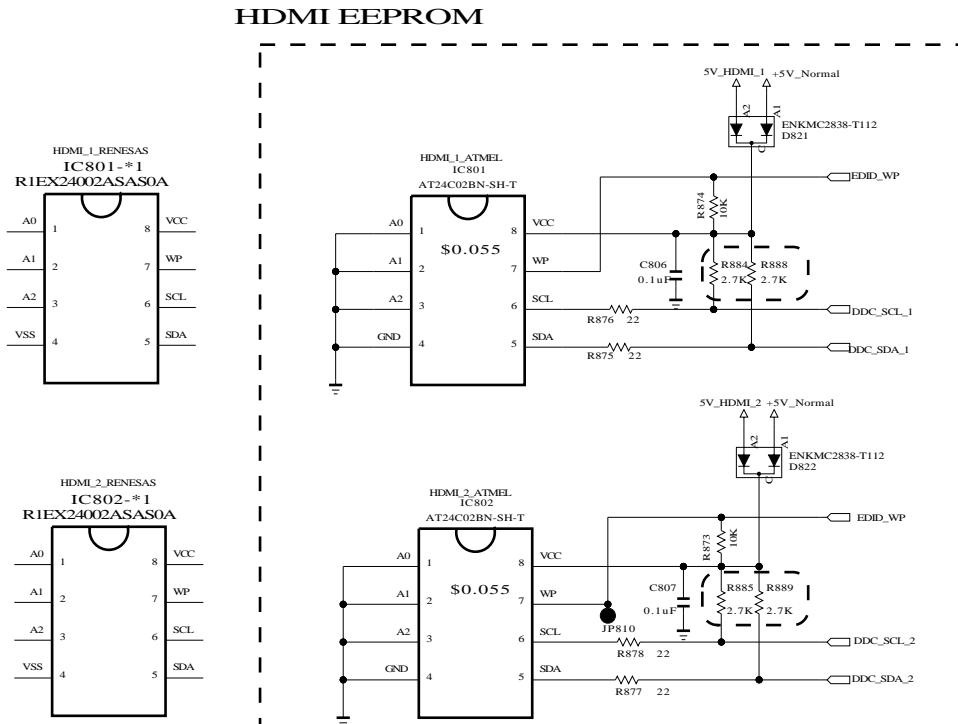
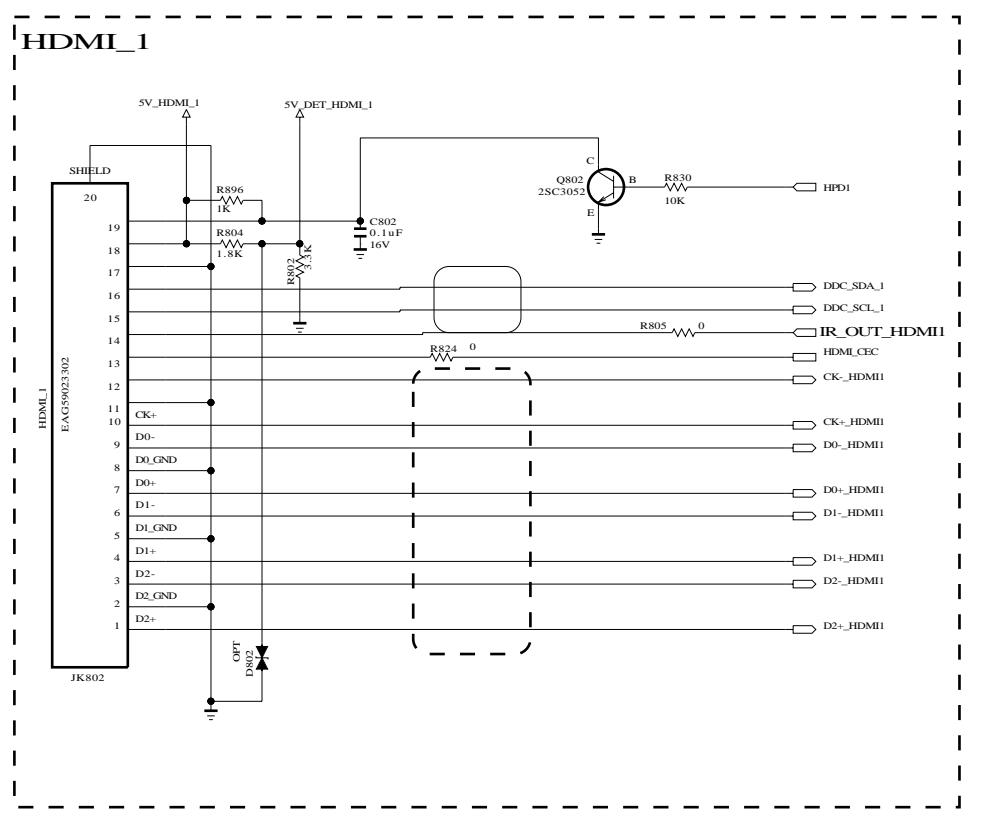


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LG Electronics

LG ELECTRONICS

MODEL	GP2R	DATE	20101023
BLOCK	USB_OCP_DIODE	SHEET	7 /



THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FIRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

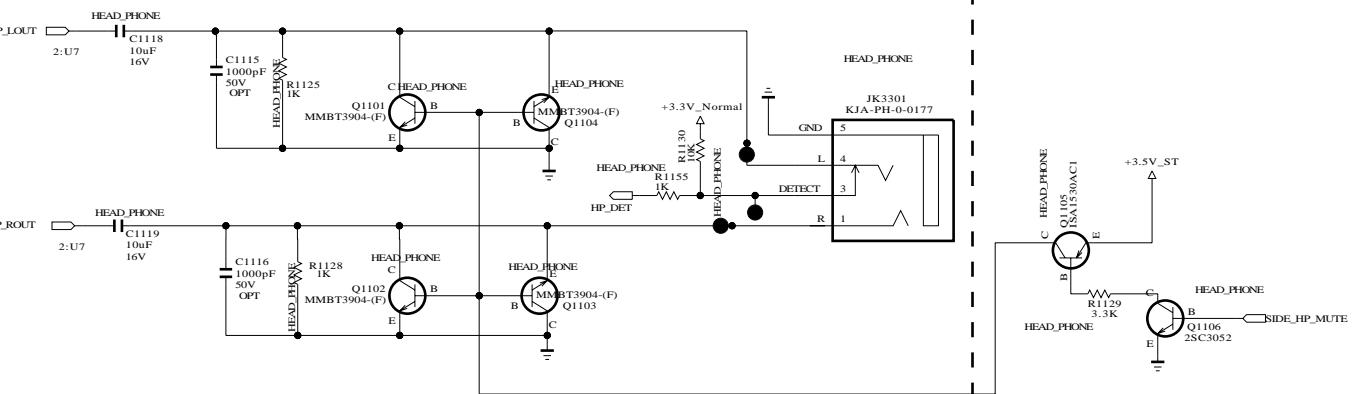
SECRET

 LG ELECTRONICS

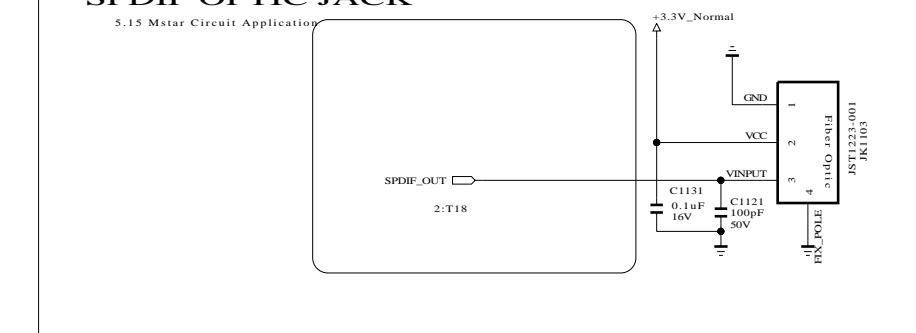
RGB/SPDIF/PC/HP

New Item Development

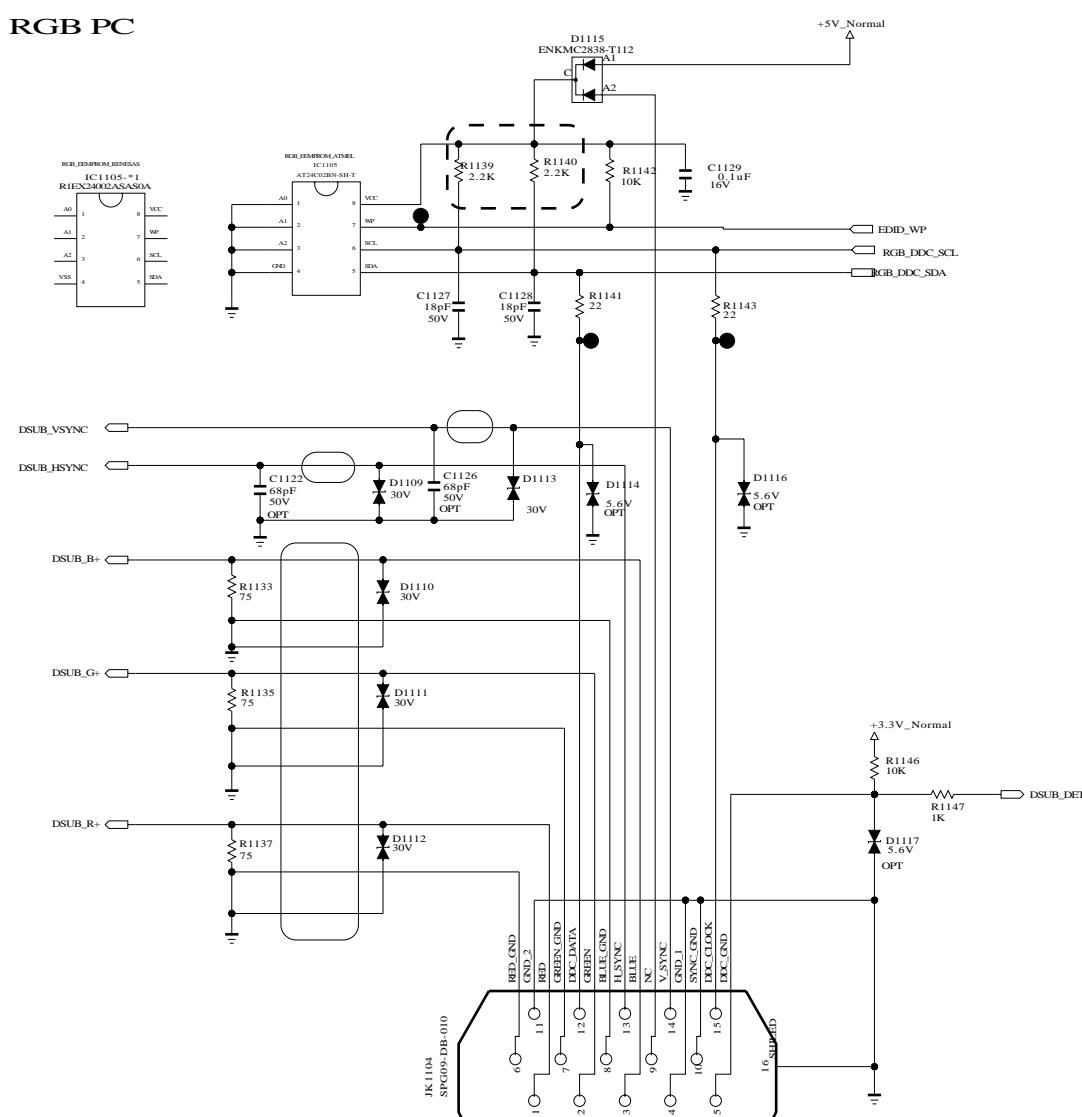
EARPHONE BLOCK or EXTERNAL SPEAKER JACK4



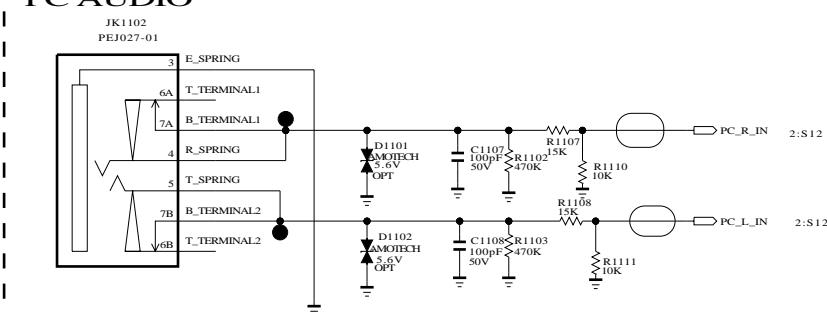
SPDIF OPTIC JACK



RGB PC



PC AUDIO



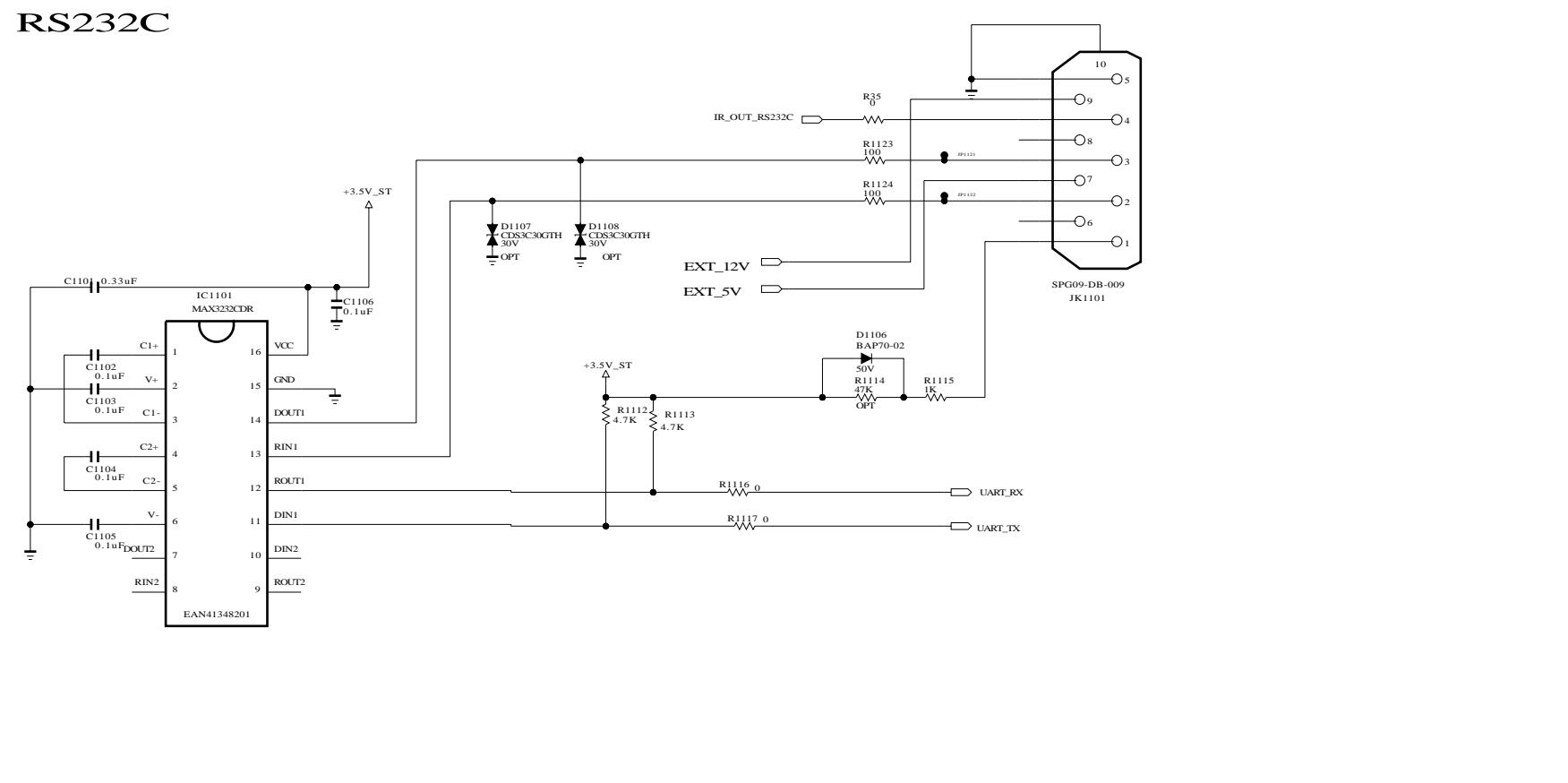
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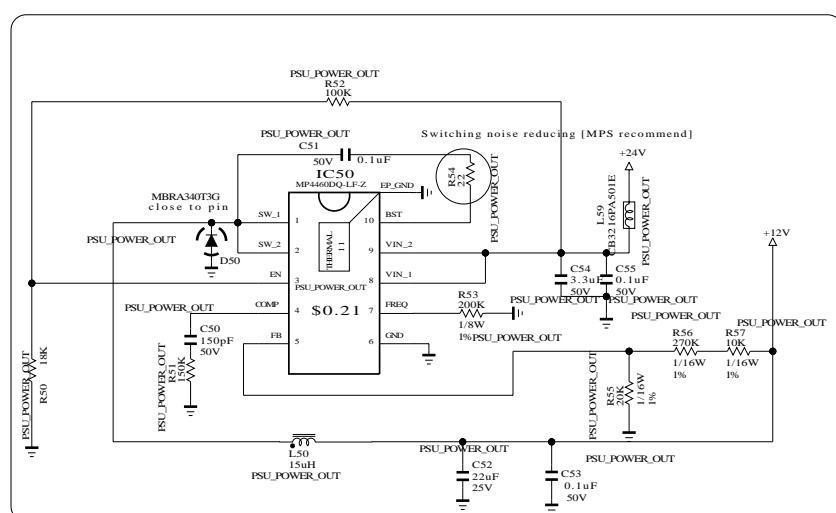
LG ELECTRONICS

MODEL	GP2R	DATE	20101023
BLOCK	RGB/SPDIF/HP	SHEET	9 /

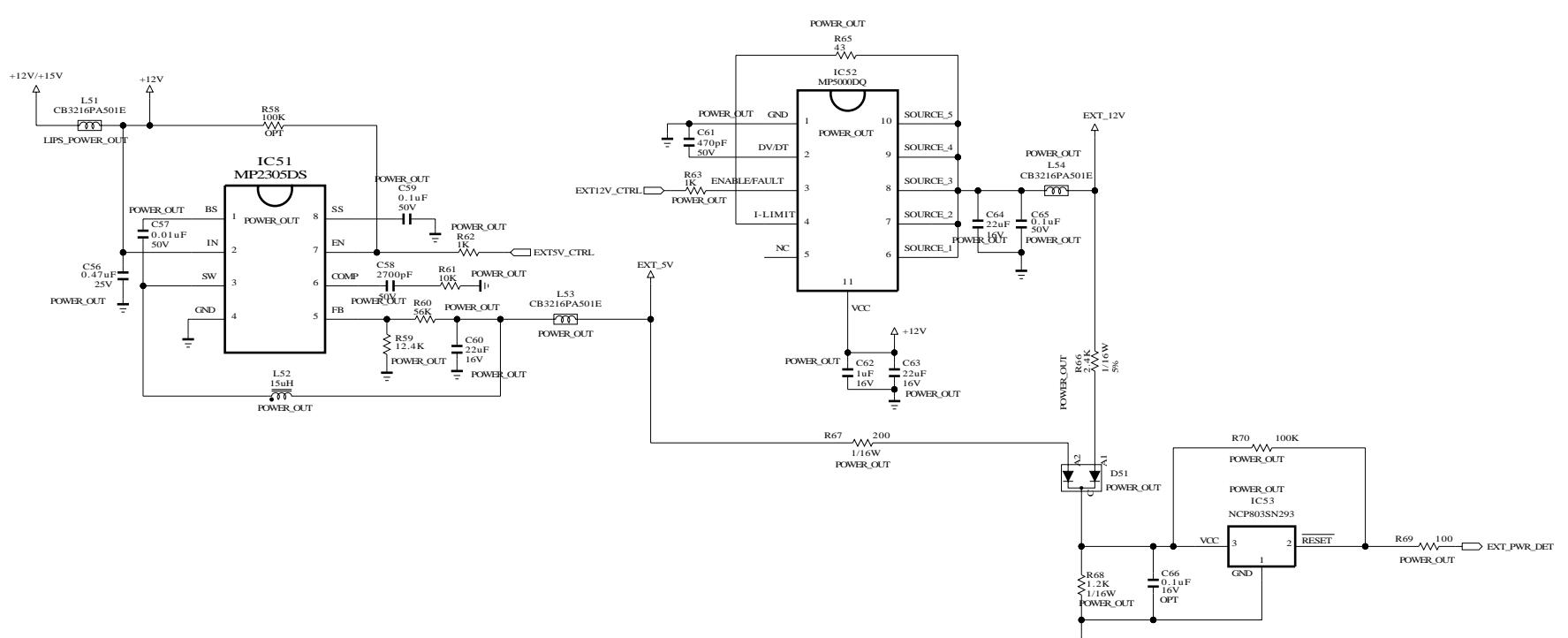
RS232C



DC DC CONVERTER +12V (For External power)



5V/12V EXT PowerOut



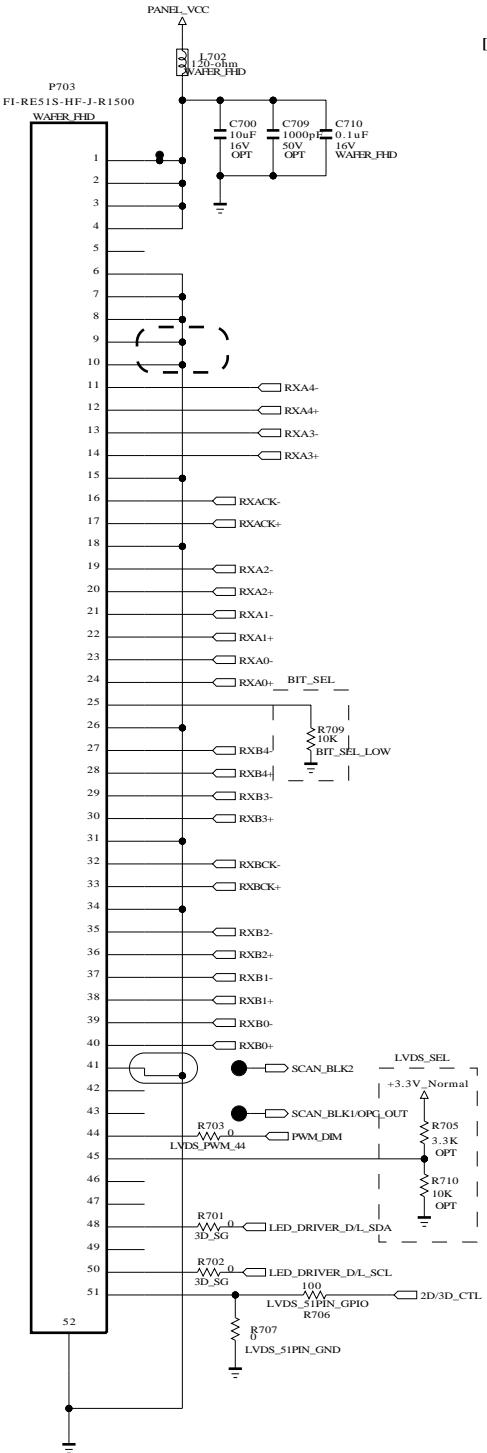
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SECRET
LG Electronics

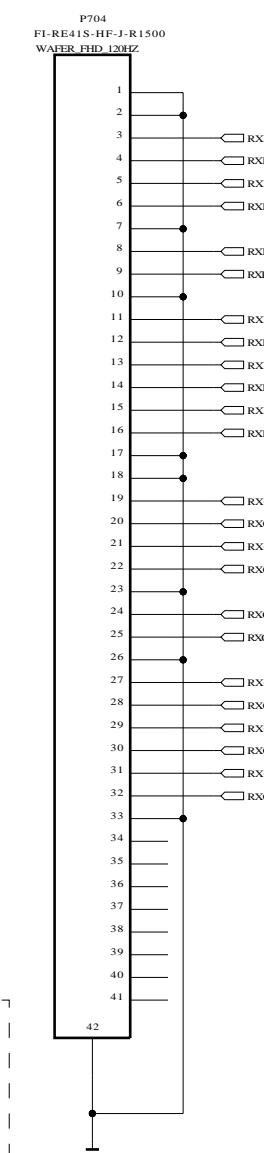
LG ELECTRONICS

MODEL	GP2R	DATE
		20101023
BLOCK	RS232C_9PIN	SHEET
		10 /

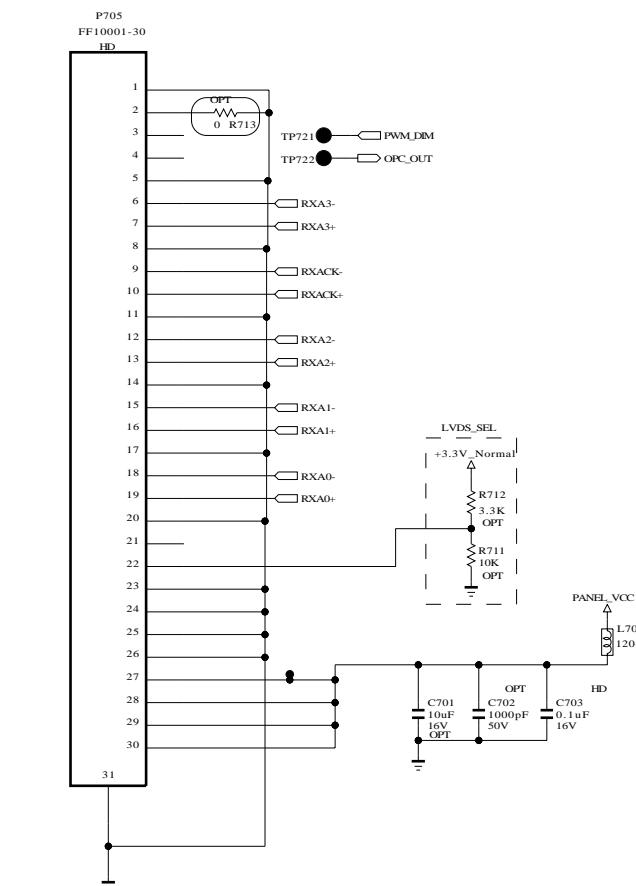
[51Pin LVDS Connector]
(For FHD 60/120Hz)



[41Pin LVDS Connector]
(For FHD 120Hz)



[30Pin LVDS Connector]
(For HD 60Hz_Normal)

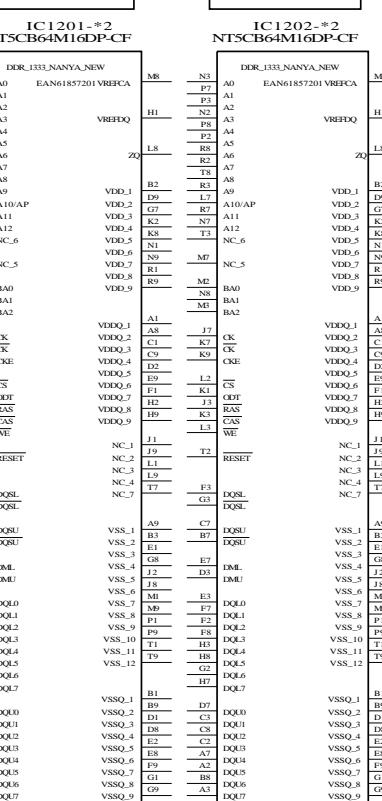
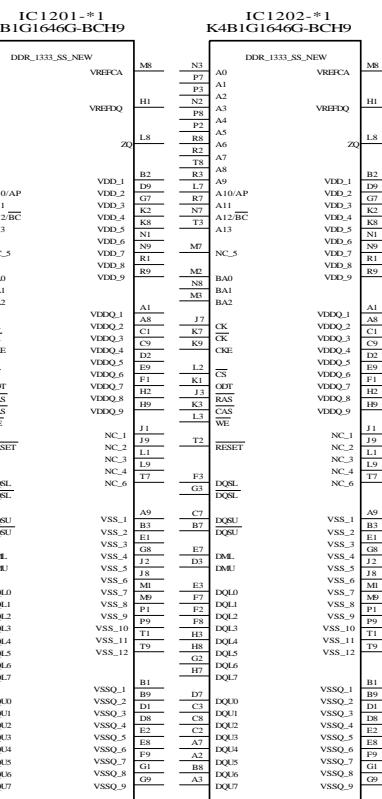
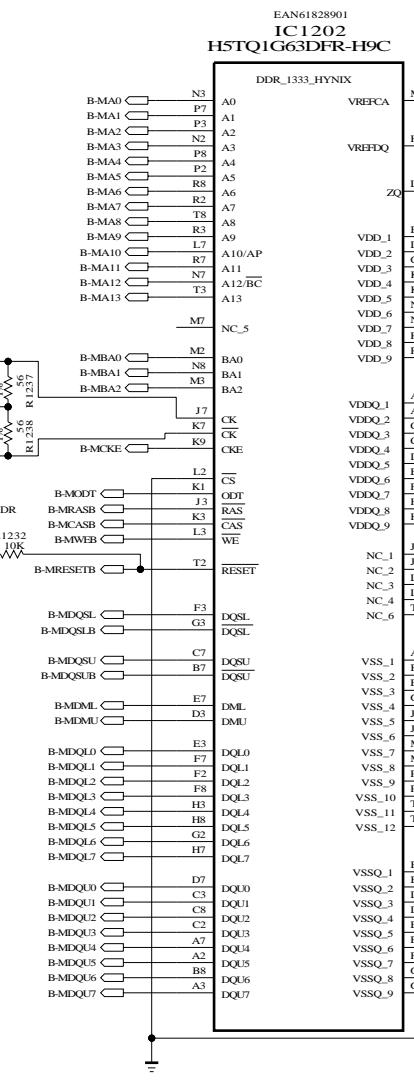
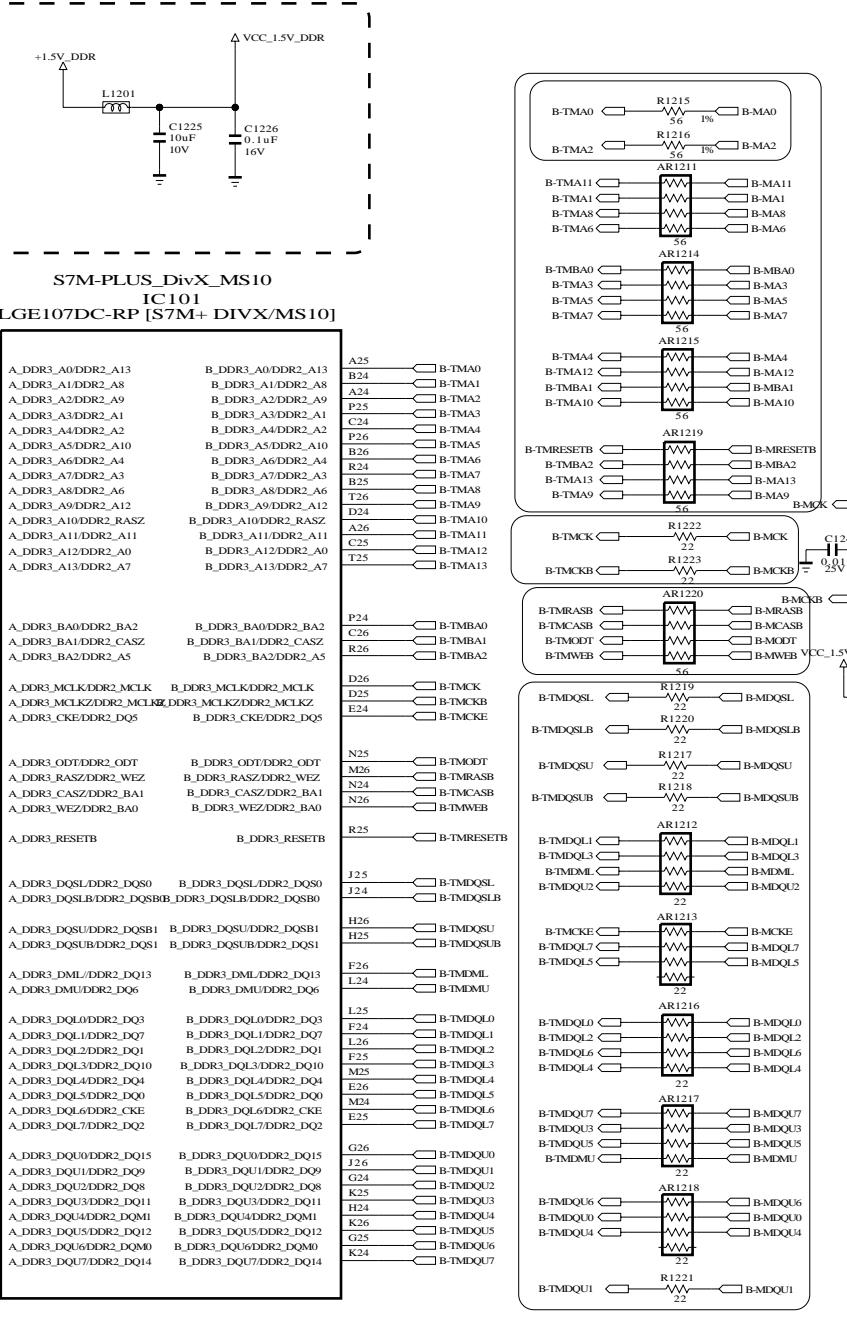
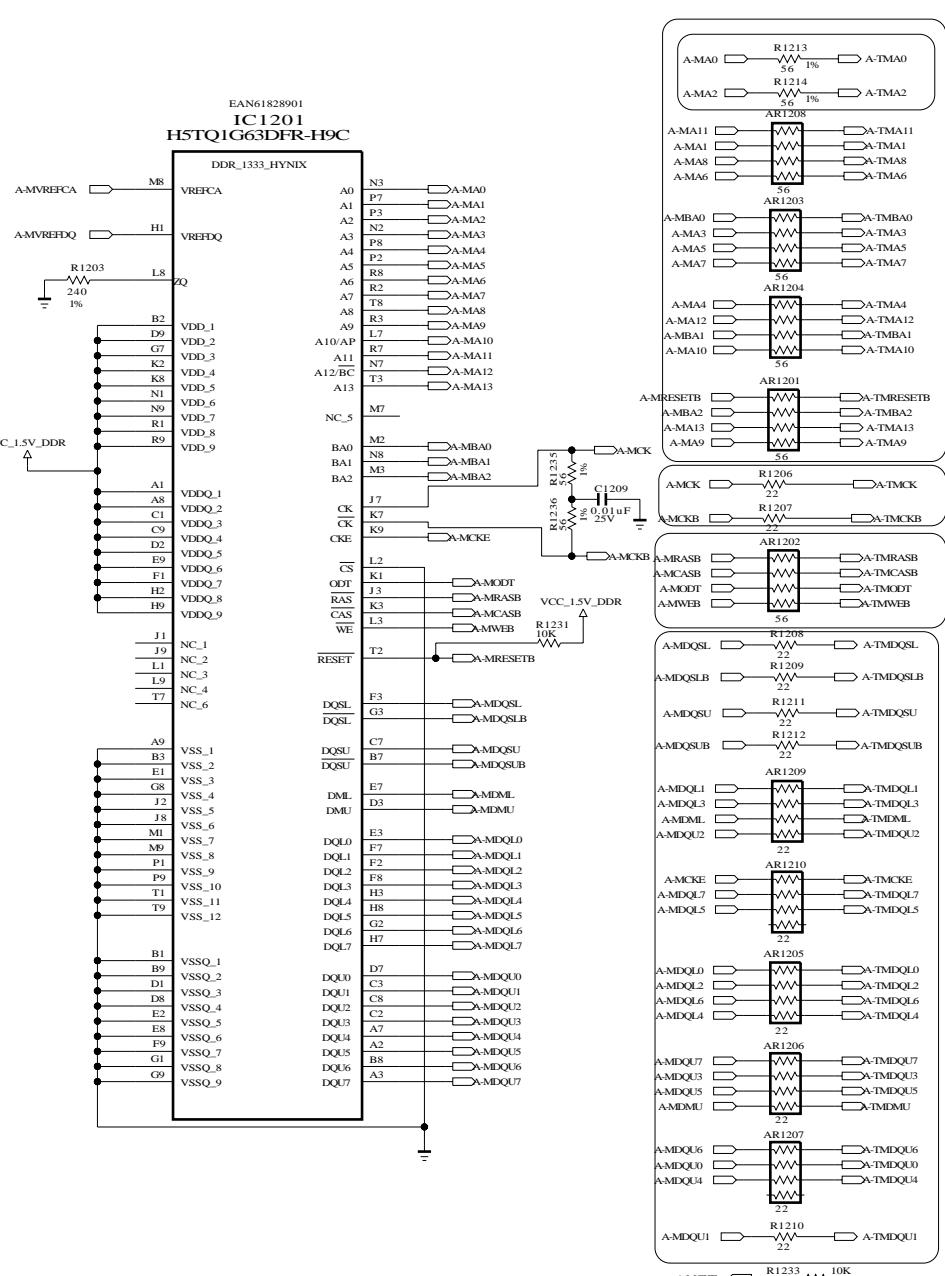
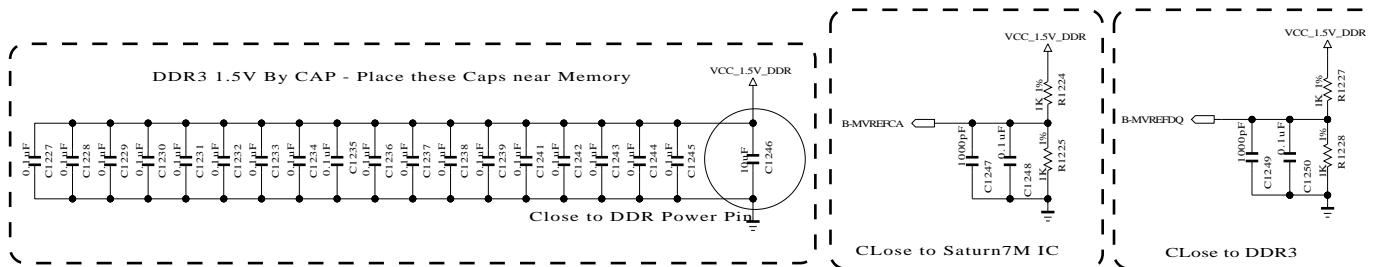
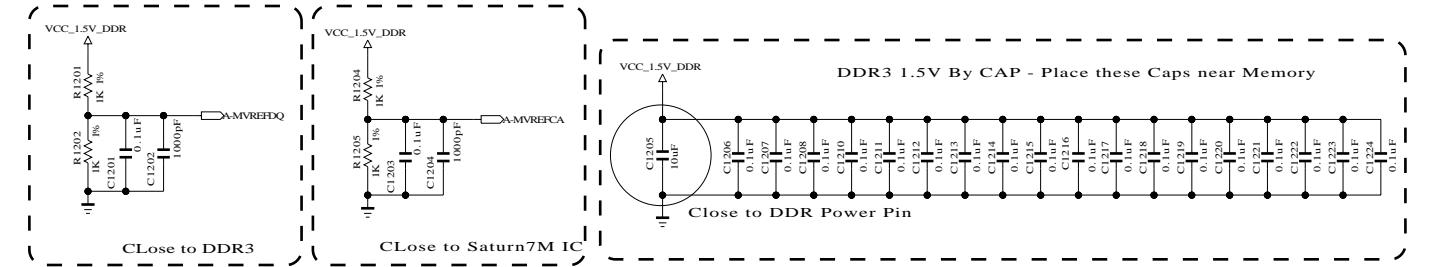


THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES
SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION.
IF REPAIR AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IT IS
ESSENTIAL THAT ONLY MANUFACTURED SPECIFIED PARTS BE USED FOR
THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

SECRET
LG Electronics

LG ELECTRONICS

MODEL	GP2R	DATE	20101023
BLOCK	LVDS_LARGE	SHEET	11 /

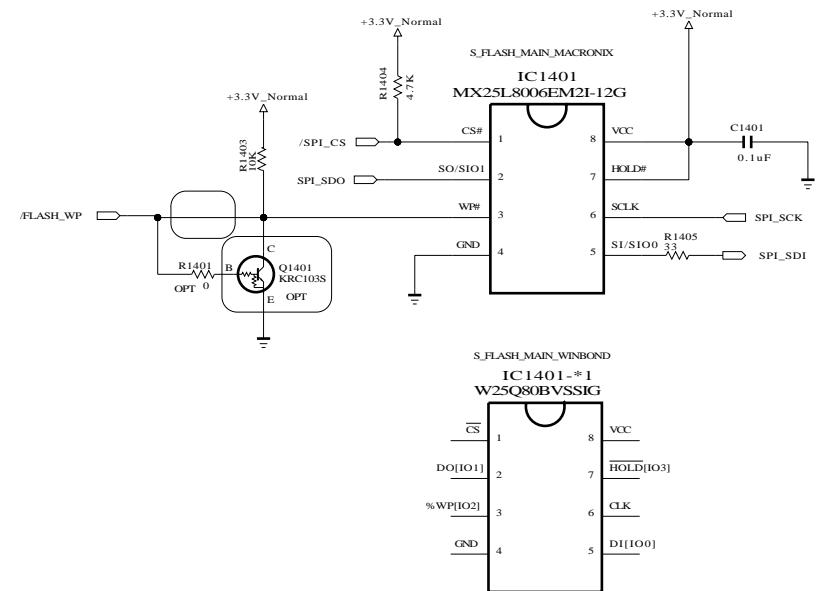


THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC

SECRET
LG Electronics



MODEL	GP2R	DATE	20101023
WORK	DDR_256	SHEET	12 /



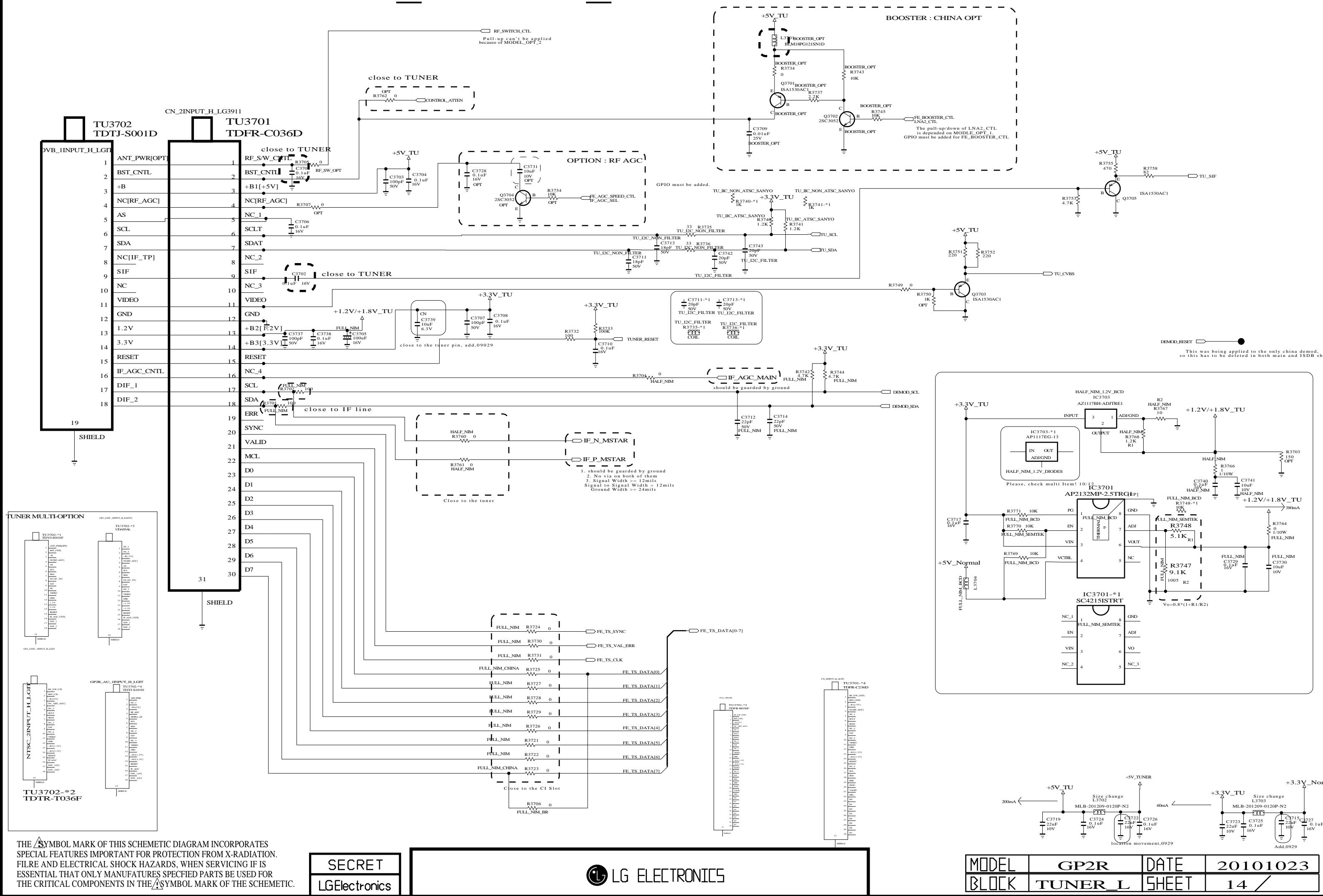
THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. IT IS ESSENTIAL THAT ONLY MANUFACTURED SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

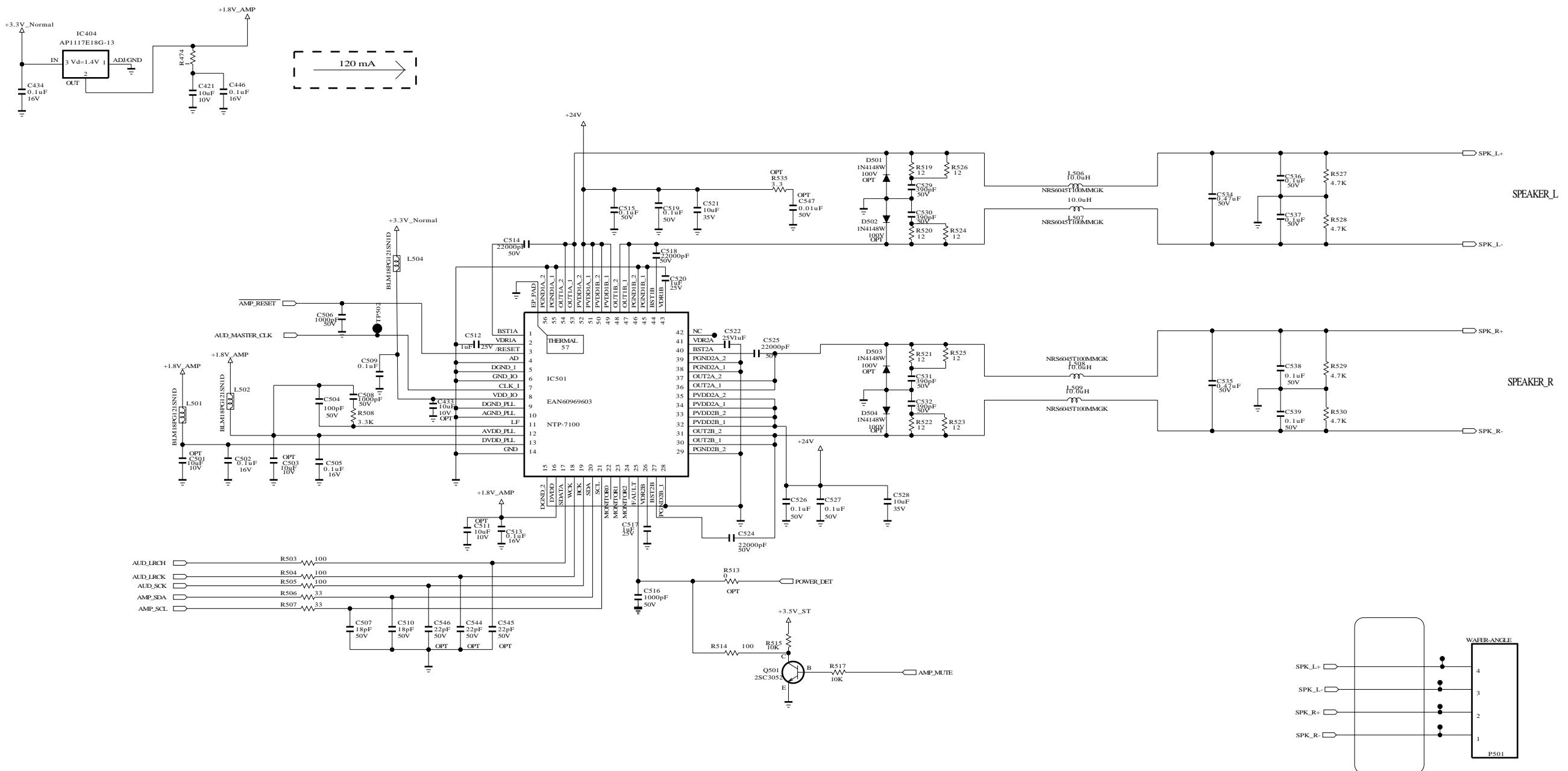
SECRET
LG Electronics

LG ELECTRONICS

MODEL	GP2R	DATE	20101023
BLOCKS	FLASH 1MB	SHEET	13 /

GP2R_LARGE_TUNER





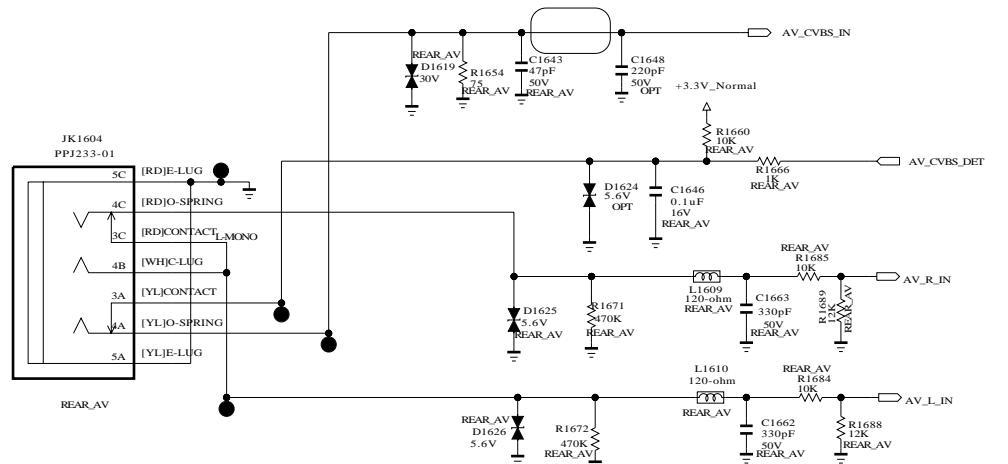
THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. IT IS ESSENTIAL THAT ONLY MANUFACTURED SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

SECRET
LG Electronics

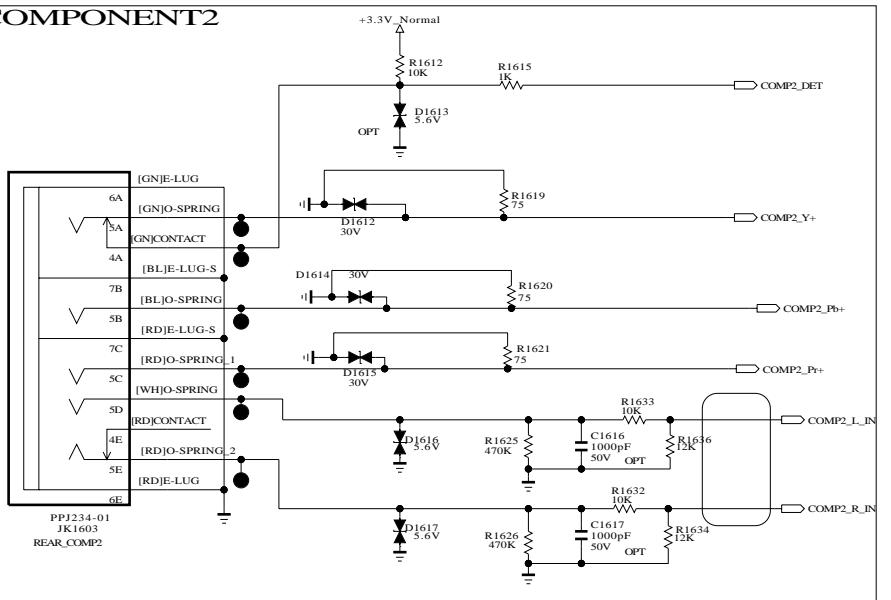
LG ELECTRONICS

MODEL BLOCK	GP2R AMP_NTP	DATE SHEET	20101023 16 /
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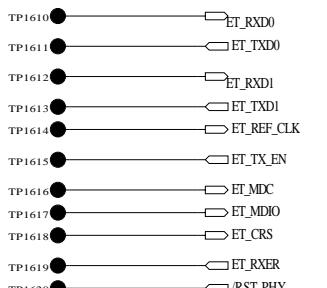
Rear AV



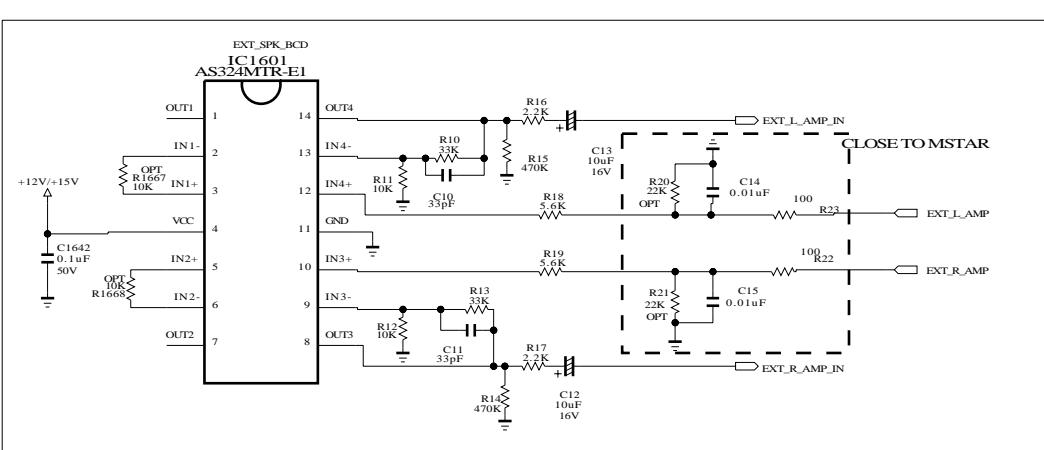
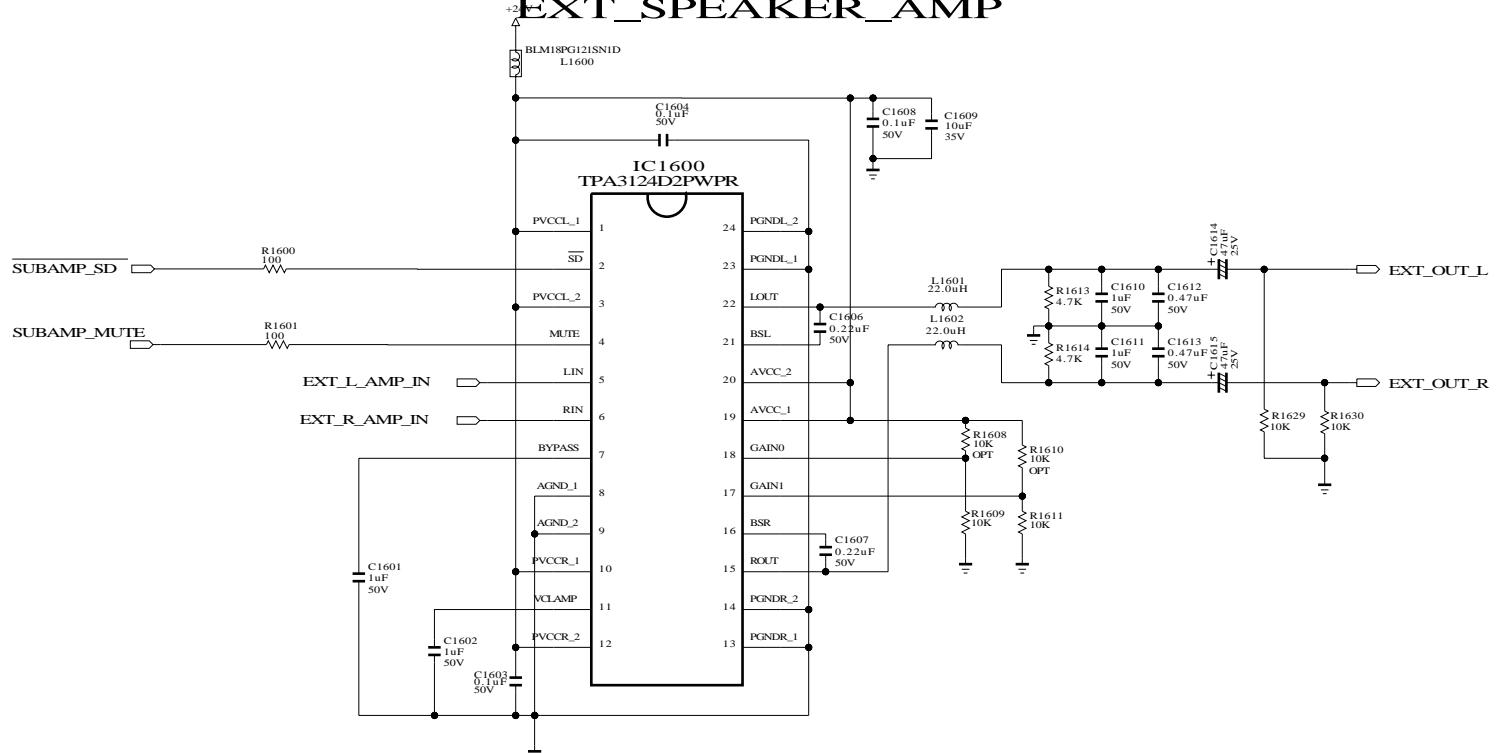
COMPONENT2



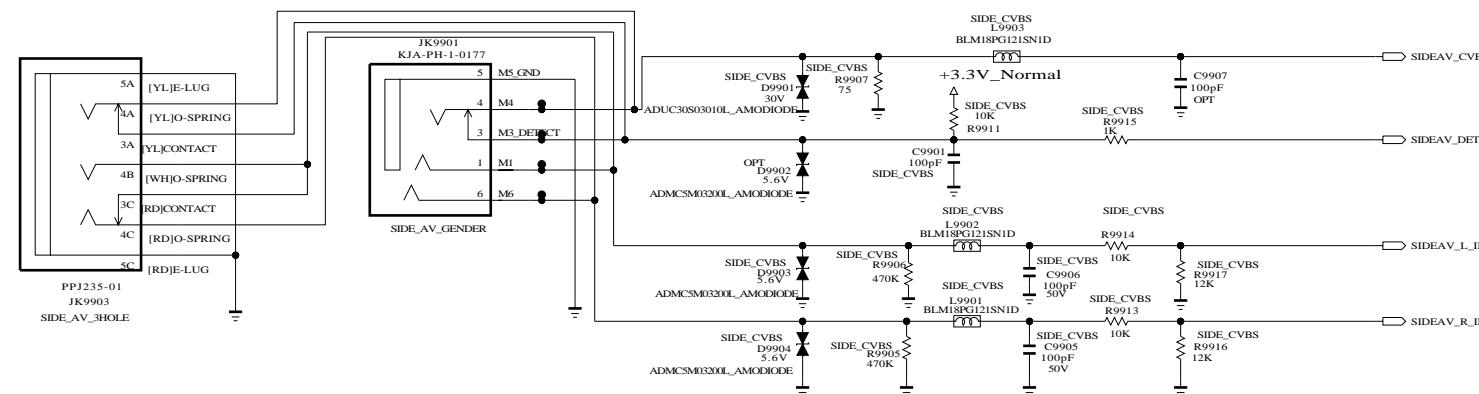
ETHERNET FOR DVB_T2



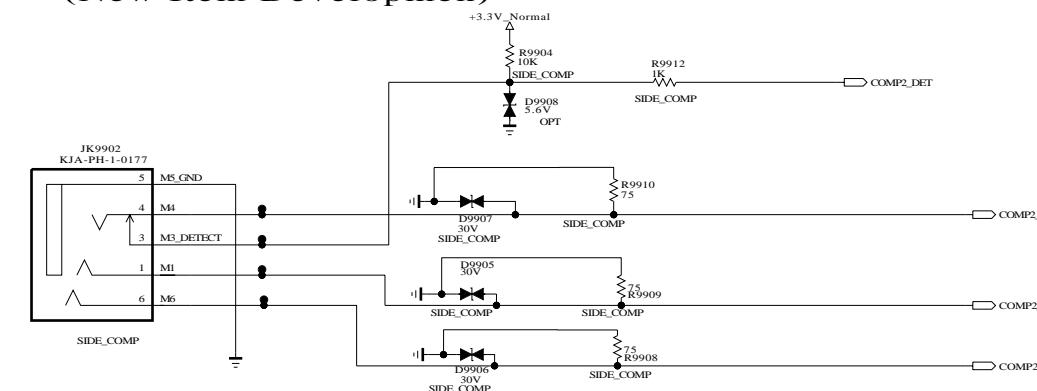
EXT_SPEAKER_AMP



SIDE CVBS PHONE JACK
(New Item Development)



SIDE COMPONENT PHONE JACK
(New Item Development)



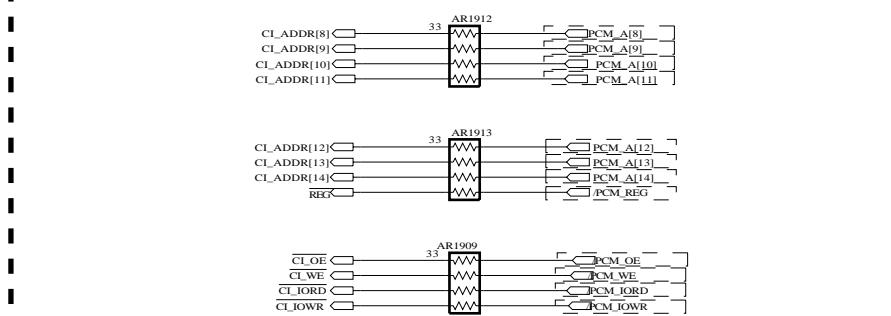
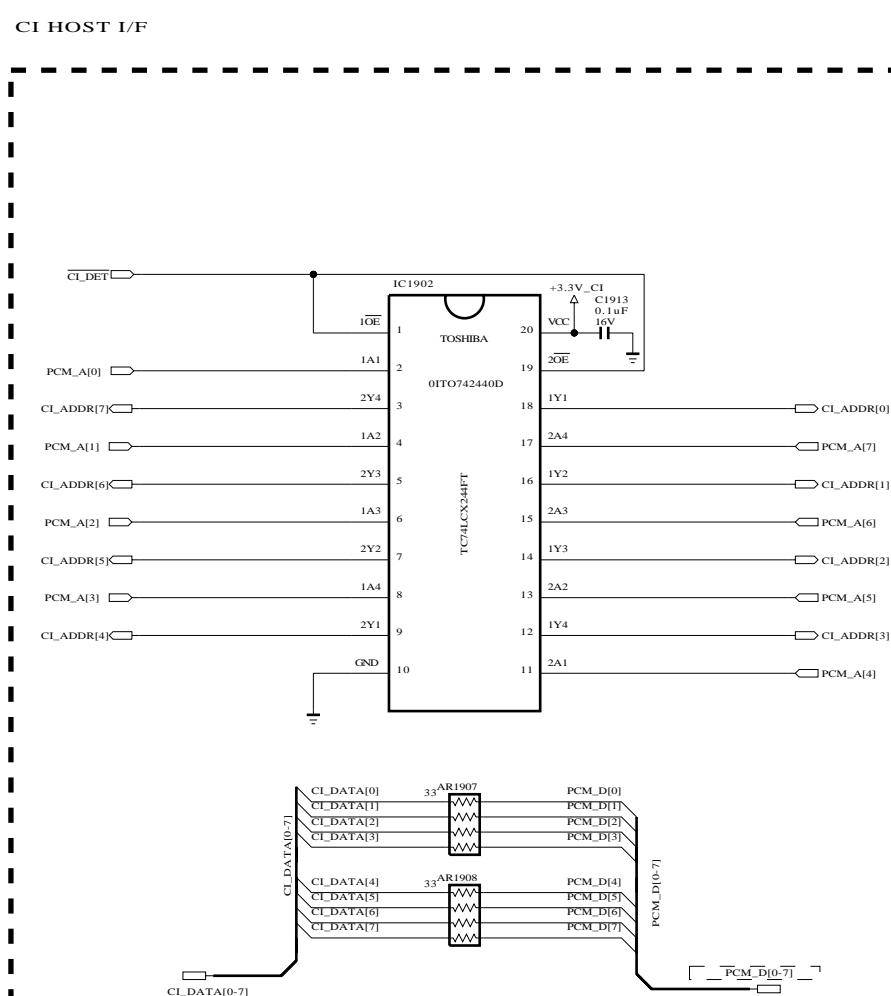
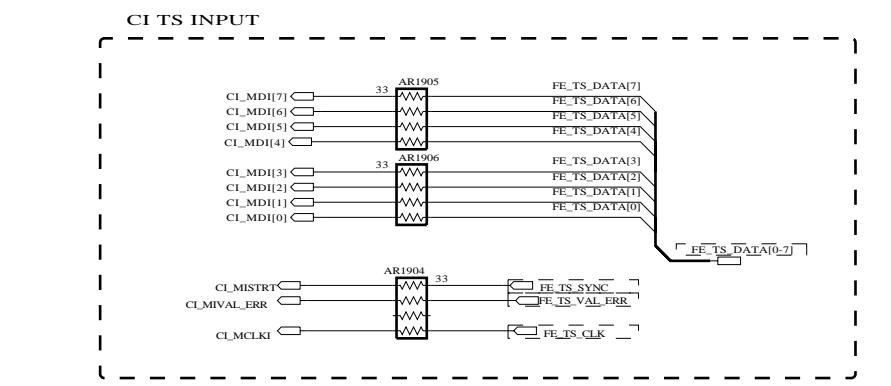
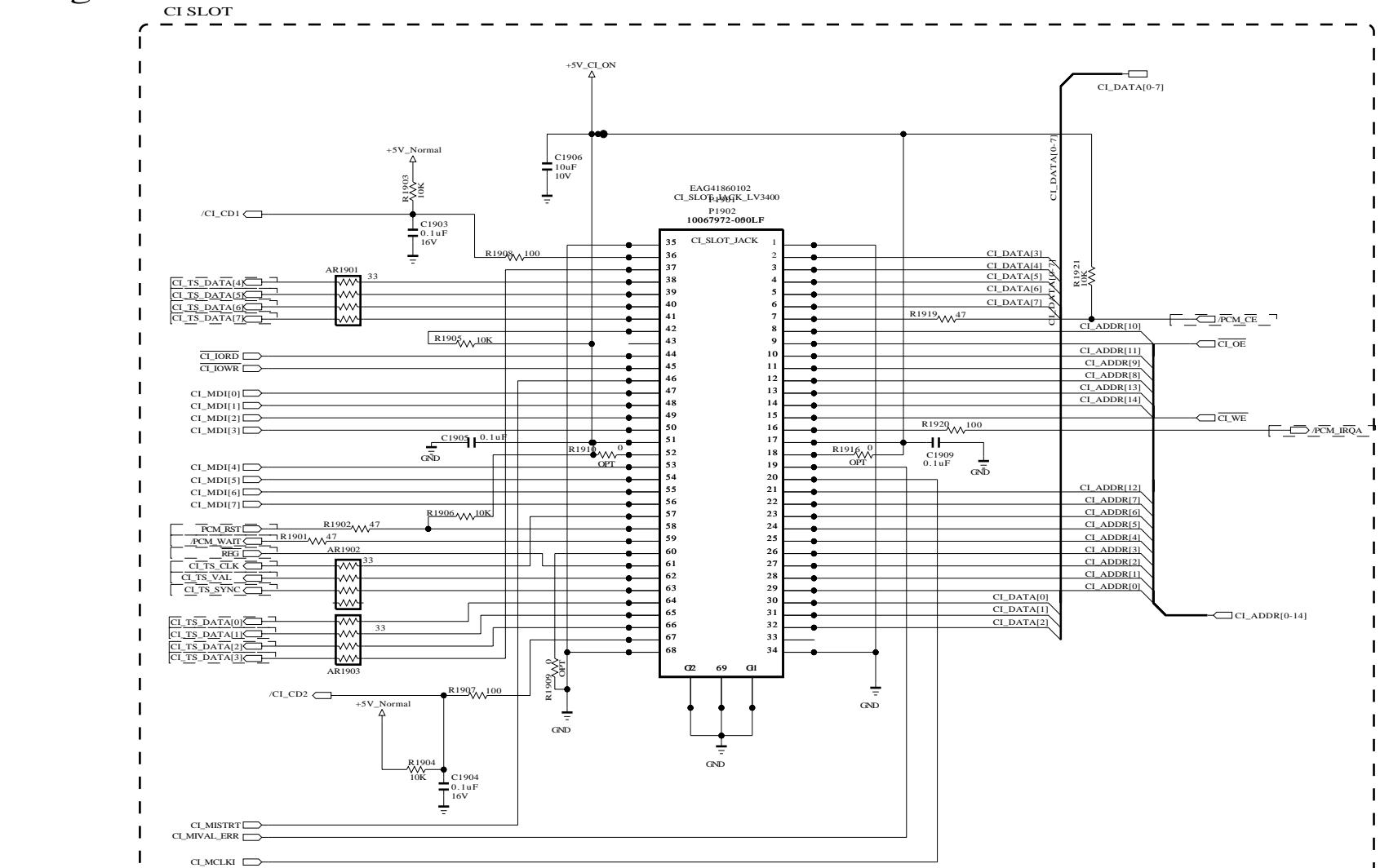
THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. IT IS ESSENTIAL THAT ONLY MANUFACTURED SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

SECRET
LG Electronics

LG ELECTRONICS

MODEL	GP2R	DATE	20101023
BLOCK	SIDE_JACK	SHEET	18 /

CI Region



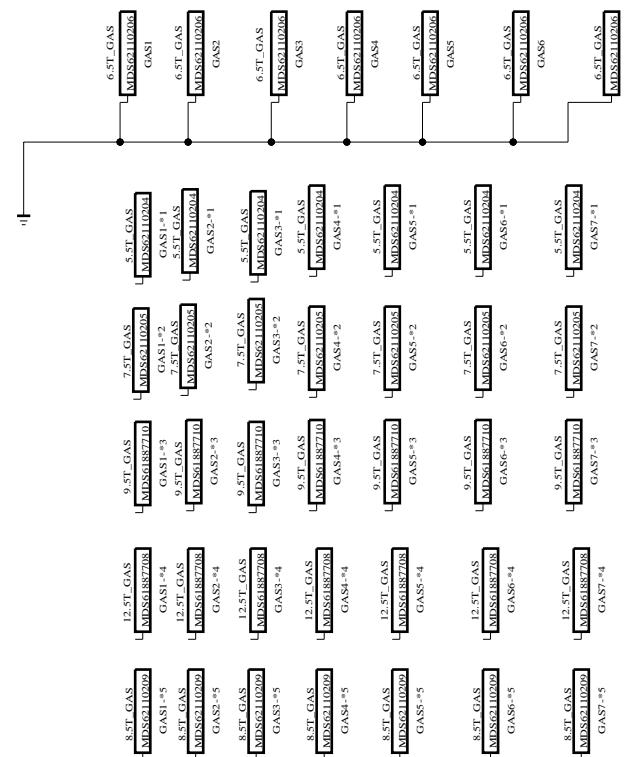
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SECRET
LG Electronics

LG ELECTRONICS

MODEL	GP2R	DATE	20101023
BLOCK	PCMCI	SHEET	20 /

SMD GASKET

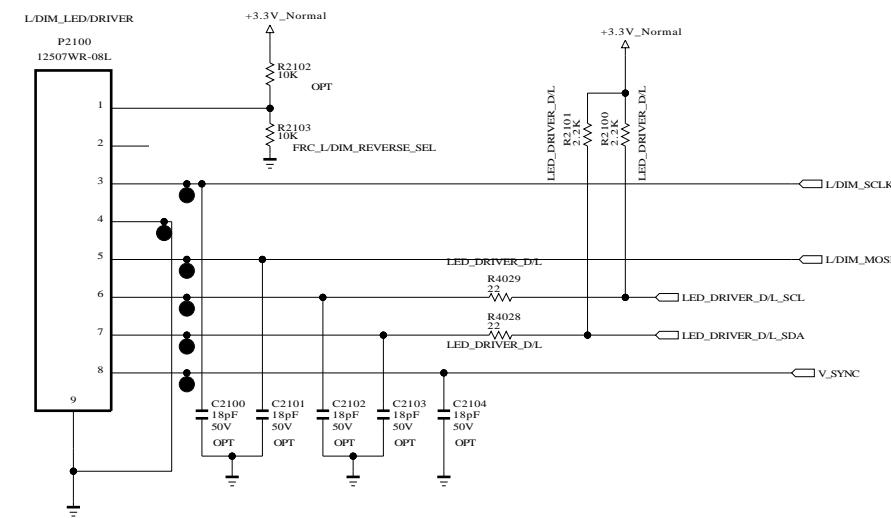


THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

SECRET
LG Electronics

 LG ELECTRONICS

MODEL	GP2R	DATE	20101023
BLOCK	SMD_GAS	SHEET	20 /



THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. IF REPAIR AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IT IS ESSENTIAL THAT ONLY MANUFACTURED SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

SECRET
LG Electronics

 LG ELECTRONICS

MODEL	GP2R	DATE	20101023
BLOCK	L/DIM_LED	SHEET	21 /



1. Trouble Shooting

Contents of LCD TV Standard Repair Process

No.	Error symptom (High category)	Error symptom (Mid category)	Page	Remarks
1	A. Video error	No video/Normal audio	1	
2		No video/No audio	2	
3		Video error, video lag/stop	3	
4		Color error	4	
5		Vertical/Horizontal bar, residual image, light spot, external device color error	5	
6	B. Power error	No power	6	
7		Off when on, off while viewing, power auto on/off	7	
8	C. Audio error	No audio/Normal video	8	
9		Wrecked audio/discontinuation/noise	9	
10	D. Function error	No response in remote controller, key error, recording error, memory error	10	
11		External device recognition error	11	
12	E. Noise	Circuit noise, mechanical noise	12	
13	F. Exterior error	Exterior defect	13	

Standard Repair Process

LCD TV

Error symptom

A. Video error

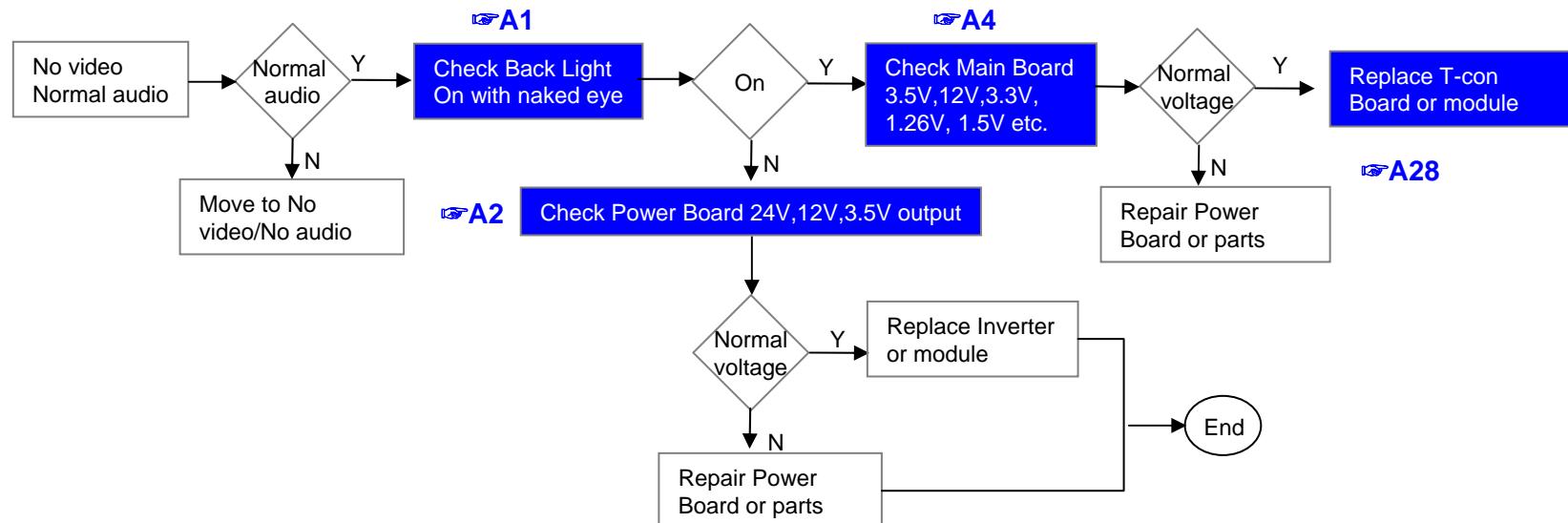
No video/ Normal audio

Established date

Revised date

1/13

**First of all, Check whether all of cables between board is inserted properly or not.
(Main B/D↔ Power B/D, LVDS Cable, Speaker Cable, IR B/D Cable,,,)**



*Precaution **A7 & A3**

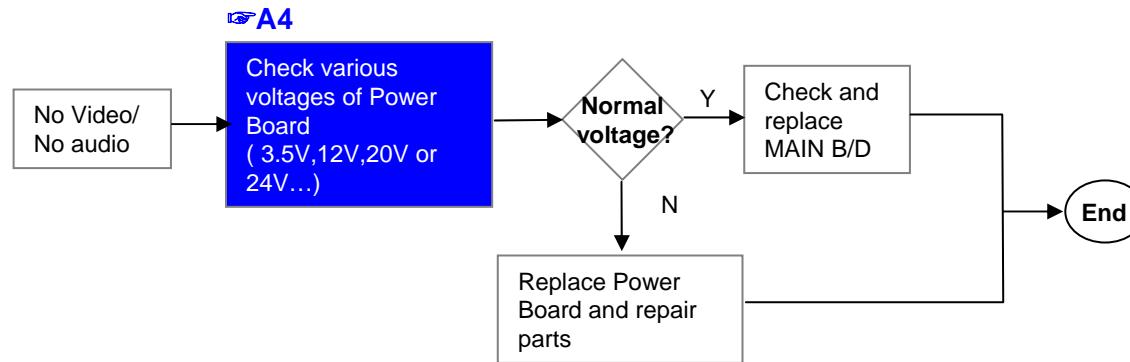
Always check & record S/W Version and White Balance value before replacing the Main Board

Replace Main Board

Re-enter White Balance value

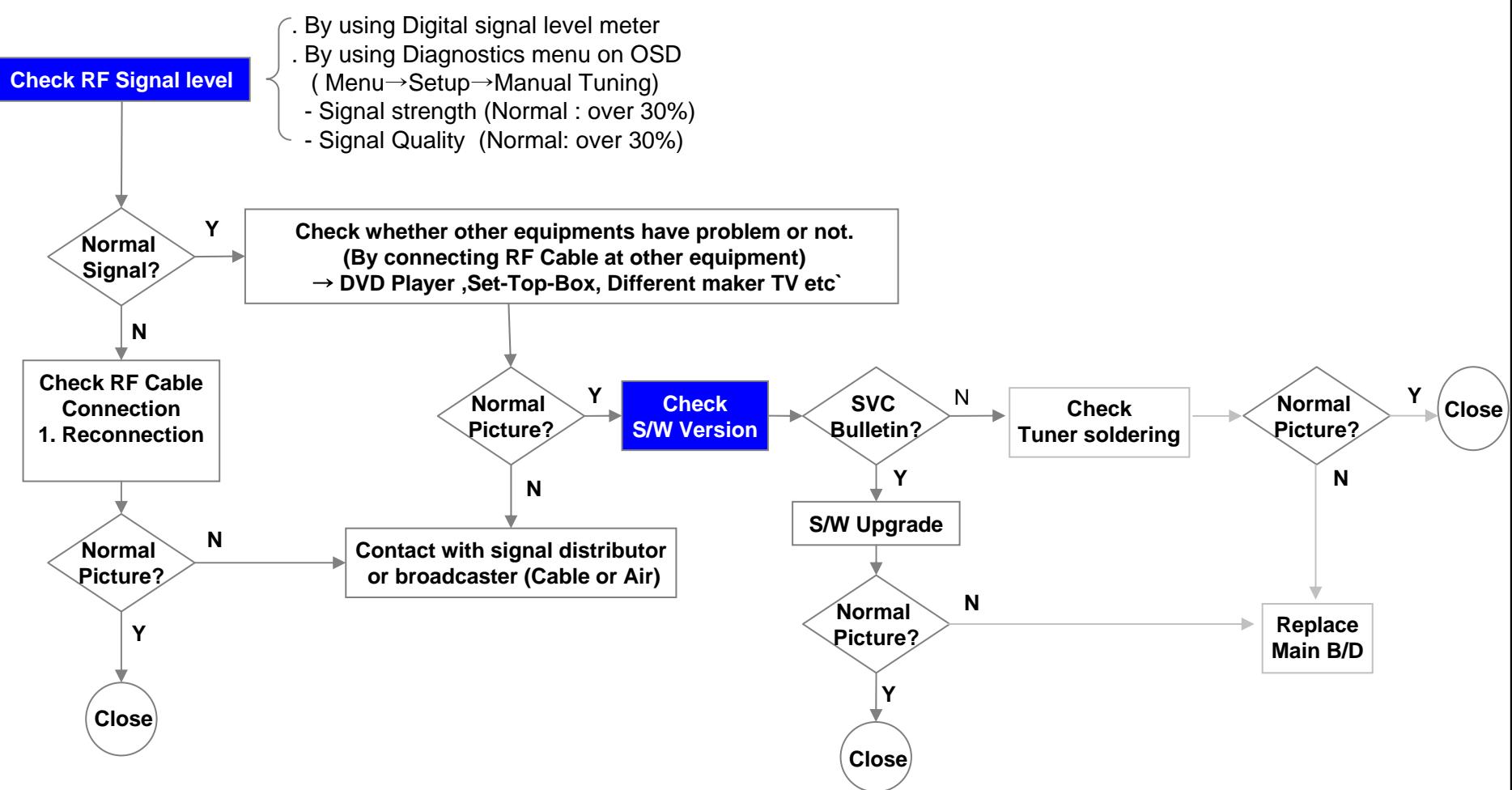
Standard Repair Process

LCD TV	Error symptom	A. Video error	Established date		
		No video/ No audio	Revised date	2/13	



Standard Repair Process

LCD TV	Error symptom	A. Picture Problem	Established date		
		Picture broken/ Freezing	Revised date	3/13	



Standard Repair Process

LCD TV

Error symptom

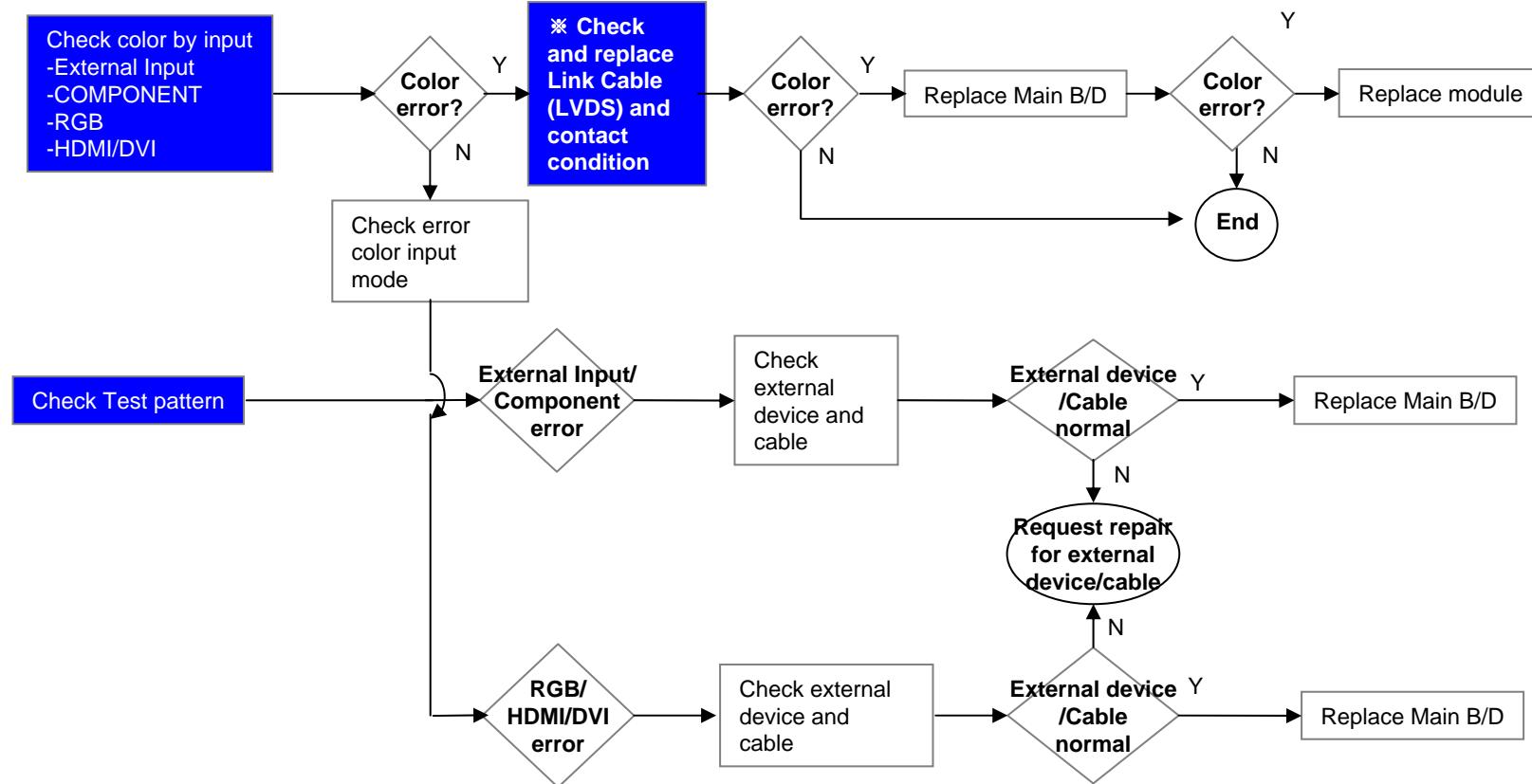
A. Video error

Color error

Established date

Revised date

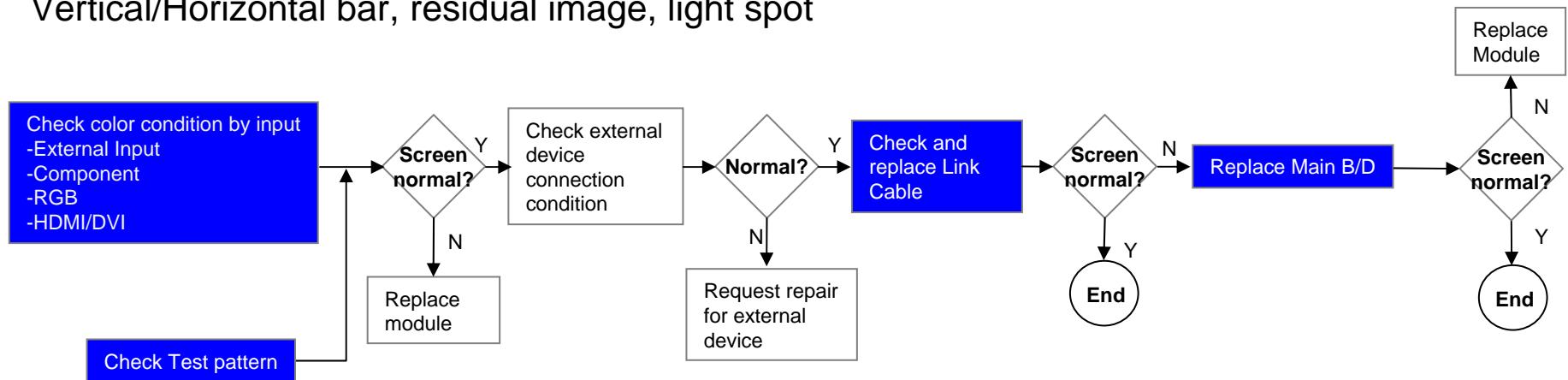
4/13



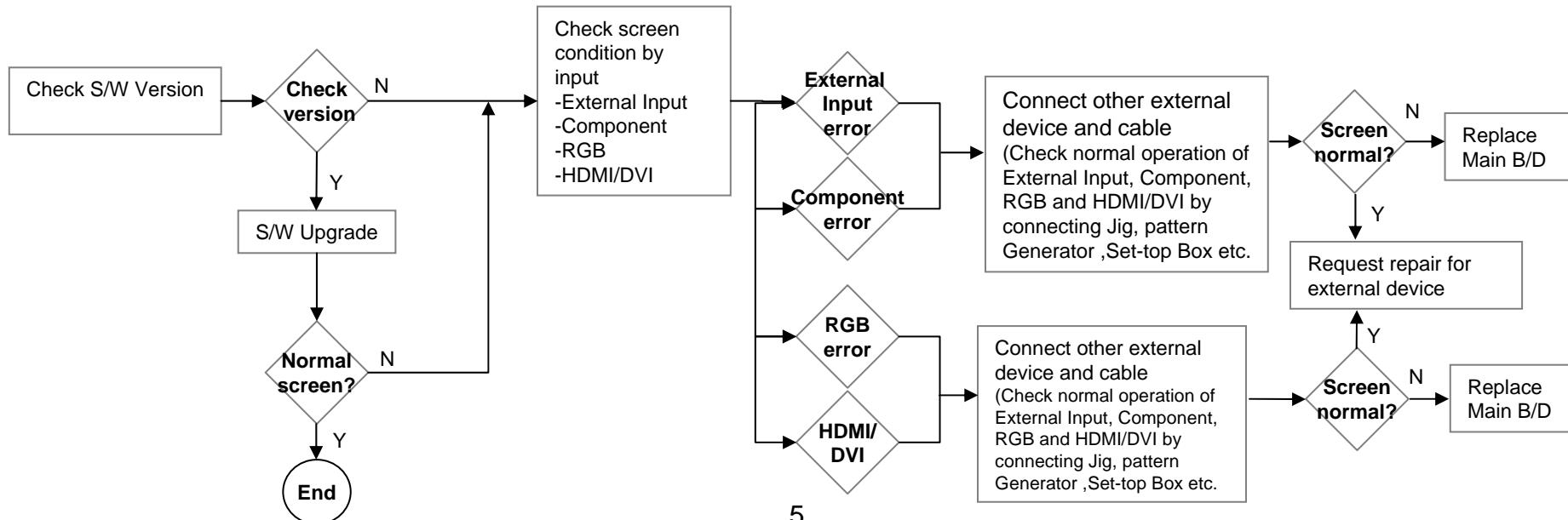
Standard Repair Process

LCD TV	Error symptom	A. Video error	Established date		
		Vertical / Horizontal bar, residual image, light spot, external device color error	Revised date		5/13

Vertical/Horizontal bar, residual image, light spot

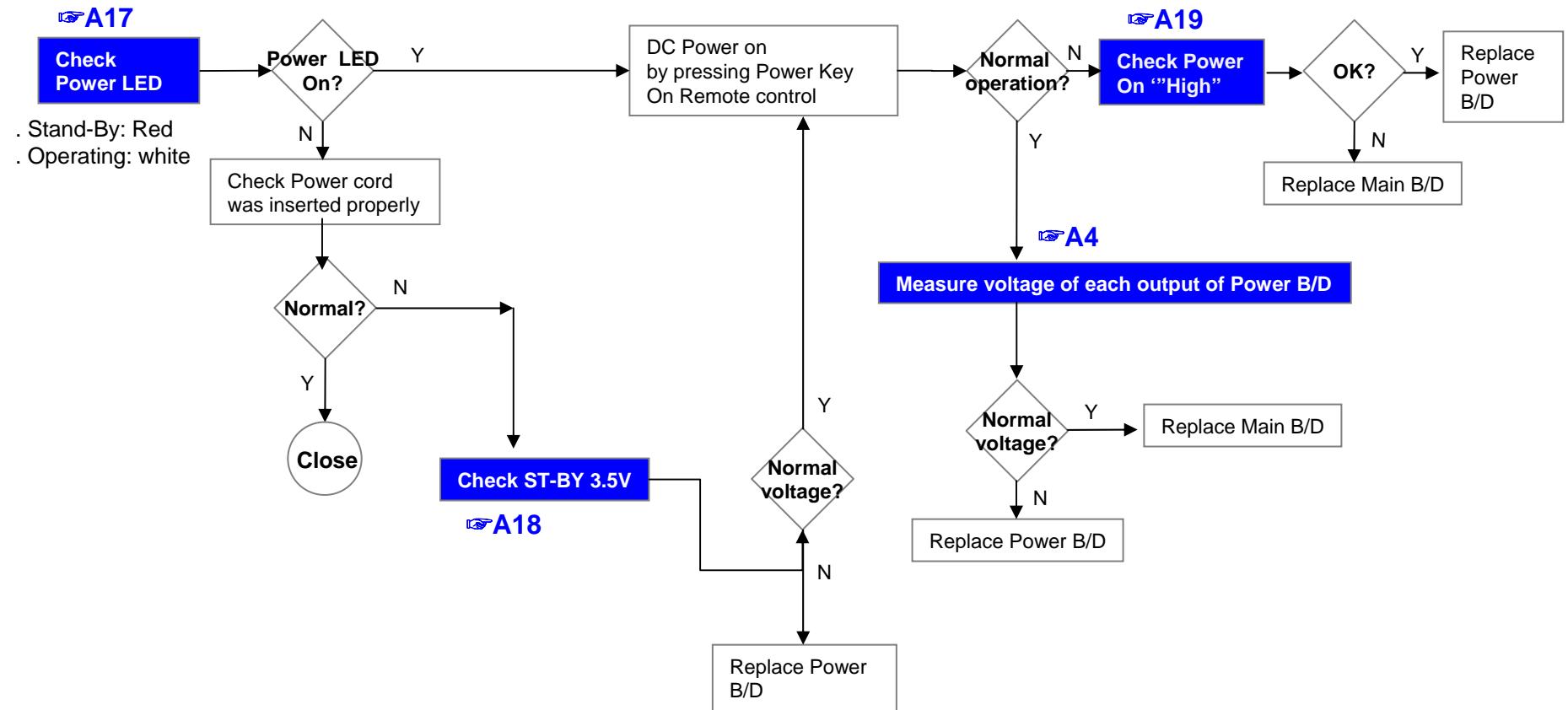


External device screen error-Color error



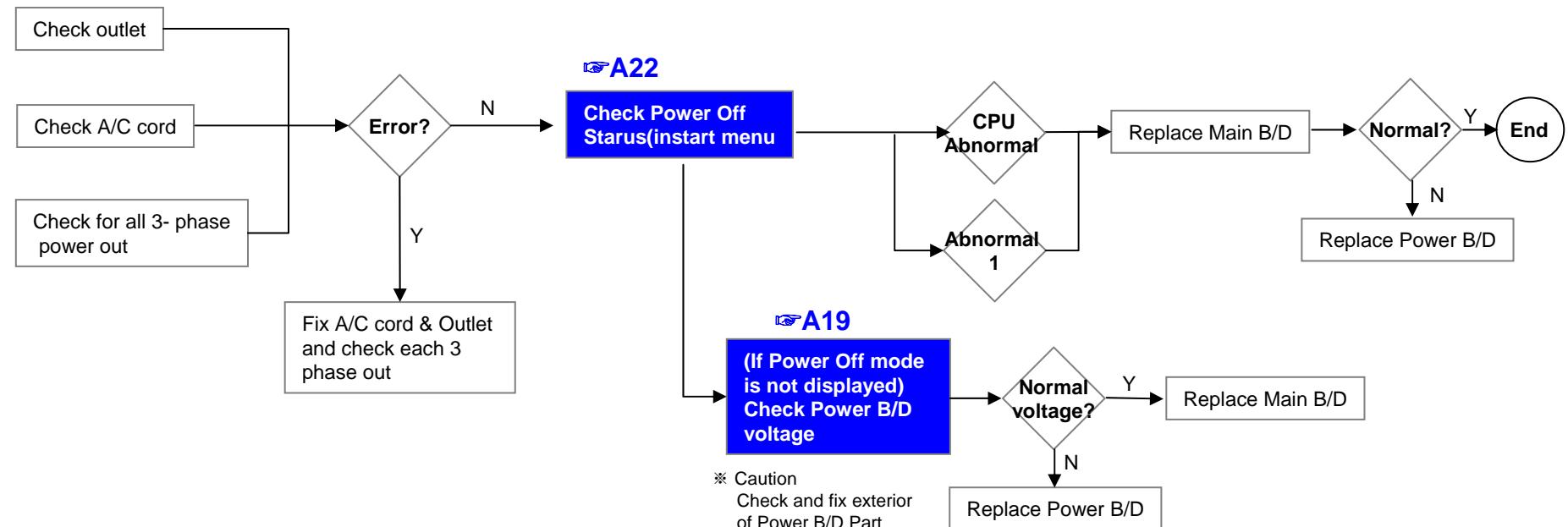
Standard Repair Process

LCD TV	Error symptom	B. Power error	Established date		
		No power	Revised date	6/13	



Standard Repair Process

LCD TV	Error symptom	B. Power error	Established date		
		Off when on, off while viewing, power auto on/off	Revised date		7/13

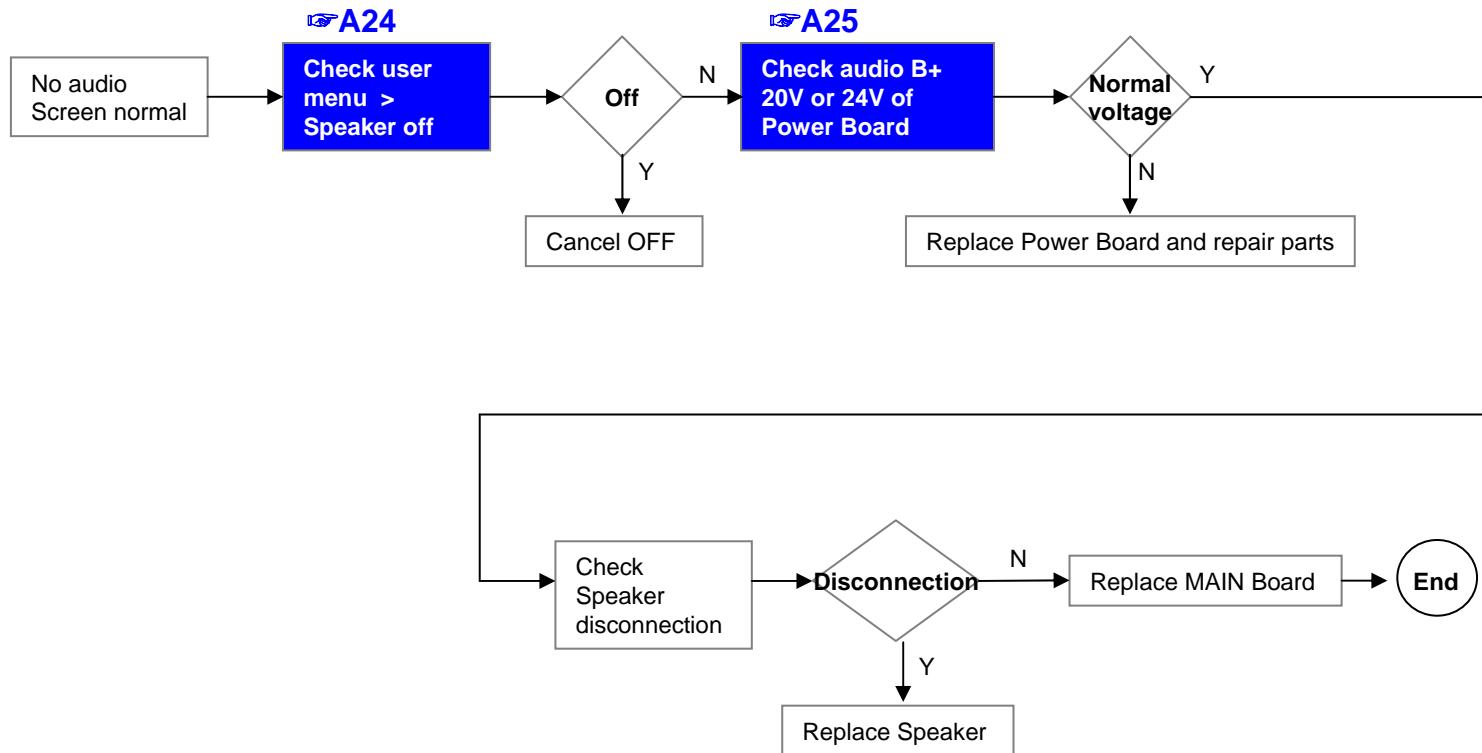


* Please refer to the all cases which can be displayed on power off mode.

Status	Power off List	Explanation
Normal	"POWEROFF_REMOTEKEY"	Power off by REMOTE CONTROL
	"POWEROFF_OFTIMER"	Power off by OFF TIMER
	"POWEROFF_SLEPTIMER"	Power off by SLEEP TIMER
	"POWEROFF_INSTOP"	Power off by INSTOP KEY
	"POWEROFF_AUTOOFF"	Power off by AUTO OFF
	"POWEROFF_ONTIMER"	Power off by ON TIMER
	"POWEROFF_RS232C"	Power off by RS232C
	"POWEROFF_RESREC"	Power off by Reserved Record
	"POWEROFF_RECEND"	Power off by End of Recording
	"POWEROFF_SWDOWN"	Power off by S/W Download
Abnormal	"POWEROFF_ABNORMAL1"	Power off by abnormal status except CPU trouble
	"POWEROFF_CPUABNORMAL"	Power off by CPU Abnormal

Standard Repair Process

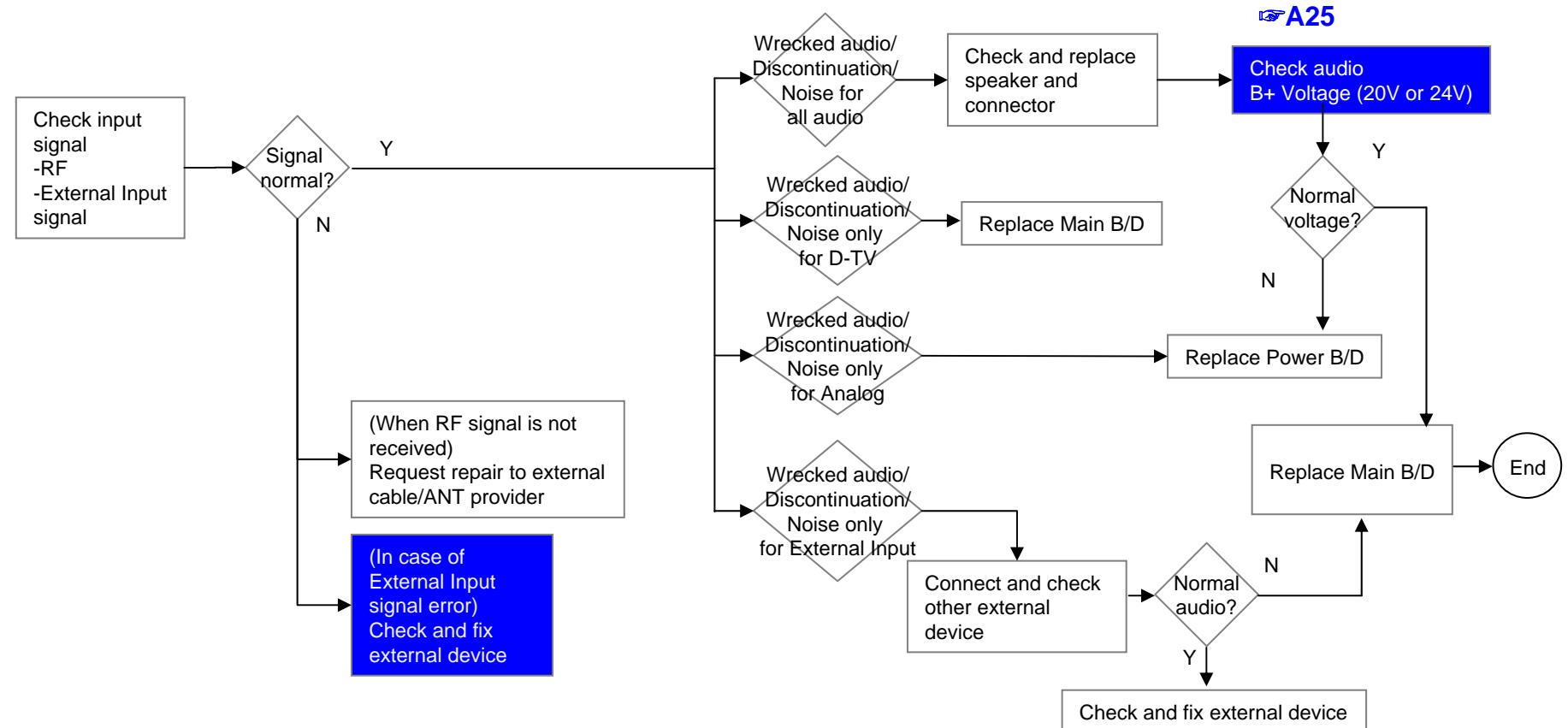
LCD TV	Error symptom	C. Audio error	Established date		
		No audio/ Normal video	Revised date		8/13



Standard Repair Process

LCD TV	Error symptom	C. Audio error	Established date		
		Wrecked audio/ discontinuation/noise	Revised date		9/13

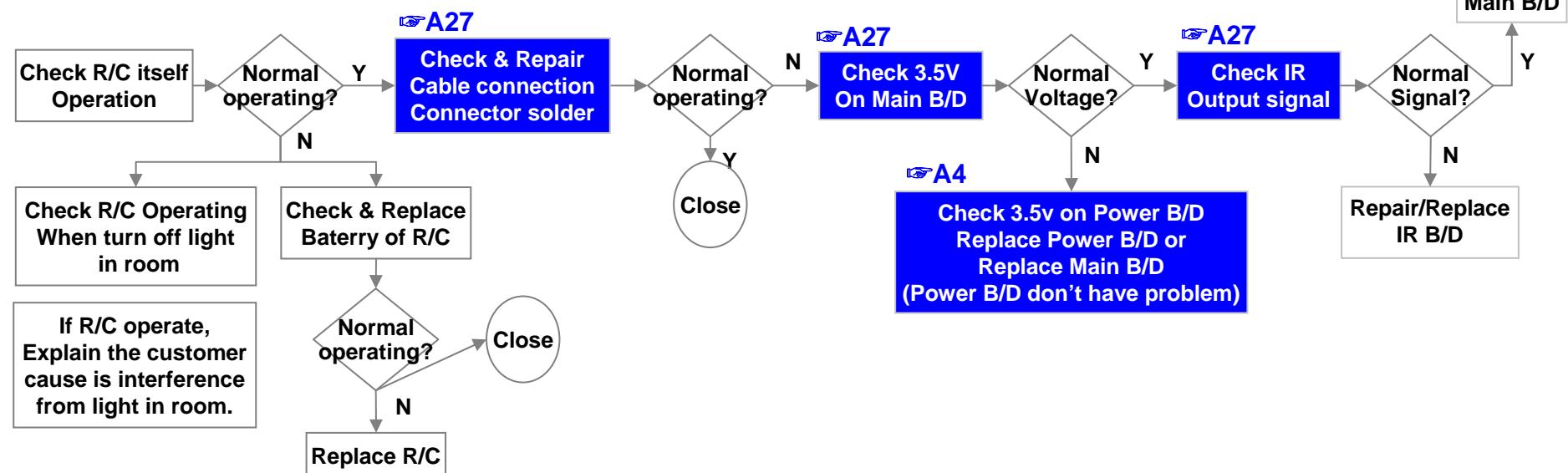
→ abnormal audio/discontinuation/noise is same after “Check input signal” compared to No audio



Standard Repair Process

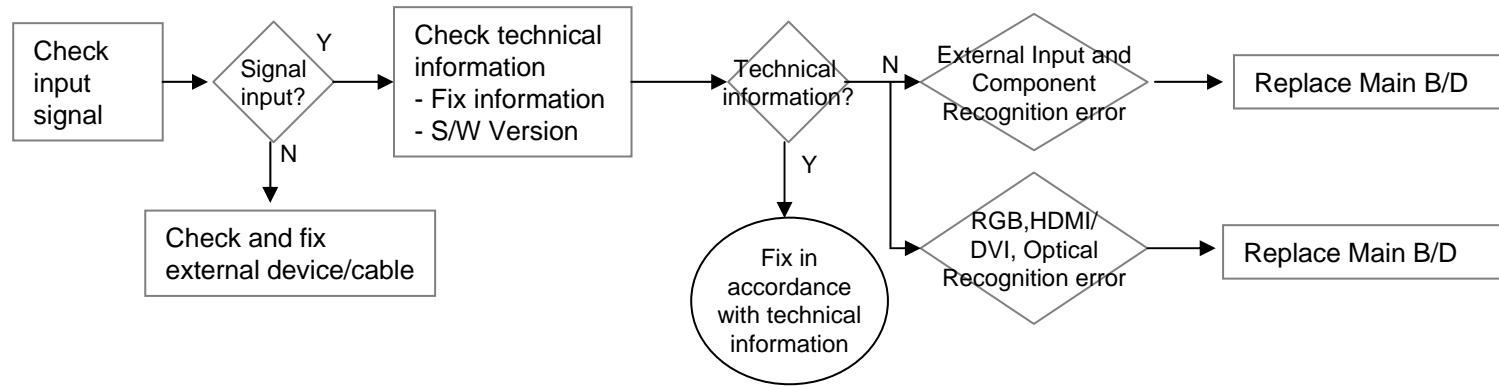
LCD TV	Error symptom	D. General Function Problem	Established date		
		Remote control & Local switch checking	Revised date		10/13

1. Remote control(R/C) operating error



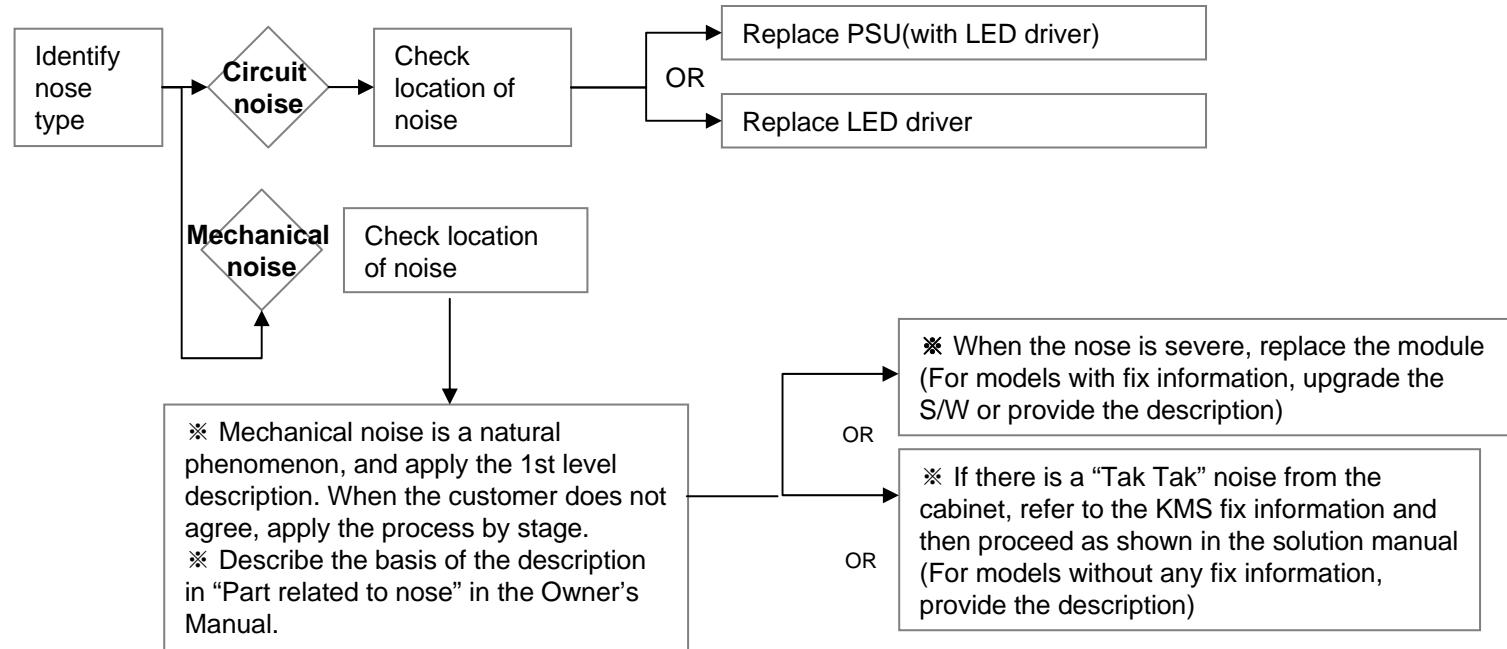
Standard Repair Process

LCD TV	Error symptom	D. Function error	Established date		
		External device recognition error	Revised date		11/13



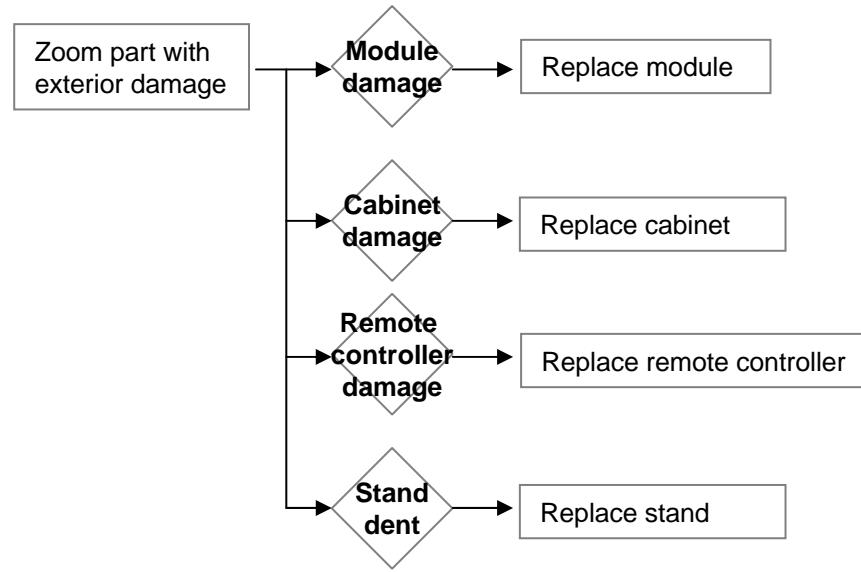
Standard Repair Process

LCD TV	Error symptom	E. Noise	Established date		
		Circuit noise, mechanical noise	Revised date		12/13



Standard Repair Process

LCD TV	Error symptom	F. Exterior defect	Established date		
		Exterior defect	Revised date	13/13	



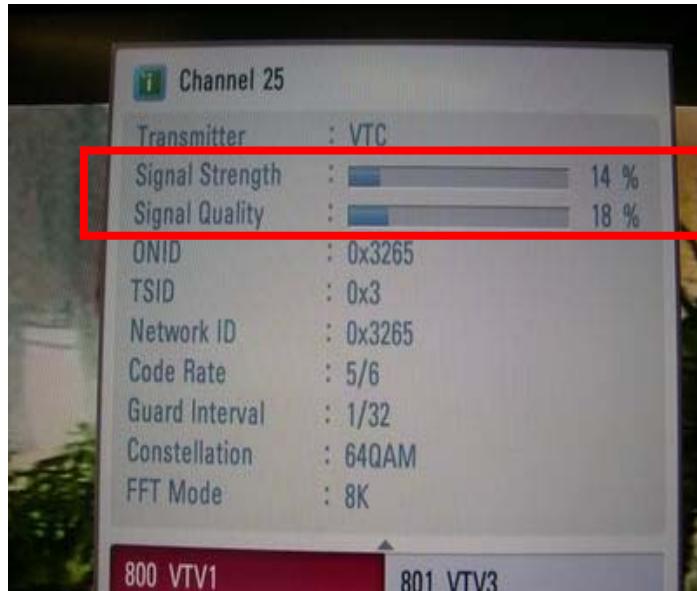
Standard Repair Process Detail Technical Manual

LCD TV	Error symptom	A. Video error_Video error, video lag/stop	Established date		
	Content	TUNER input signal strength checking method	Revised date		A6

<ALL MODELS>



MENU → red key(customer support → signal test
→ select channel)



When the signal is strong, use the attenuator (-10dB, -15dB, -20dB etc.)



A6

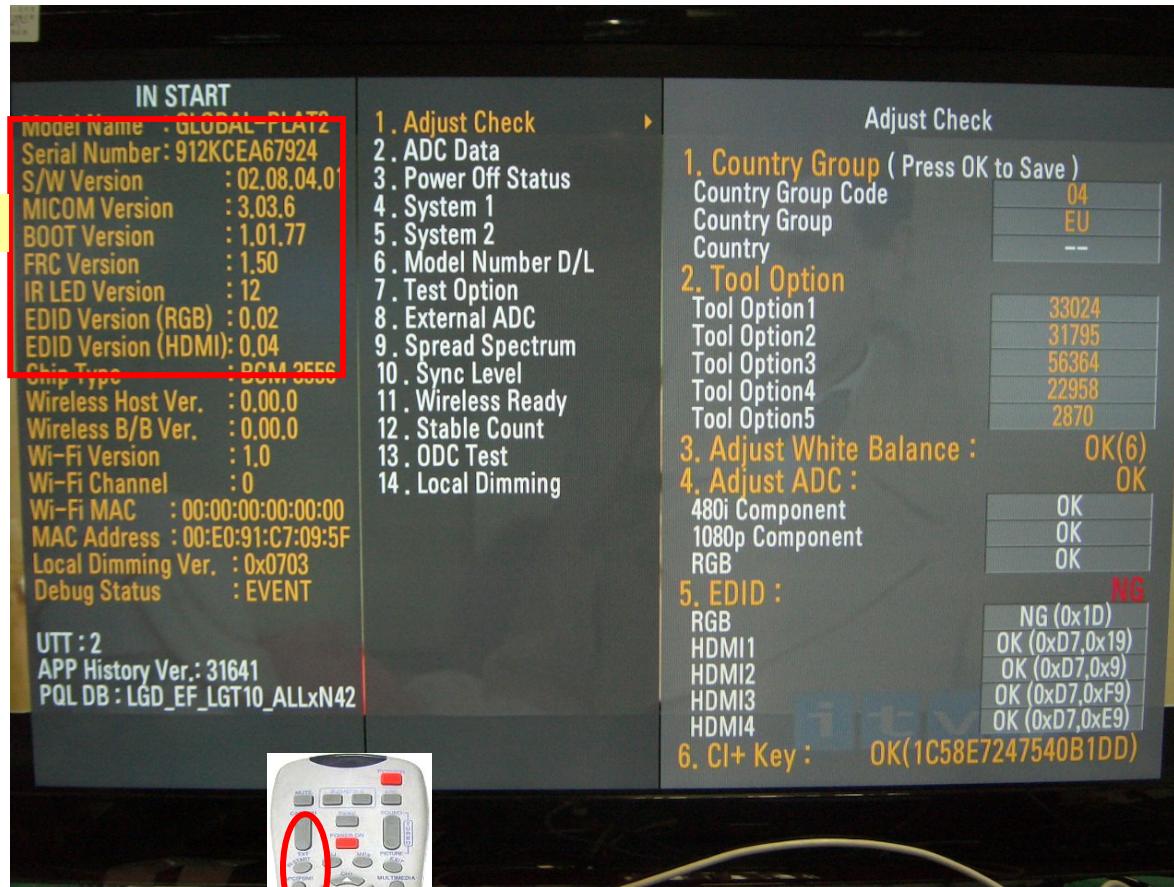


Standard Repair Process Detail Technical Manual

LCD TV	Error symptom	A. Video error_Video error, video lag/stop	Established date		
	Content	LCD-TV Version checking method	Revised date		A7

<ALL MODELS>

1. Checking method for remote controller for adjustment

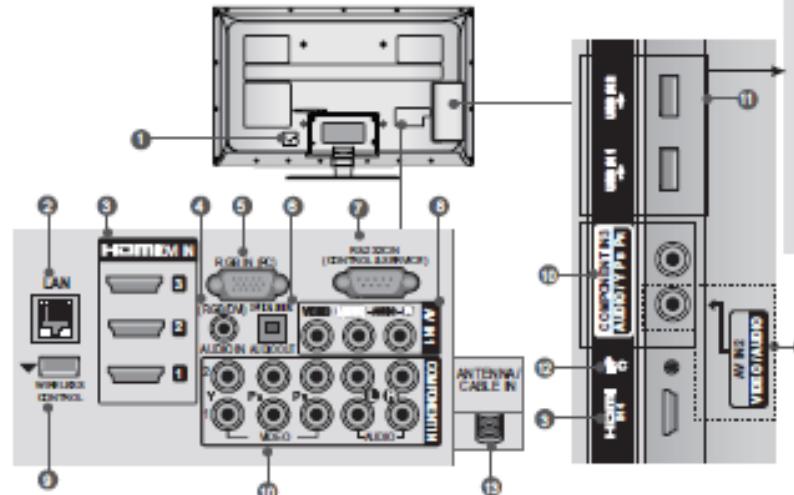


Press the IN-START with the remote controller for adjustment

A7

Standard Repair Process Detail Technical Manual

LCD TV	Error symptom	A. Video error _Vertical/Horizontal bar, residual image, light spot	Established date	
	Content	LCD TV connection diagram (1)	Revised date	A8



- ① Power Cord Socket
This TV operates on an AC power. The voltage is indicated on the Specifications page. Never attempt to operate the TV on DC power.
- ② LAN
Network connection for Weather info, Photo Album, Movie Online, etc.
Also used for video, photo and music files on a local network.
- ③ HDMI/DVI IN Input
Connect an HDMI signal to HDMI IN. Or DVI (VIDEO) signal to HDMI/DVI port with DVI to HDMI cable.
- ④ RGB/DVI Audio Input
Connect the audio from a PC or DTV.
- ⑤ RGB IN Input
Connect the output from a PC.
- ⑥ OPTICAL DIGITAL AUDIO OUT
Connect digital audio to various types of equipment.
Connect to a Digital Audio Component.
Use an Optical audio cable.
- ⑦ RS-232C IN (CONTROL & SERVICE) PORT
Connect to the RS-232C port on a PC.
This port is used for Service or Hotel mode.
- ⑧ Audio/Video Input
Connect audio/video output from an external device to these jacks.
- ⑨ WIRELESS Control
Connect the Wireless Dongle to the TV to control the external input devices connected to Media Box wirelessly.
- ⑩ Component Input
Connect a component video/audio device to these jacks.
- ⑪ USB Input
Connect USB storage device to this jack.
- ⑫ Headphone Socket
Plug the headphone into the headphone socket.
- ⑬ Antenna / Cable Input
Connect antenna or cable to this jack.

A8

Standard Repair Process Detail Technical Manual

LCD TV	Error symptom	A. Video error_Color error	Established date		
	Content	Adjustment Test pattern - ADJ Key	Revised date		A12



You can view 6 types of patterns using the ADJ Key

Checking item : 1. Defective pixel 2. Residual image 3. MODULE error (ADD-BAR,SCAN BAR..)
4. Video error (Classification of MODULE or Main-B/D!)

A12

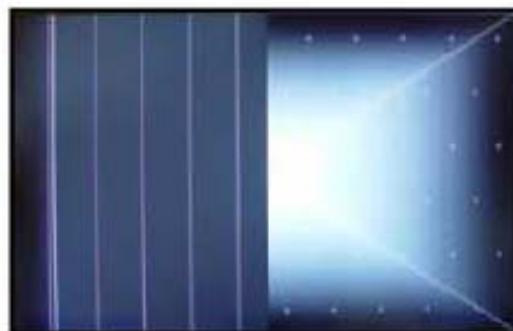
Appendix : Exchange T-Con Board (1)



Solder defect, CNT Broken



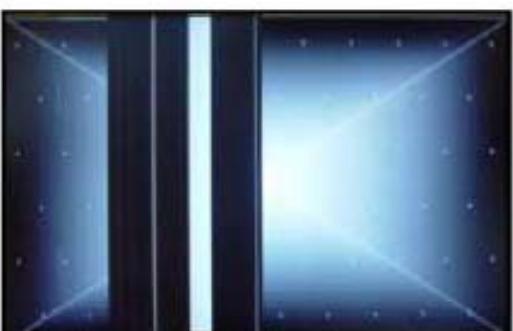
Solder defect, CNT Broken



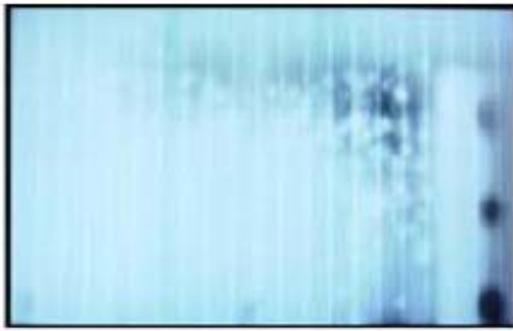
Solder defect, CNT Broken



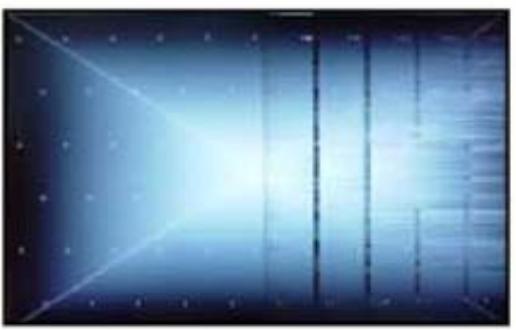
Solder defect, CNT Broken



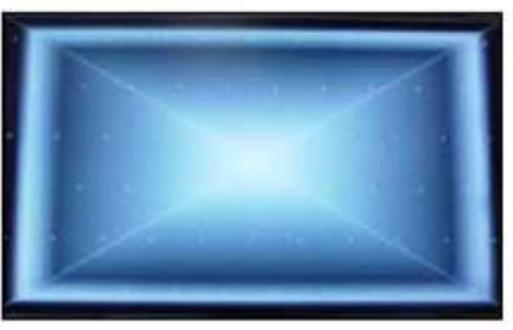
Solder defect, CNT Broken



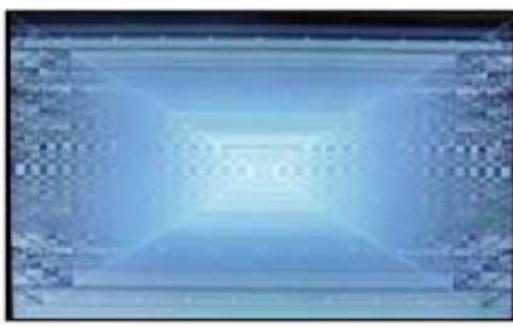
Abnormal Power Section



Solder defect, Short/Crack

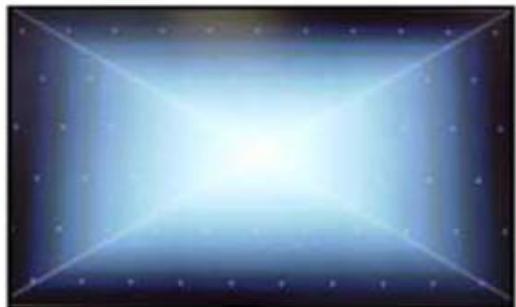


Abnormal Power Section



Solder defect, Short/Crack

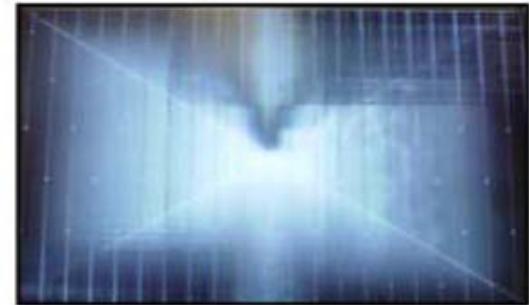
Appendix : Exchange T-Con Board (2)



Abnormal Power Section



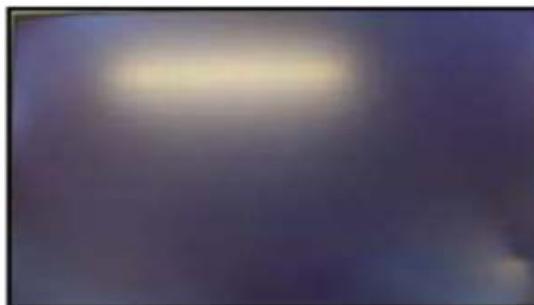
Abnormal Power Section



Solder defect, Short/Crack



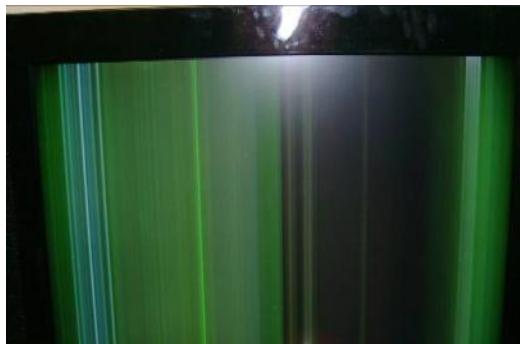
Solder defect, Short/Crack



Fuse Open, Abnormal power section



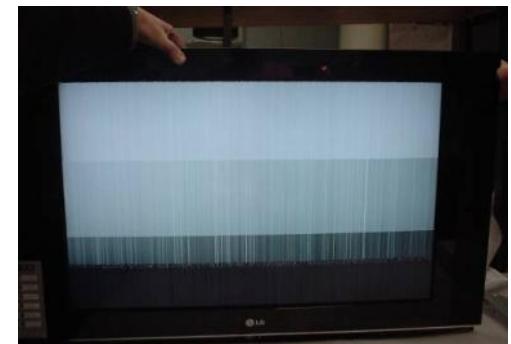
Abnormal Display



GRADATION



Noise



GRADATION

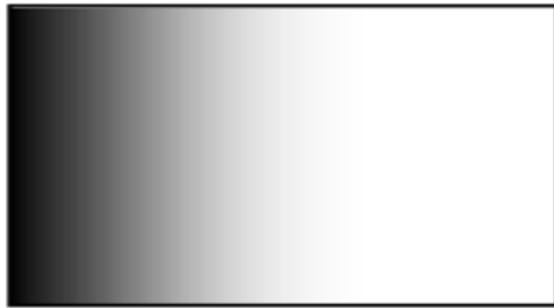
Appendix : Exchange PSU(LED driver)



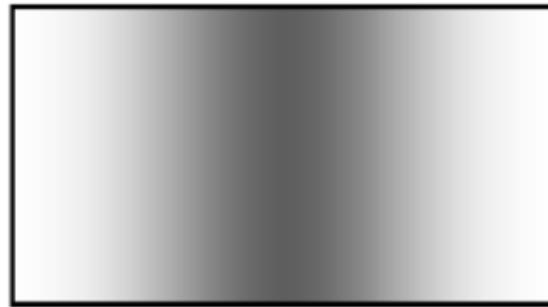
No Light



Dim Light



Dim Light



Dim Light



No picture/Sound Ok

A - 3/5

Appendix : Exchange the Module (1)



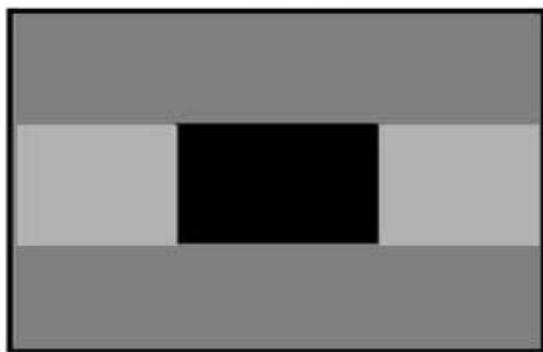
Panel Mura, Light leakage



Panel Mura, Light leakage



Press damage



Crosstalk



Press damage



Crosstalk

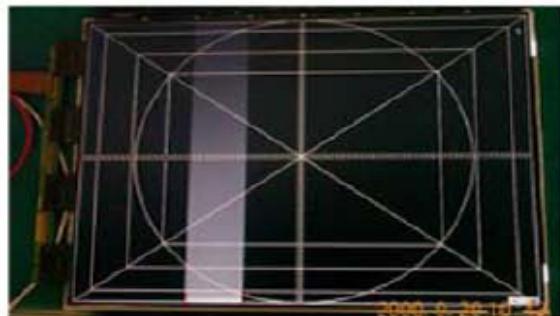


Press damage

Un-repairable Cases

In this case please exchange the module.

Appendix : Exchange the Module (2)



Vertical Block
Source TAB IC Defect



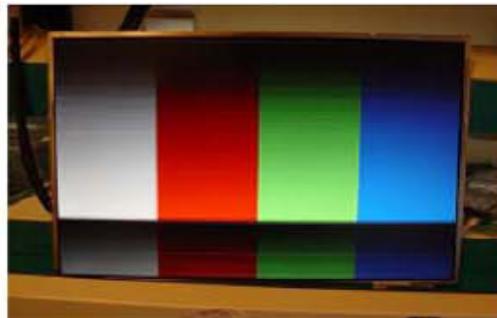
Vertical Line
Source TAB IC Defect



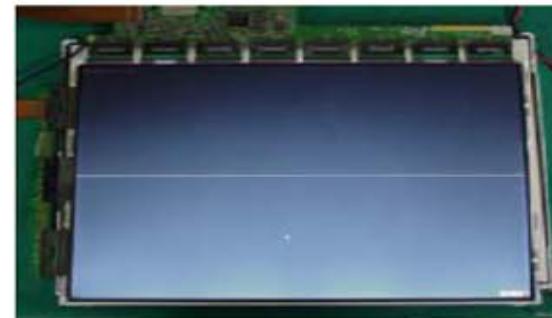
Vertical Block
Source TAB IC Defect



Horizontal Block
Gate TAB IC Defect



Horizontal Block
Gate TAB IC Defect



Horizontal line
Gate TAB IC Defect



Horizontal Block
Gate TAB IC Defect

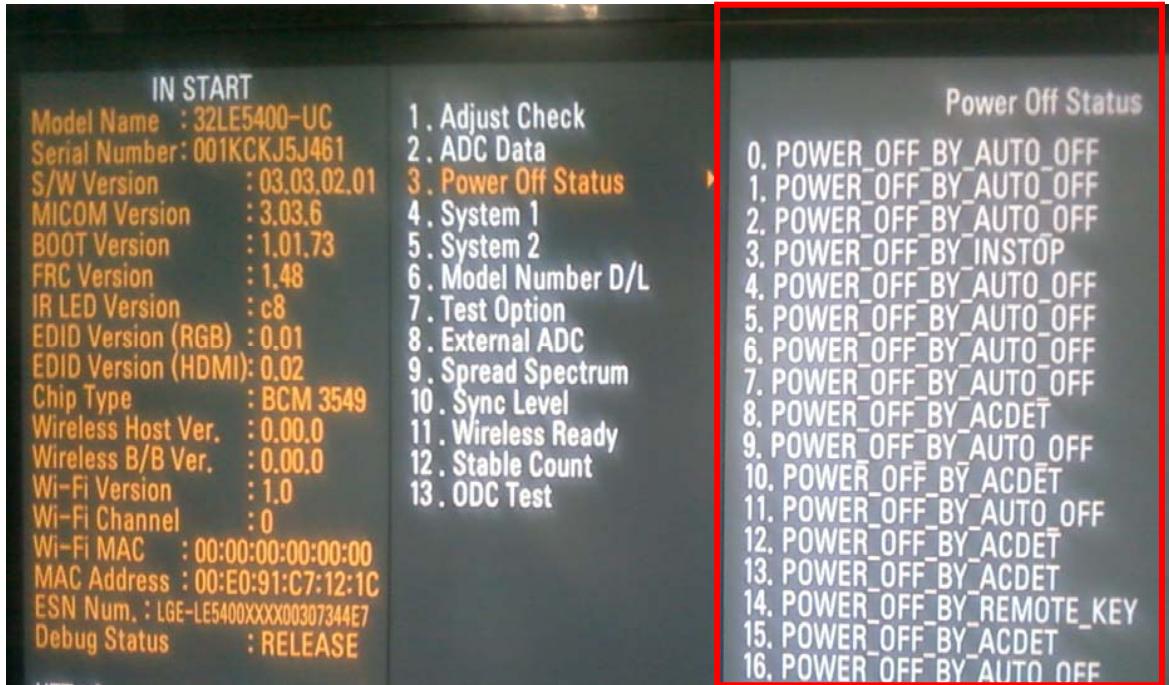
Un-repairable Cases

In this case please exchange the module.

Standard Repair Process Detail Technical Manual

LCD TV	Error symptom	B. Power error _Off when on, off whiling viewing	Established date		
	Content	POWER OFF MODE checking method	Revised date		A22

<ALL MODELS>



Entry method

1. Press the IN-START button of the remote controller for adjustment
2. Check the entry into adjustment item 3

A22

Standard Repair Process Detail Technical Manual

LCD TV	Error symptom	C. Audio error_No audio/Normal video	Established date		
	Content	Checking method in menu when there is no audio	Revised date		A24

<ALL MODELS>



Checking method

1. Press the MENU button on the remote controller
2. Select the AUDIO function of the Menu
3. Select TV Speaker from Off to On

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